STN-CAS Search

> screen 970 AND 2067

L7 SCREEN CREATED

=>

Uploading C:\Program Files\Stnexp\Queries\09463059b.str

L8 STRUCTURE UPLOADED

=> que L8 AND L7

L9 QUE L8 AND L7

=> d

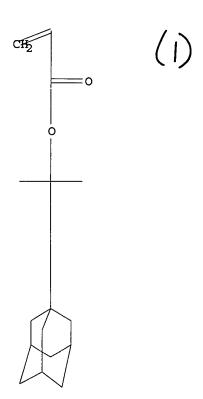
L9 HAS NO ANSWERS

L7

SCR 970 AND 2067

L8

STR



Structure attributes must be viewed using STN Express query preparation. L9 QUE ABB=ON PLU=ON L8 AND L7

## => s 19 sss ssam

COMBINATION OF STRUCTURE AND TEXT TERMS NOT VALID

The query entered contains both search terms created by structure-building or screen commands and text search terms. L#s created via the STRUCTURE or SCREEN commands must be searched in the structures files separately from text terms or profiles. The L# answer sets from structure searches can be used in crossover searches and can be combined with text terms.

=> s 19 sss sam

SAMPLE SEARCH INITIATED 11:47:19 FILE 'REGISTRY'

SAMPLE SCREEN SEARCH COMPLETED - 15 TO ITERATE

100.0% PROCESSED 15 ITERATIONS 14 ANSWERS

SEARCH TIME: 00.00.01

FULL FILE PROJECTIONS: ONLINE \*\*COMPLETE\*\*

BATCH \*\*COMPLETE\*\*

PROJECTED ITERATIONS: 68 TO 532
PROJECTED ANSWERS: 56 TO 504

L10 14 SEA SSS SAM L8 AND L7

=> FIL CAPLUS USPATFULL HCAPLUS

COST IN U.S. DOLLARS SINCE FILE TOTAL ENTRY SESSION

FULL ESTIMATED COST 0.76 346.81

DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS) SINCE FILE TOTAL ENTRY SESSION

CA SUBSCRIBER PRICE 0.00 -42.13

FILE 'CAPLUS' ENTERED AT 11:47:27 ON 11 SEP 2002 USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT. PLEASE SEE "HELP USAGETERMS" FOR DETAILS. COPYRIGHT (C) 2002 AMERICAN CHEMICAL SOCIETY (ACS)

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FILE 'HCAPLUS' ENTERED AT 11:47:27 ON 11 SEP 2002 USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT. PLEASE SEE "HELP USAGETERMS" FOR DETAILS. COPYRIGHT (C) 2002 AMERICAN CHEMICAL SOCIETY (ACS)

=> s 110

L11 27 L10

=> d his

(FILE 'HOME' ENTERED AT 11:41:13 ON 11 SEP 2002)

FILE 'REGISTRY' ENTERED AT 11:41:22 ON 11 SEP 2002

L1 SCREEN 970 AND 2067

L2 STRUCTURE UPLOADED

L3 QUE L2 AND L1

L4 41 S L3 SSS SAM

FILE 'CAPLUS, USPATFULL, HCAPLUS' ENTERED AT 11:42:07 ON 11 SEP 2002

L5 146 S L4

L6 76 DUPLICATE REM L5 (70 DUPLICATES REMOVED)

FILE 'REGISTRY' ENTERED AT 11:46:26 ON 11 SEP 2002

L7 SCREEN 970 AND 2067

L8 STRUCTURE UPLOADED

L9 QUE L8 AND L7

L10 14 S L9 SSS SAM

FILE 'CAPLUS, USPATFULL, HCAPLUS' ENTERED AT 11:47:27 ON 11 SEP 2002 L11 27 S L10

=> s 111 not 16

L12 18 L11 NOT L6

=> d 112 1-18 ibib hitstr abs

L12 ANSWER 1 OF 18 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2002:381304 CAPLUS

DOCUMENT NUMBER:

136:393273

TITLE:

Chemically amplified photoresists, resins therefor,

preparation thereof, and semiconductor device

fabrication thereby

INVENTOR(S):

Arai, Takashi

20020522

PATENT ASSIGNEE(S):

Daicel Chemical Industries, Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 10 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT	NO.	KIND	DATE

A2

APPLICATION NO. DATE

JP 2000-340585 20001108

IT 427886-92-8P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(chem. amplified pos. photoresist polymers comprising monomers with acid-labile protective groups)

RN 427886-92-8 CAPLUS

JP 2002145934

CN 2-Propenoic acid, 2-methyl-, 1,1-dimethylethyl ester, polymer with 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 279218-76-7 CMF C17 H26 O2

CM 2

CRN 177080-66-9 CMF C10 H14 O4

CM 3

CRN 585-07-9 CMF C8 H14 O2

AB The photoresists, forming patterns with high resoln. without scum generation in alkali development, contain polymers comprising monomers which bear acid-labile ester protective groups (Markush given).

L12 ANSWER 2 OF 18 CAPLUS COPYRIGHT 2002 ACS ACCESSION NUMBER: 2002:270846 CAPLUS

DOCUMENT NUMBER: 136:316923

TITLE: Positive-working chemically amplified photoresist

composition containing specific acid-sensitive resin

for semiconductor device fabrication

INVENTOR(S):
Sato, Kenichiro

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 36 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 2

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2002107936	A2	20020410	JP 2000-296881	20000928
US 2002064727	A1	20020530	US 2001-960343	20010924
PRIORITY APPLN. INFO.	:	•	JP 2000-290654 A	20000925
•			JP 2000-296881 A	20000928

OTHER SOURCE(S): MARPAT 136:316923

IT 409334-08-3 409334-10-7

RL: TEM (Technical or engineered material use); USES (Uses)
 (resin in Pos.-working chem. amplified photoresist compn. for
 semiconductor device fabrication)

RN 409334-08-3 CAPLUS

CN 2-Propenoic acid, 1-(3,5-dimethyltricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with bicyclo[2.2.1]hept-2-ene and 2,5-furandione (9CI) (CA INDEX NAME)

CM 1

CRN 409334-07-2 CMF C18 H28 O2

CM 2

CRN 498-66-8 CMF C7 H10

CRN 108-31-6 CMF C4 H2 O3

RN 409334-10-7 CAPLUS

CN 2-Propenoic acid, 1,1-dimethyl-2-oxo-2-[(tetrahydro-2-oxo-3-furanyl)oxy]ethyl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 383196-94-9 CMF C11 H14 O6

CM 2

CRN 300833-10-7 CMF C16 H24 O2

CM 3

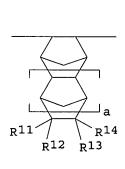
CRN 498-66-8 CMF C7 H10



CRN 108-31-6 CMF C4 H2 O3



GI



 $\begin{array}{c|c} CH_2 - C & & & \\ & \downarrow & & \\ A & & \downarrow & \\ C & R^1 & & \\ O & & & \\ R^2 & & & \end{array}$ 

RŪ

AB The title compn. contains an acid-sensitive resin increasing soly. in an alkali and an acid-generator, wherein the resin has repeating unit I ( R11-14 = H, alkyl; a = 0, 1 ) and II ( R1-2 = lower alkyl; R3 = lower alkyl, lower alkoxy, halo; k = 0-3 integer). The compn. generates little faulty development.

II

L12 ANSWER 3 OF 18 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002:72739 CAPLUS

DOCUMENT NUMBER: 136:142610

Ι

TITLE: Positive photoresist composition INVENTOR(S): Sato, Kenichiro; Aoai, Toshiaki

PATENT ASSIGNEE(S): Japan

SOURCE: U.S. Pat. Appl. Publ., 49 pp.

CODEN: USXXCO

DOCUMENT TYPE: Patent LANGUAGE: English

FAMILY ACC. NUM. COUNT: 2

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
US 2002009666	A1	20020124	US 2001-834639	20010416
JP 2001296661	A2	20011026	JP 2000-115497	20000417
JP 2002031890	A2	20020131	JP 2000-215574	20000717
JP 2002040662	A2	20020206	JP 2000-231670	20000731
PRIORITY APPLN. INFO.	:		JP 2000-115497 A	20000417
			JP 2000-215574 A	20000717

## IT 392309-94-3P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(acid-decomposable resin; pos. photoresist compn. contg.)

RN 392309-94-3 CAPLUS

CN 2-Propenoic acid, 7-methyl-5-oxo-4-oxatricyclo[4.3.0.03,8]non-7-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione, 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-propenoate and octahydro-1,4,4,6-tetramethyl-1H-5,8a-methanoazulen-6-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 392309-93-2 CMF C12 H14 O4

CM 2

CRN 313698-62-3 CMF C18 H28 O2

CM 3

CRN 300833-10-7 CMF C16 H24 O2

CM 4

CRN 498-66-8



CRN 108-31-6 CMF C4 H2 O3



AB Provided is a pos. photoresist compn. comprising a resin which contains specific repeating units and whose dissolving rate toward an alk. developing soln. is increased by the action of an acid and a compd. which generates an acid upon irradn. with an actinic ray or a radiation. The present invention relates to pos. photoresist compn. used in an ultramicrolithog. process, e.g., for the prodn. of VLSI and high capacity microchips processes.

L12 ANSWER 4 OF 18 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2001:347119 CAPLUS

DOCUMENT NUMBER:

134:346475

TITLE:

Adamantyl-containing polymer for photoresist and

polymer composition for photoresist

INVENTOR(S):

Gokochi, Toru; Okino, Takeshi; Asakawa, Koji; Shinoda,

Naomi; Funaki, Katsunori; Tsutsumi, Kiyoharu; Horai,

Akira; Inoue, Keizo

PATENT ASSIGNEE(S):

Toshiba Corp., Japan; Daicel Chemical Industries, Ltd.

SOURCE:

Jpn. Kokai Tokkyo Koho, 23 pp. CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

IT 338790-63-9P 338790-67-3P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(adamantyl-contg. polymer for etching-resistant photoresist for semiconductor device fabrication)

RN 338790-63-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate and tetrahydro-2,2-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-31-1 CMF C10 H14 O4

CRN 279218-76-7 CMF C17 H26 O2

CM 3

CRN 115372-36-6 CMF C14 H20 O3

RN 338790-67-3 CAPLUS

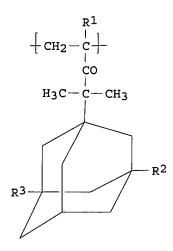
CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-2H-pyran-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-49-1 CMF C17 H26 O3

CRN 52858-59-0 CMF C9 H14 O3

GI



The polymer is that having .gtoreq.1 adamantyl-substituted monomer unit I (R1 = H, Me; R2, R3 = H, OH). The photoresist compn. contains the polymer and a photosensitive acid-generating agent. The photoresist compn., showing good etching resistance, is suitable for photolithog. in semiconductor device fabrication.

L12 ANSWER 5 OF 18 USPATFULL

Ι

ACCESSION NUMBER:

2002:16787 USPATFULL

TITLE:
INVENTOR(S):

Positive photoresist composition Sato, Kenichiro, Shizuoka, JAPAN Aoai, Toshiaki, Shizuoka, JAPAN

	NUMBER	KIND	DATE	
PATENT INFORMATION:	US 2002009666	A1	20020124	
APPLICATION INFO.:	US 2001-834639	A1	20010416	(9)

			NUMBER	DATE
PRIORITY	INFORMATION:	JP	2000-115497	20000417
		JP	2000-215574	20000717
		JP	2000-231670	20000731

DOCUMENT TYPE: Utility FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC, 2100

Pennsylvania Avenue, N.W., Washington, DC, 20037

NUMBER OF CLAIMS:

EXEMPLARY CLAIM:

1

LINE COUNT:

1642

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 392309-94-3P

(acid-decomposable resin; pos. photoresist compn. contg.)

RN 392309-94-3 USPATFULL

CN 2-Propenoic acid, 7-methyl-5-oxo-4-oxatricyclo[4.3.0.03,8]non-7-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione,

1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-propenoate and

octahydro-1,4,4,6-tetramethyl-1H-5,8a-methanoazulen-6-yl 2-propenoate

(9CI) (CA INDEX NAME)

CM 1

CRN 392309-93-2 CMF C12 H14 O4

CM 2

CRN 313698-62-3 CMF C18 H28 O2

CM 3

CRN 300833-10-7 CMF C16 H24 O2

$$\begin{array}{c} O \\ \parallel \\ \text{H}_2\text{C} = \text{CH} - \text{C} - O \\ \text{Me} - \text{C} \end{array}$$

CM 4

CRN 498-66-8



CRN 108-31-6 CMF C4 H2 O3



<u>AB</u> Provided is a positive photoresist composition comprising a resin which contains specific repeating units and whose dissolving rate toward an alkaline developing solution is increased by the action of an acid and a compound which generates an acid upon irradiation with an actinic ray or a radiation.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L12 ANSWER 6 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2002:381304 HCAPLUS

DOCUMENT NUMBER:

136:393273

TITLE:

Chemically amplified photoresists, resins therefor,

preparation thereof, and semiconductor device

fabrication thereby

INVENTOR(S):

Arai, Takashi

PATENT ASSIGNEE(S):

Daicel Chemical Industries, Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 10 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ---------**--**-----JP 2002145934 A2 20020522 JP 2000-340585 20001108

427886-92-8P TT

> RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(chem. amplified pos. photoresist polymers comprising monomers with acid-labile protective groups)

427886-92-8 HCAPLUS RN

CN2-Propenoic acid, 2-methyl-, 1,1-dimethylethyl ester, polymer with 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 279218-76-7 CMF C17 H26 O2

CRN 177080-66-9 CMF C10 H14 O4

$$\begin{array}{c|c} H_2C & \text{Me} \\ \parallel & \\ \text{Me}-C-C-O \\ \parallel & \\ O \end{array}$$

CM

CRN 585-07-9 CMF C8 H14 O2

The photoresists, forming patterns with high resoln. without scum AB generation in alkali development, contain polymers comprising monomers which bear acid-labile ester protective groups (Markush given).

L12 ANSWER 7 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2002:292089 HCAPLUS

DOCUMENT NUMBER:

136:316934

TITLE:

Positive-working photoresist composition for

fabrication of semiconductor device

INVENTOR(S):

Sato, Kenichiro

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 51 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE -----JP 2002116544 A2 20020419 JP 2000-310761 20001011

OTHER SOURCE(S):

MARPAT 136:316934

412015-88-4

RL: TEM (Technical or engineered material use); USES (Uses) (pos.-working photoresist compn. for fabrication of semiconductor device)

RN 412015-88-4 HCAPLUS

CN 2-Propenoic acid, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with 2,5-furandione, 1,2,3,4,4a,5,8,8a-octahydro-1,4:5,8-dimethanonaphthalene and tetrahydro-2-oxo-3-furanyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 328249-37-2 CMF C7 H8 O4

CM 2

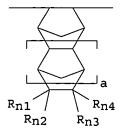
CRN 262608-27-5 CMF C16 H24 O3

CM 3

CRN 21635-90-5 CMF C12 H16

CM 4

CRN 108-31-6 CMF C4 H2 O3



I

AB The photoresist compn. contains a resin whose soly. rate in alk. developer increases by reaction with an acid and having a norbornene-based repeating unit I (a = 0, 1) and a OH group-contg. alicyclic hydrocarbyl ester group, and a compd. generating an acid upon irradn. with an actinic ray or radiation. The photoresist provides little fault pattern having improved adhesion to an inorg. antireflection film.

L12 ANSWER 8 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002

2002:270846 HCAPLUS

DOCUMENT NUMBER:

136:316923

TITLE:

Positive-working chemically amplified photoresist

composition containing specific acid-sensitive resin

for semiconductor device fabrication

INVENTOR(S):

Sato, Kenichiro

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 36 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 2

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2002107936	A2	20020410	JP 2000-296881	20000928
US 2002064727	<b>A</b> 1	20020530	US 2001-960343	20010924
PRIORITY APPLN. INFO.	:		JP 2000-290654 A	20000925
			JP 2000-296881 A	20000928

OTHER SOURCE(S): MARPAT 136:316923

IT 409334-08-3 409334-10-7

RL: TEM (Technical or engineered material use); USES (Uses) (resin in Pos.-working chem. amplified photoresist compn. for semiconductor device fabrication)

RN 409334-08-3 HCAPLUS

CN 2-Propenoic acid, 1-(3,5-dimethyltricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with bicyclo[2.2.1]hept-2-ene and 2,5-furandione (9CI) (CA INDEX NAME)

CM 1

CRN 409334-07-2 CMF C18 H28 O2

CRN 498-66-8 CMF C7 H10



CM :

CRN 108-31-6 CMF C4 H2 O3

RN 409334-10-7 HCAPLUS

CN 2-Propenoic acid, 1,1-dimethyl-2-oxo-2-[(tetrahydro-2-oxo-3-furanyl)oxy]ethyl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 383196-94-9 CMF C11 H14 O6

CM 2

CRN 300833-10-7 CMF C16 H24 O2

CRN 498-66-8 CMF C7 H10



CM 4

CRN 108-31-6 CMF C4 H2 O3

GI

AB The title compn. contains an acid-sensitive resin increasing soly. in an alkali and an acid-generator, wherein the resin has repeating unit I ( R11-14 = H, alkyl; a = 0, 1) and II ( R1-2 = lower alkyl; R3 = lower alkyl, lower alkoxy, halo; k = 0-3 integer). The compn. generates little faulty development.

 $(R^3)_k$ 

II

L12 ANSWER 9 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002:72739 HCAPLUS

DOCUMENT NUMBER: 136:142610

TITLE: Positive photoresist composition INVENTOR(S): Sato, Kenichiro; Aoai, Toshiaki

PATENT ASSIGNEE(S):

Japan

SOURCE:

U.S. Pat. Appl. Publ., 49 pp.

CODEN: USXXCO

DOCUMENT TYPE:

Patent

LANGUAGE:

English

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ----------\_\_\_\_\_ US 2002009666 **A1** 20020124 US 2001-834639 20010416 JP 2001296661 A2 20011026 JP 2000-115497 20000417 JP 2002031890 A2 20020131 JP 2000-215574 20000717 JP 2002040662 A2 20020206 JP 2000-231670 20000731 PRIORITY APPLN. INFO.: JP 2000-115497 A 20000417 JP 2000-215574 A 20000717

IT 392309-94-3P

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

JP 2000-231670

A 20000731

(acid-decomposable resin; pos. photoresist compn. contg.)

392309-94-3 HCAPLUS RN

CN2-Propenoic acid, 7-methyl-5-oxo-4-oxatricyclo[4.3.0.03,8]non-7-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione, 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-propenoate and octahydro-1,4,4,6-tetramethyl-1H-5,8a-methanoazulen-6-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 392309-93-2 CMF C12 H14 O4

CM 2

CRN 313698-62-3 CMF C18 H28 O2

$$H_2C = CH - C - O$$
 $Me$ 
 $Me$ 
 $Me$ 
 $Me$ 
 $Me$ 

CM 3

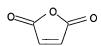
CRN 300833-10-7

CRN 498-66-8 CMF C7 H10



CM 5

CRN 108-31-6 CMF C4 H2 O3



AB Provided is a pos. photoresist compn. comprising a resin which contains specific repeating units and whose dissolving rate toward an alk. developing soln. is increased by the action of an acid and a compd. which generates an acid upon irradn. with an actinic ray or a radiation. The present invention relates to pos. photoresist compn. used in an ultramicrolithog. process, e.g., for the prodn. of VLSI and high capacity microchips processes.

L12 ANSWER 10 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2001:644598 HCAPLUS

DOCUMENT NUMBER:

135:218729

TITLE:

Lactone ring-containing polymers and resin

compositions for photoresists

INVENTOR(S):

Gokochi, Toru; Okino, Takeshi; Asakawa, Koji; Shinoda,

Naomi; Funaki, Katsunori; Tsutsumi, Kiyoharu; Horai,

Akira

PATENT ASSIGNEE(S):

Toshiba Corp., Japan; Daicel Chemical Industries, Ltd.

Jpn. Kokai Tokkyo Koho, 49 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

SOURCE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE

APPLICATION NO. DATE

------

JP 2001240625 A2 20010904 JP 2000-49549 20000225

IT 357341-10-7P 357341-14-1P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

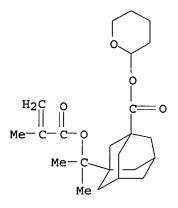
(prepn. of lactone ring-contg. polymers for photoresists)

RN 357341-10-7 HCAPLUS

CN Tricyclo[3.3.1.13,7]decane-1-carboxylic acid, 3-[1-methyl-1-[(2-methyl-1-oxo-2-propenyl)oxy]ethyl]-, tetrahydro-2H-pyran-2-yl ester, polymer with 2,5-furandione, 5-oxo-4-oxatricyclo[4.3.1.13,8]undec-1-yl 2-methyl-2-propenoate and 3a,4,7,7a-tetrahydro-4,7-methanobenzofuran-2(3H)-one (9CI) (CA INDEX NAME)

CM 1

CRN 357341-09-4 CMF C23 H34 O5



CM 2

CRN 357340-99-9 CMF C9 H10 O2

CM 3

CRN 348596-87-2 CMF C14 H18 O4

CRN 108-31-6 CMF C4 H2 O3

RN 357341-14-1 HCAPLUS

CN Tricyclo[3.3.1.13,7]decane-1,3-dicarboxylic acid, 5-[1-methyl-1-[(2-methyl-1-oxo-2-propenyl)oxy]ethyl]-, bis(tetrahydro-2H-pyran-2-yl) ester, polymer with 2,5-furandione, 5-oxo-4-oxatricyclo[4.3.1.13,8]undec-1-yl 2-methyl-2-propenoate and 3a,4,7,7a-tetrahydro-4,7-methanobenzofuran-2(3H)-one (9CI) (CA INDEX NAME)

CM 1

CRN 357341-13-0 CMF C29 H42 O8

$$\begin{array}{c|c} H_2C & O & C = O \\ \hline Me - C - C - O & C \\ \hline Me - C & C - O \\ \hline \end{array}$$

CM 2

CRN 357340-99-9 CMF. C9 H10 O2

CRN 348596-87-2 CMF C14 H18 O4

CM 4

CRN 108-31-6 CMF C4 H2 O3

GI

AB Photoresist compns. contain polymers contg. monomer units I and/or II (R1, Ra-Rg = H, Me; X1-X3 = CH2, CO2; at least one of X1-X3 is CO2; m, p, q = 0-2) and photoacid generators. The compns. show good adhesion to substrates such as Si and can precisely form fine patterns in semiconductor manufg.

L12 ANSWER 11 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2001:347119 HCAPLUS

DOCUMENT NUMBER: 134:346475

TITLE: Adamantyl-containing polymer for photoresist and

polymer composition for photoresist

INVENTOR(S): Gokochi, Toru; Okino, Takeshi; Asakawa, Koji; Shinoda,

Naomi; Funaki, Katsunori; Tsutsumi, Kiyoharu; Horai,

Akira; Inoue, Keizo

PATENT ASSIGNEE(S): Toshiba Corp., Japan; Daicel Chemical Industries, Ltd.

SOURCE: Jpn. Kokai Tokkyo Koho, 23 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent

LANGUAGE: Japanese FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001131232 A2 20010515 JP 1999-312329 19991102

IT 338790-63-9P 338790-67-3P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(adamantyl-contg. polymer for etching-resistant photoresist for semiconductor device fabrication)

RN 338790-63-9 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate and tetrahydro-2,2-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-31-1 CMF C10 H14 O4

CM 2

CRN 279218-76-7 CMF C17 H26 O2

$$\begin{array}{c|c} \text{H}_2\text{C} & \text{O} \\ \parallel & \parallel \\ \text{Me-} & \text{C-} & \text{C-} \\ \text{Me-} & \text{C} \\ \end{array}$$

CRN 115372-36-6 CMF C14 H20 O3

RN 338790-67-3 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-2H-pyran-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

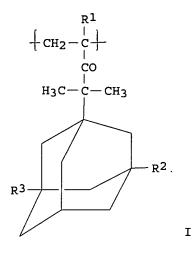
CM 1

CRN 324761-49-1 CMF C17 H26 O3

CM 2

CRN 52858-59-0 CMF C9 H14 O3

GI



The polymer is that having .gtoreq.1 adamantyl-substituted monomer unit I (R1 = H, Me; R2, R3 = H, OH). The photoresist compn. contains the polymer and a photosensitive acid-generating agent. The photoresist compn., showing good etching resistance, is suitable for photolithog. in semiconductor device fabrication.

L12 ANSWER 12 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2001:261353 HCAPLUS

DOCUMENT NUMBER: 134:303020

TITLE: Far-UV sensitive positive-working chemically amplified

photoresist composition for micro photolithography

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 45 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001100421 A2 20010413 JP 1999-280202 19990930

IT 334643-72-0P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resin contg. quaternary ammonium salt group in far-UV sensitive pos.-working chem. amplified photoresist compn.)

RN 334643-72-0 HCAPLUS

Ethanaminium, N-ethyl-N,N-dimethyl-2-[(2-methyl-1-oxo-2-propenyl)oxy]-, salt with trifluoromethanesulfonic acid (1:1), polymer with 3,5-dideoxy-2-C-methylpentonic acid .gamma.-lactone 2-(2-methyl-2-propenoate) and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CN

CRN 332877-32-4 CMF C10 H14 O4

CRN 279218-76-7 CMF C17 H26 O2

CM 3

CRN 334643-04-8 CMF C10 H20 N O2 . C F3 O3 S

CM 4

CRN 48063-69-0 CMF C10 H20 N O2

CM 5

CRN 37181-39-8 CMF C F3 O3 S

AB The title compn. contains a photoacid generator and a resin increasing the soly. towards an alkali developer by reacting with an acid, wherein the resin has a quaternary ammonium salt group. The addn. of the acid-sensitive resin contg. quaternary ammonium salt group to the compn. provides improved development characteristics and eliminates rough edges on the pattern.

L12 ANSWER 13 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2001:117245 HCAPLUS

DOCUMENT NUMBER: 134:170832

TITLE: Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S): Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 48 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001042535 A2 20010216 JP 1999-211370 19990726

IT 324761-53-7P 324761-58-2P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-53-7 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl) 1-methylethyl ester, polymer with tetrahydro-2-methyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-49-1 CMF C17 H26 O3

CM 2

CRN 324761-23-1 CMF C9 H12 O4

RN 324761-58-2 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl)1-methylethyl ester, polymer with tetrahydro-4,4-dimethyl-2-oxo-3-furanyl
2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1 '

CRN 324761-57-1 CMF C17 H26 O4

CRN 156938-13-5 CMF C10 H14 O4

AB The title compn. contains a photoacid generator, a polymer having an alicyclic hydrocarbon group, and a surfactant, wherein the surfactant is fluoro or silicon-based. The compn. generates little faulty development and provides the good pattern profiles.

L12 ANSWER 14 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2001:117244 HCAPLUS

DOCUMENT NUMBER:

134:170858

TITLE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 48 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

SOURCE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001042534 A2 20010216 JP 1999-211369 19990726

IT 324761-53-7P 324761-58-2P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-53-7 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-2-methyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-49-1 CMF C17 H26 O3

CRN 324761-23-1 CMF C9 H12 O4

RN 324761-58-2 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-57-1 CMF C17 H26 O4

CM 2

CRN 156938-13-5 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ & & & \\ H_2C & O & & \\ \parallel & \parallel & \\ Me-C-C-O & Me & & \\ \end{array}$$

AB The title compn. contains a photoacid generator, a polymer having an alicyclic hydrocarbon group, and a mixed solvent, wherein the solvent contains 2-heptanone. The compn. provides the good pattern profiles and the excellent storageability.

L12 ANSWER 15 OF 18 HCAPLUS COPYRIGHT 2002 ACS ACCESSION NUMBER: 2001:117243 HCAPLUS

DOCUMENT NUMBER:

134:170831

TITLE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 47 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

KIND DATE

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FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.

APPLICATION NO. DATE

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JP 2001042533

A2 20010216 JP 1999-211368 19990726

IT 324761-53-7P 324761-58-2P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material

use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-53-7 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1methylethyl ester, polymer with tetrahydro-2-methyl-5-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM

CRN 324761-49-1

CMF C17 H26 O3

CM 2

CRN 324761-23-1 CMF C9 H12 O4

324761-58-2 HCAPLUS ВN

CN 2-Propenoic acid, 2-methyl-, 1-(3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-4,4-dimethyl-2-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-57-1

CMF C17 H26 O4

CRN 156938-13-5 CMF C10 H14 O4

$$H_2C$$
  $O$   $Me$   $Me$ 

AB The title compn. contains a photoacid generator, a polymer having an alicyclic hydrocarbon group, and a mixed solvent, wherein the solvent contains propylene glycol monomethyl ether acetate or propylene glycol monomethyl ether propionate. The compn. provides the evenly coated layer and the good storageability.

L12 ANSWER 16 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2001:117242 HCAPLUS

DOCUMENT NUMBER:

134:170830

TITLE:

SOURCE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 47 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001042532 A2 20010216 JP 1999-211367 19990726

IT 324761-53-7P 324761-58-2P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-53-7 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-2-methyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-49-1 CMF C17 H26 O3

CRN 324761-23-1 CMF C9 H12 O4

RN 324761-58-2 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl)1-methylethyl ester, polymer with tetrahydro-4,4-dimethyl-2-oxo-3-furanyl
2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-57-1 CMF C17 H26 O4

CM 2

CRN 156938-13-5 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ & & & \\ H_2C & O & & \\ \parallel & \parallel & \\ Me-C-C-O & & Me \end{array}$$

AB The title compn. contains a photoacid generator, a polymer, and a mixed solvent contg. Et lactate and Bu acetate, wherein the polymer has an alicyclic hydrocarbon group. The compn. provides the evenly coated layer and the good storageability.

L12 ANSWER 17 OF 18 HCAPLUS COPYRIGHT 2002 ACS ACCESSION NUMBER: 2001:115197 HCAPLUS

DOCUMENT NUMBER:

134:185945

TITLE:

Polymer for photoresists and resin compositions for

photoresists

INVENTOR(S):

Funaki, Yoshinori; Tsutsumi, Kiyoharu; Takaragi,

Akira; Inoue, Keizo

PATENT ASSIGNEE(S):

Daicel Chemical Industries, Ltd., Japan

SOURCE:

PCT Int. Appl., 152 pp. CODEN: PIXXD2

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
WO 2001010916	A1	20010215	WO 2000-JP5168	20000802
W: KR, US				
RW: DE, FR,	GB			
JP 2001048931	A2	20010220	JP 1999-223110	19990805
JP 2001048933	A2	20010220	JP 1999-223144	19990805
EP 1172384	A1	20020116	EP 2000-949953	20000802
R: DE, FR,	GB			
PRIORITY APPLN. INFO.	. <b>:</b>		JP 1999-223110 A	19990805
			JP 1999-223144 A	19990805
			WO 2000-JP5168 W	20000802

## ΙT 325992-29-8P 325992-45-8P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(polymer for photoresists and resin compns. for photoresists)

RN 325992-29-8 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-ethyl-1-tricyclo[3.3.1.13,7]dec-1-ylpropyl ester, polymer with 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-3,5,5-trimethyl-2-oxo-3-furanyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 325991-61-5 CMF C10 H14 O4

CM 2

CRN 325991-24-0 CMF C19 H30 O2

CRN 115372-36-6 CMF C14 H20 O3

RN 325992-45-8 HCAPLUS

CN 2-Propenoic acid, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylpropyl 2-propenoate and tetrahydro-3,5,5-trimethyl-2-oxo-3-furanyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 325991-61-5 CMF C10 H14 O4

CM 2

CRN 325991-25-1 CMF C17 H26 O2

CM 3

CRN 216581-85-0 CMF C13 H18 O4

GI

## \* STRUCTURE DIAGRAM TOO LARGE FOR DISPLAY - AVAILABLE VIA OFFLINE PRINT \*

AB A polymer comprises at least one kind of monomer units selected from I-IV (R1 = H, Me; R2,3 = H, OH, etc.; R5,6 = H, OH, CO; R7-9 = H, Me; R10,11 = C1-8 hydrocarbon; R12-14 = H, OH, Me), with the proviso that when the polymer comprises monomer units of III. It must also contain at least another kind of monomer units selected from among those represented by general formula V (R15,16 = H, OH, COOH; R17 = OH, CO, COOH) or the like. This polymer is excellent not only in transparency, soly. in alkali and tight adhesion but also in etching resistance, thus being useful as the resin for photoresists.

REFERENCE COUNT: 12 THERE ARE 12 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L12 ANSWER 18 OF 18 HCAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2001:98658 HCAPLUS

DOCUMENT NUMBER:

134:170817

TITLE:

Positive-working photoresist composition for exposure

to far ultraviolet light

INVENTOR(S):

Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 47 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001033969 A2 20010209 JP 1999-203676 19990716

IT 324761-53-7P 324761-58-2P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos.-working photoresist compn. contg. polymer with alicyclic group for exposure to far UV light)

RN 324761-53-7 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3-hydroxytricyclo[3.3.1.13,7]dec-1-yl)-1-methylethyl ester, polymer with tetrahydro-2-methyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-49-1 CMF C17 H26 O3

CRN 324761-23-1 CMF C9 H12 O4

RN 324761-58-2 HCAPLUS

CN 2-Propenoic acid, 2-methyl-, 1-(3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl)1-methylethyl ester, polymer with tetrahydro-4,4-dimethyl-2-oxo-3-furanyl
2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-57-1 CMF C17 H26 O4

CM 2

CRN 156938-13-5 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ & & & \\ H_2C & O & & \\ \parallel & \parallel & & \\ Me-C-C-O & & Me & \\ \end{array}$$

$$\begin{array}{c|c}
O & R^1 \\
\hline
C - O & \\
\hline
\end{array}$$

$$\begin{array}{c|c}
Z_{A} & OH \\
\end{array}$$

$$A \quad I$$

The title compn. contains (1) a compd. which generates acids by irradn. of actinic ray or radiation and (2) a polymer contg. .gtoreq.1 group with an alicyclic hydrocarbon structure represented by I (R1 = Me, Et, n- or iso-Pr, n-, iso-, or sec-butyl; ZA = at. group required for forming alicyclic hydrocarbon group; a = 1, 2) and -CO2CR2R3ZB(OH)b (R2, R3 = C1-4 alkyl; ZB = 2- or 3-valent alicyclic hydrocarbon group; b = 1, 2). The polymer has alkali soly. which increases by acids. The compn. is sensitive to far UV light, esp. to ArF excimer laser light, and resist patterns with low edge roughness can be offered.

=> screen 970 AND 2067 L1 SCREEN CREATED Uploading C:\Program Files\Stnexp\Queries\09463059a.str STRUCTURE UPLOADED => que L2 AND L1 QUE L2 AND L1 => dL3 HAS NO ANSWERS L1 SCR 970 AND 2067 L2STR CH Structure attributes must be viewed using STN Express query preparation. QUE ABB=ON PLU=ON L2 AND L1 => s 13 sss sam SAMPLE SEARCH INITIATED 11:41:51 FILE 'REGISTRY' SAMPLE SCREEN SEARCH COMPLETED -67 TO ITERATE 100.0% PROCESSED 67 ITERATIONS 41 ANSWERS SEARCH TIME: 00.00.05 FULL FILE PROJECTIONS: ONLINE \*\*COMPLETE\*\* BATCH \*\*COMPLETE\*\* PROJECTED ITERATIONS: 849 TO 1831 PROJECTED ANSWERS: 436 TO 1204 L441 SEA SSS SAM L2 AND L1 => d L4 ANSWER 1 OF 41 REGISTRY COPYRIGHT 2002 ACS 437770-82-6 REGISTRY RN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, CN polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and octahydro-6-hydroxy-1(or 3)-oxo-4,7-methanoisobenzofuran-5-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

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CH<sub>2</sub>
Me^-C^-CO_2H
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1 REFERENCES IN FILE CA (1967 TO DATE) 1 REFERENCES IN FILE CAPLUS (1967 TO DATE)

=> FIL CAPLUS USPATFULL HCAPLUS

COST IN U.S. DOLLARS

SINCE FILE TOTAL

ENTRY SESSION

FULL ESTIMATED COST

1.96 2.17

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(FILE 'HOME' ENTERED AT 11:41:13 ON 11 SEP 2002)

FILE 'REGISTRY' ENTERED AT 11:41:22 ON 11 SEP 2002

L1SCREEN 970 AND 2067

STRUCTURE UPLOADED L2

 $L_3$ QUE L2 AND L1 41 S L3 SSS SAM L4

FILE 'CAPLUS, USPATFULL, HCAPLUS' ENTERED AT 11:42:07 ON 11 SEP 2002

=> s 14

146 L4 L5

=> duplicate

ENTER REMOVE, IDENTIFY, ONLY, OR (?):rem

ENTER L# LIST OR (END):15

DUPLICATE PREFERENCE IS 'CAPLUS, USPATFULL, HCAPLUS'

KEEP DUPLICATES FROM MORE THAN ONE FILE? Y/(N):n

PROCESSING COMPLETED FOR L5

L6 76 DUPLICATE REM L5 (70 DUPLICATES REMOVED)

=> d l6 1-76 ibib hitstr abs

ANSWER 1 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 1

ACCESSION NUMBER: 2002:466067 CAPLUS

137:54621

DOCUMENT NUMBER:

TITLE: Polymer for photoresist and resin compositions

therefor

Funaki, Yoshinori; Tsutsumi, Kiyoharu; Inoue, Keizo; Adachi, Tomoko INVENTOR (S):

PATENT ASSIGNEE(S): Daicel Chemical Industries, Ltd., Japan

SOURCE: PCT Int. Appl., 70 pp.

CODEN: PIXXD2

DOCUMENT TYPE: Patent LANGUAGE: Japanese FAMILY ACC. NUM. COUNT: 1 PATENT INFORMATION:

W: JP, KR, US RW: DE, FR, GB

PRIORITY APPLN. INFO.: JP 2000-378750 A 20001213

OTHER SOURCE(S): MARPAT 137:54621

IT 437770-82-6P

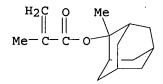
RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (photoresist resin compn.)

RN 437770-82-6 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and octahydro-6-hydroxy-1(or 3)-oxo-4,7-methanoisobenzofuran-5-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2



CM 2

CRN 115372-36-6 CMF C14 H20 O3

CM 3

CRN 437770-77-9 CMF C13 H16 O5

CCI IDS CDES 8:ID

CM 4

CRN 437754-44-4 CMF C9 H12 O4

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-- C-- CO}_2\text{H} \end{array}$$

GI

$$\begin{array}{c|c}
 & R^1 \\
 & C \\
 & C$$

AB A polymer for photoresist comprises at least one kind of monomer units represented by I (R1-5 = H, Me; m, p, q = 0, 1, 2; and n = 0, 1, with the proviso that the hydroxyl group and the carbonyloxy group attached to the main chain are bonded to one of the two left-end carbon atoms of the ring). When this polymer is used as the base of photoresist, the resulting photoresist is well balanced between adhesion to a substrate and etching resistance. REFERENCE COUNT:

ANSWER 2 OF 76 CAPLUS COPYRIGHT 2002 ACS

**DUPLICATE 2** 

ACCESSION NUMBER:

2002:449670 CAPLUS

DOCUMENT NUMBER:

137:39324

TITLE:

(Meth)acrylate esters, starting alcohols for the preparation thereof, processes for preparing both, polymers of the esters, chemically amplifiable resist

compositions, and method for forming patterns

INVENTOR(S):

Kamon, Yoshihiro; Fujiwara, Tadayuki; Kuwano, Hideaki;

THERE ARE 4 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

Momose, Hikaru; Koizumi, Atsushi

PATENT ASSIGNEE(S):

Mitsubishi Rayon Co., Ltd., Japan

SOURCE:

PCT Int. Appl., 109 pp.

DOCUMENT TYPE:

CODEN: PIXXD2

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1 PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE -------------------WO 2001-JP10628 20011205 WO 2002046179 20020613 A1 W: KR, US RW: AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR JP 2002234882 A2 20020823 JP 2001-366958 20011130 PRIORITY APPLN. INFO.: JP 2000-371712 A 20001206 JP 2001-1728 A 20010109 JP 2001-366958 A 20011130 JP 2001-368904 A 20011203

OTHER SOURCE(S): MARPAT 137:39324

436852-45-8P 436852-47-0P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(prepn. of (meth)acrylate-based chem. amplification-type resist)

RN436852-45-8 CAPLUS

2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, CN polymer with octahydro-1(or 3)-oxo-4,7-methanoisobenzofuran-5-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 436852-34-5 CMF C13 H16 O4 CCI IDS CDES \*

D2 = 0

CM 2

CRN 209982-56-9. CMF C16 H24 O2

RN 436852-47-0 CAPLUS

2-Propenoic acid, 2-methyl-, 2-hydroxyethyl ester, polymer with CN 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and octahydro-1(or 3)-oxo-4,7-methanoisobenzofuran-5-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CRN 436852-34-5 CMF C13 H16 O4 CCI IDS

CDES \*

D2-0

CM 2

CRN 177080-67-0 CMF C15 H22 O2

3 CM

CRN 868-77-9 CMF C6 H10 O3

GI

$$x^1$$
 $x^2$ 
 $x^2$ 

AB (Meth)acrylate esters are represented by the general formula I (R1-4 = H, Me, Et; one of X1 and X2 is (meth)acryloyloxy and the other is H; A1 and

A2 are H or form O, CH2, CH2CH2). These esters can be prepd. by prepg. a product of addn. of a 1,3-diene with maleic anhydride by Diels-Alder reaction, reducing this product into a lactone, hydrating this lactone into an alc., and esterifying this alc. with (meth)acrylic acid. The (co)polymers produced by polymg. monomer compns. contg. the (meth)acrylate esters are excellent in transparency, dry-etching resistance, and soly. in org. solvents, and useful as resins for chem. amplifiable resist compns.

REFERENCE COUNT: 5 THERE ARE 5 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 3 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 3

ACCESSION NUMBER: 2002:429451 CAPLUS

DOCUMENT NUMBER: 137:26108

TITLE: Positive-working photoresist composition

INVENTOR(S): Hada, Hideo; Fujimura, Satoshi; Sasaki, Kazuhito;

Iwai, Takeshi

PATENT ASSIGNEE(S): Japan

SOURCE: U.S. Pat. Appl. Publ., 7 pp.

CODEN: USXXCO

DOCUMENT TYPE: Patent LANGUAGE: English

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
US 2002068238	A1	20020606	US 2001-996676	20011130
JP 2002169292	A2	20020614	JP 2000-369225	20001204
PRIORITY APPLN. INFO.	:		JP 2000-369225 A	20001204

IT 348631-34-5

RL: TEM (Technical or engineered material use); USES (Uses) (resin; pos.-working photoresist compn. contg.)

RN 348631-34-5 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

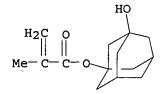
CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 130224-95-2 CMF C8 H10 O4

CRN 115372-36-6 CMF C14 H20 O3



AB The invention discloses a pos.-working photoresist compn. suitable for patterning light-exposure with light having a wavelength of .ltoreq. 200 nm. The photoresist compn. comprises (1) a resinous compd. capable of being imparted with increased soly. in an aq. alk. soln. by interaction with an acid, (2) a radiation-sensitive acid generating compd. capable of generating an acid by irradn. with a radiation and (3) an org. solvent. The resinous compd. is a copolymer consisting of a combination of three types of specific (meth)acrylate units as the monomeric units. The patterned resist layer formed from the photoresist compn. has an advantage in respect of decreased line slimming caused by electron beam irradn. in SEM inspection.

ANSWER 4 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 4

ACCESSION NUMBER:

2002:592336 CAPLUS

DOCUMENT NUMBER:

137:147763

TITLE:

Chemically amplified positive-working photoresist

composition providing fine resolution patterns

INVENTOR(S):

Fujimori, Toru

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 94 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ---------**----**JP 2002221796 A2 20020809 JP 2001-18868 20010126

IT 398140-88-0P

> RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(in chem. amplified pos.-working photoresist compn. for far-UV exposure)

RN398140-88-0 CAPLUS

Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, CN polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2Hcyclopenta[b]furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2yl 2-propenoate (9CI) (CA INDEX NAME)

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 242129-35-7 CMF C11 H12 O4

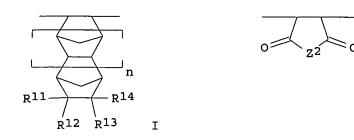
CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

GI



$$\begin{array}{c|c}
 & R^{91} \\
 & \downarrow \\
 & C \\$$

The photoresist compn., used in fabrication of semiconductor devices, AB contains a photoacid generator, a polymer increasing the soly. in an alkali developer by reaction with an acid and having repeating groups I, II, and III [R11-14 = acid-decomposable group, H, halo, cyano, CO2H, etc.; .gtoreq.2 of R11-14 may form a ring; n = 0, 1; Z2 = O, N(R41); R41 = H, OH, (halo)alkyl, etc.; R91 = H, lower alkyl, halo, CN; X5 = O, S, etc.; R92 = H, cyclic or chain alkyl, alkoxy, OH, etc.], and a compd. contg. CON(OH) group. The photoresist compn., esp. when using an ArF excimer laser, provides excellent post exposure delay (PED) stability and profiles and inhibits shortening of line pattern edges.

ANSWER 5 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 5

ACCESSION NUMBER:

2002:566567 CAPLUS

DOCUMENT NUMBER:

137:132103

TITLE:

Positive-working photoresist composition

II

INVENTOR(S): Fujimori, Toru

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

Jpn. Kokai Tokkyo Koho, 93 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

SOURCE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE \_ \_ \_ \_ -----JP 2002214787 JP 2001-13298 A2 20020731 20010122

IT 398140-88-0P

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resin in pos.-working photoresist compn.)

398140-88-0 CAPLUS RN

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2Hcyclopenta[b] furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2yl 2-propenoate (9CI) (CA INDEX NAME)

CM

CRN 249562-06-9 CMF C14 H20 O2

CRN 242129-35-7 CMF C11 H12 O4

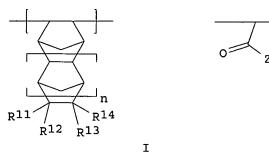
CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

GI



AB The title compn. contains a light- or radiation-sensitive acid generator, a resin increasing soly. rate in an alkali developer by an acid, and a compd. having an acid-sensitive group, wherein the resin has repeating group I(R11-14 = acid-sensitive group, H, halo, cyano, etc.; n = 0, 1), II( Z2 = -O-, -N(R41)-;R41 = H, OH, alkyl, etc.), and [CH2-C(R91)(CO-X5-B-R)]R92)](R91= H, lower alkyl, halo, -CN; X5 = -O-, -S-, -NR93; R93 = H, chain or cyclic alkyl; B = single bond, connecting group; R92 = H, chain or cyclic alkyl, alkoxy, carboxy, etc.) and wherein the compd. having the acid-sensitive group generates a group, which is sol. in the alkali developer or more sol. in the alkali developer before the acid reaction. The compn. shows the improved stability during the post exposure delay (PED).

ANSWER 6 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 6 1.6

ACCESSION NUMBER:

2002:566566 CAPLUS

DOCUMENT NUMBER:

INVENTOR(S):

137:132102

TITLE:

Positive-working photoresist composition

II

Fujimori, Toru

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 78 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

LANGUAGE:

Patent Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ---------JP 2002214786 A2 20020731 JP 2001-10481 20010118

IT 398140-88-0P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resin in pos.-working photoresist compn.)

RN 398140-88-0 CAPLUS

Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, CN polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2Hcyclopenta[b] furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2yl 2-propenoate (9CI) (CA INDEX NAME)

CM

CRN 249562-06-9 CMF C14 H20 O2

CRN 242129-35-7 CMF C11 H12 O4

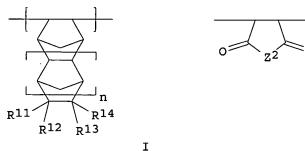
CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

GI



AB The title compn. contains a light- or radiation-sensitive acid generator, a resin increasing soly. rate in an alkali developer by an acid, and a basic compd. not contg. an arom. group, wherein the resin has repeating group I(R11-14 = acid-sensitive group, H, halo, cyano, etc.; n = 0, 1), II( Z2 = -O-, -N(R41)-; R41 = H, OH, alkyl, etc.), and [CH2-C(R91)(CO-X5-B-R92)](R91= H, lower alkyl, halo, -CN; X5 = -O-, -S-, -NR93; R93 = H, chain or cyclic alkyl; B = single bond, connecting group; R92 = H, chain or cyclic alkyl, alkoxy, carboxy, etc.). The compn. shows the improved stability during the post exposure delay (PED).

ANSWER 7 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 7

ACCESSION NUMBER:

2002:538441 CAPLUS

DOCUMENT NUMBER:

137:116950

TITLE:

Chemically amplified far-UV positive photoresists

II

compositions with improved exposure margin and defocus

DATE

latitude

INVENTOR(S):

Sato, Kenichiro

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 81 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

SOURCE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.

KIND DATE APPLICATION NO.

- - - <del>-</del> -----JP 2002202607 JP 2000-402246 A2 20020719 20001228

OTHER SOURCE(S):

MARPAT 137:116950

398140-88-0P, tert-Butyl norbornenecarboxylate-maleic

anhydride-2-methyl-2-adamantyl acrylate-norbornenelacton acrylate copolymer

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(far-UV pos. photoresists having sulfonium and iodonium photoacid generators with improved exposure margin and defocus latitude)

RN 398140-88-0 CAPLUS

CNBicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2Hcyclopenta[b]furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CRN 242129-35-7 CMF C11 H12 O4

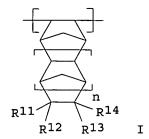
CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

GI



The resist compns. comprise (A) photoacid generators Q1Q2Q3S+X- [Q1-3 = (un)substituted phenyl; substituent = H, alkyl, alkoxy, OH, halo, SR; R = alkyl, aryl; X = RFSO3; RF = C.gtoreq.2-fluoroalkyl], X-Y1S+(Y2)Z1SZ2S+Y3Y4X- [Y1-4 = (un)substituted Ph (max. 2 substituents); Z1, Z2 = (un)substituted phenylene (max. 2 substituents); substituent, X = same as above], and Q4I+Q5X- [Q4, Q5 = (un)substituted phenyl; substituent, X = same as above] and (B) resins, which become alkali-sol. by acid decompn., comprising repeating units I (R11-14 = acid-decomposable group, H, halo, cyano, COOH, etc.; n = 0, 1), II (Z2 = O, NR41; R41 = H, OH, alkyl, haloalkyl, OSO2R42; R42 = alkyl, haloalkyl, etc.), and CH2CR91COX5BR92 (R91 = H, lower alkyl, halo, CN; X5 = O, S, NR93, NR93SO2; R93 = H, alkyl; B = single bond, linking group; R92 = H, alkyl, alkoxy, OH, etc.).

L6 ANSWER 8 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 8

ACCESSION NUMBER: 2002:538440 CAPLUS

DOCUMENT NUMBER: 137:116949

TITLE: Storage-stable chemically amplified far-UV positive

photoresists compositions with good sensitivity and no

aggregation

INVENTOR(S): Sato, Kenichiro

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 81 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

DANGUAGE: Uap

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2002202606 A2 20020719 JP 2000-402245 20001228

IT 398140-88-0P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(storage-stable far-UV pos. photoresist compns. in solvents with good soly.)

RN 398140-88-0 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester,

polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2Hcyclopenta[b]furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

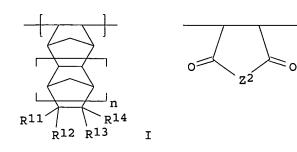
CRN 242129-35-7 CMF C11 H12 O4

CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3



AB The resist compns., useful for contact hole formation in semiconductor device fabrication, comprise (A) photoacid generators, (B) resins, which become alkali-sol. by acid decompn., comprising repeating units I (R11-14 = acid-decomposable group, H, halo, cyano, COOH, etc.; n = 0, 1), II (Z2 = O, NR41; R41 = H, OH, alkyl, haloalkyl, OSO2R42; R42 = alkyl, haloalkyl, etc.), and CH2CR91COX5BR92 (R91 = H, lower alkyl, halo, CN; X5 = O, S, NR93, NR93SO2; R93 = H, alkyl; B = single bond, linking group; R92 = H, alkyl, alkoxy, OH, etc.), and (C) mixed solvents comprising 1st solvents of propylene glycol monoalkyl ether alkoxylates and 2nd solvents selected from propylene glycol monoalkyl ethers, alkyl lactates, and alkyl alkoxypropionates or, instead of the 2nd solvents, 3rd solvents selected from .gamma.-butyrolactone, ethylene carbonate, and propylene carbonate. The solvents may comprise .gtoreq.1 solvents selected from each of the 1st, 2nd, and 3rd solvent groups.

ΙI

L6 ANSWER 9 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 9

ACCESSION NUMBER: 2002:539335 CAPLUS

DOCUMENT NUMBER: 137:101423

TITLE: Storage-stable chemically amplified far-UV positive

photoresist compositions suitable for half-tone

phase-shift photomasks

INVENTOR(S): Sato, Kenichiro

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 80 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2002202605 A2 20020719 JP 2000-402244 20001228

OTHER SOURCE(S): MARPAT 137:101423

IT 398140-88-0P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(storage-stable far-UV pos. photoresists contg. triphenylsulfonium photoacid generators for half-tone phase-shift photomasks)

RN 398140-88-0 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CRN 242129-35-7 CMF C11 H12 O4

CM 3

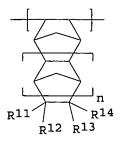
CRN 154970-45-3 CMF C12 H18 O2

CM ·

CRN 108-31-6 CMF C4 H2 O3

GI

II



Ι

The resist compns. comprise (A) photoacid generators [C6H5-lRs4lS(C6H5-nRs6n)C6H5-mRs5m]+Xs- (Rs4, Rs5, Rs6 = alkyl, cycloalkyl, alkoxy, OH, etc.; l = 1-5; m, n = 0-5; Xs- = RSO3-; R = aliph. or arom. hydrocarbon group) and (B) resins comprising repeating units I (R11-14 = acid-decomposable group, H, halo, cyano, COOH, etc.; n = 0, 1), II (Z2 = 0, NR41; R41 = H, OH, alkyl, haloalkyl, OSO2R42; R42 = alkyl, haloalkyl, etc.), and CH2CR91COX5BR92 (R91 = H, lower alkyl, halo, CN; X5 = 0, S, NR93, NR93SO2; R93 = H, alkyl; B = single bond, linking group; R92 = H, alkyl, alkoxy, OH, etc.), wherein the resins become alkali-sol. by acid decompn.

L6 ANSWER 10 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 10

ACCESSION NUMBER:

2002:381311 CAPLUS

DOCUMENT NUMBER:

136:409016

TITLE:

Acrylic polymer compound for photoresist and

manufacture thereof

INVENTOR(S):

Tsutsumi, Kiyoharu; Funaki, Katsunori

PATENT ASSIGNEE(S):

Daicel Chemical Industries, Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 9 pp. CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2002145954	A2	20020522	JP 2000-343762	20001110

IT 348631-34-5P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

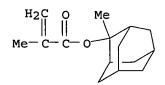
(acrylic polymer compd. for photoresist)

RN 348631-34-5 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2



CRN 130224-95-2 CMF C8 H10 O4

CM 3

CRN 115372-36-6 CMF C14 H20 O3

GΙ

AB The invention relates to an acrylic polymer compd. for a photoresist which

contains delocalized monomer units and has a small intramol. compn. distribution. The acrylic polymer compd. is a copolymer of (A) a (meth)acrylate I (R1 = H, Me; R2 = H, C1-3 hydrocarbon; R3-10 = H, Me; p, q, r, s = 0, 1; p+q+r+s = 2-4) having lactone ring, (B) .gtoreq.1 (meth)acrylate selected from II and III (R11 = H, Me; R12,13 = H, C1-3 hydrocarbon; R14 = C6-20 aliph. hydrocarbon capable of forming ring) having an aliph. hydrocarbon capable of forming a ring, (C) a (meth)acrylate IV (R17 = H, Me; R18,19 = substituent bonded to adamantane ring) contg. an adamantane ring. The manuf. involving a copolymn. of above monomers and a photoresist compn. contg. a photoacid are also claimed.

1.6 ANSWER 11 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 11

ACCESSION NUMBER: 2002:364226 CAPLUS

DOCUMENT NUMBER:

136:393267

TITLE:

Positive-working resist compositions with high

sensitivity and resolution

INVENTOR(S):

Fujimori, Toru; Tan, Shiro; Nakao, Hajime

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 43 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.

KIND DATE APPLICATION NO. DATE

JP 2002139839 A2 20020517 JP 2000-332955 20001031

-----

OTHER SOURCE(S):

MARPAT 136:393267

307976-27-8

RL: TEM (Technical or engineered material use); USES (Uses) (acid-decomposable polymer; pos.-working photoresist compns. with high

sensitivity and reduced standing wave effect)

RN307976-27-8 CAPLUS

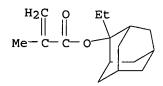
CN

2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2



CM

CRN 156938-13-5 CMF C10 H14 O4

CRN 79-41-4 CMF C4 H6 O2

CH<sub>2</sub> || Me-- C-- CO<sub>2</sub>H

AB The compns. contain photoacid generators (A), polymers (B) having alicyclic hydrocarbon structures in the main or side chains and good soly. in alkali developing agents by acid-induced decompn., and compds. (C) shown as RXC:OOH (R = F-contg. hydrocarbyl; X = F-free divalent linking group). The compns., useful for microphotofabrication using ArF excimer laser in semiconductor device fabrication, give resist patterns with good pattern profiles and reduced standing wave effect.

L6 ANSWER 12 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 12

ACCESSION NUMBER:

2002:364225 CAPLUS

DOCUMENT NUMBER:

136:393266

TITLE:

Positive-working resist compositions with high

sensitivity and resolution

INVENTOR(S):

Fujimori, Toru; Tan, Shiro; Nakao, Hajime

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

COVERGE (S)

Jpn. Kokai Tokkyo Koho, 45 pp.

SOURCE:

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2002139837

A2 20020517

MARPAT 136:393266

JP 2000-332733 20001031

OTHER SOURCE(S):

IT 307976-27-8

RL: TEM (Technical or engineered material use); USES (Uses) (acid-decomposable polymer; pos.-working photoresist compns. with high sensitivity and reduced standing wave effect)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CRN 156938-13-5 CMF C10 H14 O4

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-C-CO}_2 \text{H} \end{array}$$

The compns. contain photoacid generators (A), polymers (B) having AB alicyclic hydrocarbon structures in the main or side chains and good soly. in alkali developing agents by acid-induced decompn., and compds. (C) shown as RWC:00B (R = F-contg. hydrocarbyl; W = F-free divalent org. group; B = acid-decomposable group). The compns., useful for microphotofabrication using ArF excimer laser in semiconductor device fabrication, give resist patterns with good pattern profiles and reduced standing wave effect.

ANSWER 13 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 13

ACCESSION NUMBER:

2002:292089 CAPLUS 136:316934

DOCUMENT NUMBER: TITLE:

SOURCE:

Positive-working photoresist composition for

fabrication of semiconductor device

INVENTOR(S):

Sato, Kenichiro

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 51 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

LANGUAGE:

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. DATE KIND APPLICATION NO. DATE ---------\_\_\_\_\_\_ JP 2002116544 A2 20020419 JP 2000-310761 20001011

OTHER SOURCE(S):

MARPAT 136:316934

IT 412015-90-8

RL: TEM (Technical or engineered material use); USES (Uses) (pos.-working photoresist compn. for fabrication of semiconductor device)

RN 412015-90-8 CAPLUS

CN 2-Propenoic acid, 5-hydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione and 5-oxo-4-oxatricyclo[4.3.1.13,8]undec-1-yl 2-propenoate (9CI) (CA INDEX

NAME)

CM 1

CRN 333359-29-8 CMF C14 H20 O3

CM 2

CRN 265999-35-7 CMF C13 H16 O4

CM 3

CRN 498-66-8 CMF C7 H10



CM 4

CRN 108-31-6 CMF C4 H2 O3 GI

Ι

AB The photoresist compn. contains a resin whose soly. rate in alk. developer increases by reaction with an acid and having a norbornene-based repeating unit I (a = 0, 1) and a OH group-contg. alicyclic hydrocarbyl ester group, and a compd. generating an acid upon irradn. with an actinic ray or radiation. The photoresist provides little fault pattern having improved adhesion to an inorg. antireflection film.

L6 ANSWER 14 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 14

ACCESSION NUMBER:

2002:237124 CAPLUS

DOCUMENT NUMBER:

136:286589

TITLE:

Positive-working chemically amplified photoresist

composition containing specific acid-sensitive resin

and specific nitrogen-containing compound for

semiconductor device fabrication

INVENTOR(S):

Fujimori, Toru; Kawabe, Yasumasa; Nakao, Hajime

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 92 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. APPLICATION NO. KIND DATE DATE - - - **-**\_\_\_\_\_ \_\_\_\_\_ JP 2002090987 A2 20020327 JP 2001-209543 20010710 PRIORITY APPLN. INFO.: JP 2000-211642 A 20000712 OTHER SOURCE(S): MARPAT 136:286589

IT 398140-88-0P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resin in pos.-working photoresist compn.)

RN 398140-88-0 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CRN 242129-35-7 CMF C11 H12 O4

CM . 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

AB The title compn. contains a resin, which has an alicyclic hydrocarbon group, increasing the soly. rate in an alkali by reacting with an acid, a photo-acid generator, and a nitrogen-contg. compd., wherein the nitrogen-contg. compd. has group -C(=O)-N(OH)-. The compn. provides the improved line-edge roughness on the photoresist.

L6 · ANSWER 15 OF 76 CAPLUS COPYRIGHT 2002 ACS

2002:113853 CAPLUS

ACCESSION NUMBER: DOCUMENT NUMBER:

136:168215

TITLE:

Removal of metals from alicyclic polymers with high

**DUPLICATE 15** 

energy efficiency

INVENTOR (S): Nakase, Yoshihisa; Kakinoki, Katsuyuki; Murata,

Kiyoshi

PATENT ASSIGNEE(S): Jsr Ltd., Japan

SOURCE: Jpn. Kokai Tokkyo Koho, 15 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE --------------JP 2002047309 A2 20020212 JP 2000-231057 20000731

IT 330576-52-8P

> RL: IMF (Industrial manufacture); PEP (Physical, engineering or chemical process); PRP (Properties); PYP (Physical process); TEM (Technical or engineered material use); PREP (Preparation); PROC (Process); USES (Uses) (removal of metals from alicyclic polymers with high energy efficiency)

RN330576-52-8 CAPLUS

2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with CN 2,5-furandione and 1,2,3,4,4a,5,8,8a-octahydro-1,4:5,8-dimethanonaphthalen-2-ol (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 7388-87-6 CMF C12 H16 O

CM 3

CRN 108-31-6 CMF C4 H2 O3

The metals are removed by either (1) passing monomer solns. through a zeta AB potential-generating filter and polymg. the monomers to prep. the polymers or (2) passing the polymer solns. through the filter to purify the polymer. The alicyclic polymers are useful for photoresist materials. Thus, a THF soln. of a 1,2,3,4,4a,5,8,8a-octahydro-1,4:5,8-dimethanonaphthalen-2-ol-maleic anhydride-2-methyl-2-adamantyl acrylate copolymer contg. 140 ppb Na and 71 ppb Fe was passed through a Zeta Plus GN filter giving a soln. contg. 40 ppb Na and 45 ppb Fe.

L6 ANSWER 16 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 16

ACCESSION NUMBER: 2002:65851 CAPLUS

DOCUMENT NUMBER: 136:126557

TITLE: Radiation-sensitive chemically amplified resist resin

composition for semiconductor device fabrication Nishimura, Yukio; Doki, Katsuji; Yamamoto, Masashi;

INVENTOR(S): Nishimura, Yukio; Doki, Katsuji; Yamamoto

Kajita, Toru; Shimokawa, Tsutomu

PATENT ASSIGNEE(S): JSR Ltd., Japan

SOURCE: Jpn. Kokai Tokkyo Koho, 29 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2002023371 A2 20020123 JP 2000-204223 20000705

IT 391262-41-2P 391262-43-4P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

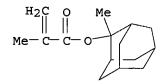
(resin in radiation sensitive chem. amplified resist resin compn.)

RN 391262-41-2 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 3-(1-oxo-2-propenyl)-2-oxazolidinone (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2



CM 2

CRN 2043-21-2 CMF C6 H7 N O3

RN 391262-43-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and 3-(1-oxo-2-propenyl)-2-oxazolidinone (9CI) (CA INDEX NAME)

CM 1

CRN 391262-42-3 CMF C14 H20 O3

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 2043-21-2 CMF C6 H7 N O3

$$\begin{array}{c}
0\\
||\\
C-CH=CH_2\\
\\
\end{array}$$

AB The title compn. contains a resin becoming alkali sol. by an acid and a photoacid generator, wherein the resin contains substituted 2-oxazoline groups in the side chain. The compn., which contains the resin having 2-oxazolidone deriv. in the side chain, provides a resist of the sensitivity, resoln., pattern profile.

L6 ANSWER 17 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 17

ACCESSION NUMBER: 2002:23773 CAPLUS

DOCUMENT NUMBER: 136:93490

TITLE: Copolymer having specific terminal groups for

chemically amplified photoresist composition

INVENTOR(S): Momose, Akira; Wakabayashi, Shigeo

PATENT ASSIGNEE(S): Mitsubishi Rayon Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 14 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

LANGUAGE:

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

----------JP 2000-392856 JP 2002006502 A2 20020109 20001225

PRIORITY APPLN. INFO.: JP 2000-120083 A 20000420

OTHER SOURCE(S): MARPAT 136:93490

IT 386729-59-5P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(copolymer having specific terminal groups for chem. amplified photoresist compn.)

RN386729-59-5 CAPLUS

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, CN telomer with ethyl 2-propenoate, 1-octanethiol and tetrahydro-5-oxo-3furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 111-88-6 CMF C8 H18 S

 $HS-(CH_2)_7-Me$ 

CM 2

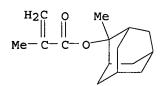
CRN 386729-58-4

(C15 H22 O2 . C8 H10 O4 . C5 H8 O2)x

CCI PMS

CM 3

CRN 177080-67-0 CMF C15 H22 O2



CM

CRN 130224-95-2 CMF C8 H10 O4

$$\begin{picture}(20,0) \put(0,0){\line(0,0){0.5ex}} \put(0,0){\line(0,0){0.5e$$

CRN 140-88-5 CMF C5 H8 O2

. || EtO- C- CH--- CH<sub>2</sub>

AB The invention relates to a copolymer for chem. amplified photoresist compn. has alicyclic repeating units and lactone-based repeating units, wherein the copolymer has a terminal group (R1)(R2)(R3)C- (R1-2 = H, C1-10 alkyl, carbonyl-contg. group, etc.; R3 = CN, C2-10 cyanoalkyl). The copolymer provides the photoresist of improved sensitivity and the resoln ans is suitable for use in photolithog.

L6 ANSWER 18 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 18

ACCESSION NUMBER:

2002:119352 CAPLUS

DOCUMENT NUMBER:

136:175472

TITLE:

Positive photosensitive composition for

photofabrication using deep UV ray

INVENTOR(S):
PATENT ASSIGNEE(S):

Kodama, Kunihiko; Aoai, Toshiaki Fuji Photo Film Co., Ltd., Japan

SOURCE:

Eur. Pat. Appl., 120 pp.
CODEN: EPXXDW

DOCUMENT TYPE:

Patent

LANGUAGE:

English

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE
EP 1179750 A1 20020213 EP 2001-117796 20010802

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2002122994 A2 20020426 JP 2001-188670 20010621 US 2002051933 A1 20020502 US 2001-921691 20010806 PRIORITY APPLN. INFO.: JP 2000-240059 A 20000808

IT 398140-88-0P

RL: PRP (Properties); SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resin; deep UV photofabrication pos. photoresist compn. contg.)

RN 398140-88-0 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CRN 242129-35-7 CMF C11 H12 O4

CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

AB A pos. photosensitive compn. comprises: (A) a compd. generating an acid upon irradn. with one of an actinic ray and radiation; (B) a resin contg. a monocyclic or polycyclic alicyclic hydrocarbon structure and increasing the soly: to an alkali developer by the action of an acid; and (C) an onium salt of carboxylic acid. The present invention relates to a pos. photosensitive compn. for use in the prodn. process of a semiconductor such as IC, in the prodn. of a circuit board such as liq. crystal and thermal head, and in other photofabrication processes.

REFERENCE COUNT:

THERE ARE 13 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 19 OF 76 USPATFULL

ACCESSION NUMBER:

2002:99037 USPATFULL

13

TITLE: INVENTOR(S): Positive photosensitive composition Kodama, Kunihiko, Shizuoka, JAPAN Aoai, Toshiaki, Shizuoka, JAPAN

PATENT ASSIGNEE(S):

FUJI PHOTO FILM CO., LTD. (non-U.S. corporation)

NUMBER KIND DATE

PATENT INFORMATION:

US 2002051933

A1 20020502

APPLICATION INFO.:

US 2001-921691

20010806 (9) A1

NUMBER

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DATE

PRIORITY INFORMATION:

JP 2000-240059

20000808

DOCUMENT TYPE:

Utility

FILE SEGMENT:

APPLICATION

LEGAL REPRESENTATIVE:

SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC, 2100

Pennsylvania Avenue, N.W., Washington, DC, 20037

NUMBER OF CLAIMS: 20

EXEMPLARY CLAIM:

1

LINE COUNT:

2260

CAS INDEXING IS AVAILABLE FOR THIS PATENT. IT 398140-88-0P

(resin; deep UV photofabrication pos. photoresist compn. contg.)

RN398140-88-0 USPATFULL

Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, CN

polymer with 2,5-furandione, hexahydro-2-oxo-3,5-methano-2H-

cyclopenta[b] furan-6-yl 2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-

2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 242129-35-7 CMF C11 H12 O4

CM 3

CRN 154970-45-3 CMF C12 H18 O2

CRN 108-31-6 CMF C4 H2 O3

AB A positive photosensitive composition comprises: (A) a compound generating an acid upon irradiation with one of an actinic ray and radiation; (B) a resin containing a monocyclic or polycyclic alicyclic hydrocarbon structure and increasing the solubility to an alkali developer by the action of an acid; and (C) an onium salt of carboxylic acid.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 20 OF 76 USPATFULL

ACCESSION NUMBER:

2002:8180 USPATFULL

TITLE:

Novel ester compounds, polymers, resist compositions

and patterning process

INVENTOR (S):

Hasegawa, Koji, Niigata-ken, JAPAN Nishi, Tsunehiro, Niigata-ken, JAPAN Kinsho, Takeshi, Niigata-ken, JAPAN Watanabe, Takeru, Niigata-ken, JAPAN Nakashima, Matsuo, Niigata-ken, JAPAN Tachibana, Seiichiro, Niigata-ken, JAPAN

Hatakeyama, Jun, Niigata-ken, JAPAN

PATENT ASSIGNEE(S):

Shin-Etsu Chemical Co., Ltd., Tokyo, JAPAN (non-U.S.

corporation)

NUMBER DATE

PRIORITY INFORMATION:

JP 2000-119410 20000420

DOCUMENT TYPE:

Utility

FILE SEGMENT:

APPLICATION

LEGAL REPRESENTATIVE:

MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS:

1

EXEMPLARY CLAIM: NUMBER OF DRAWINGS:

1 Drawing Page(s)

LINE COUNT:

1600

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 366809-11-2P

(polymers of ester compds. for photoresist and patterning)

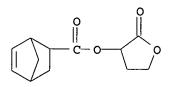
RN 366809-11-2 USPATFULL

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, tetrahydro-2-oxo-3-furanyl

ester, polymer with 2,5-furandione and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

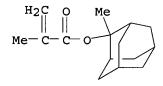
CM 1

CRN 264193-09-1 CMF C12 H14 O4



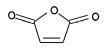
CM 2

CRN 177080-67-0 CMF C15 H22 O2



CM 3

CRN 108-31-6 CMF C4 H2 O3



AB An ester compound of the following formula (1) is provided. ##STR1##

R.sup.1 is H, methyl or CH.sub.2CO.sub.2R.sup.3, R.sup.2 is H, methyl or CO.sub.2R.sup.3, R.sup.3 is C.sub.1-C.sub.15 alkyl, k is 0 or 1, Z is a divalent C.sub.2-C.sub.20 hydrocarbon group which forms a single ring or bridged ring with the carbon atom and which may contain a hetero atom, m is 0 or 1, n is 0, 1, 2 or 3, and 2m+n=2 or 3. A resist composition comprising as the base resin a polymer resulting from the ester compound is sensitive to high-energy radiation, has excellent sensitivity, resolution, and etching resistance, and is suited for micropatterning using electron beams or deep-UV.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 21 OF 76 CAPLUS COPYRIGHT 2002 ACS

2001:582183 CAPLUS

ACCESSION NUMBER: DOCUMENT NUMBER:

135:160158

TITLE:

Polymeric compound for photoresist and resin

composition for photoresist

INVENTOR(S):

Funaki, Yoshinori; Tsutsumi, Kiyoharu; Takaragi, Akira

DUPLICATE 19

PATENT ASSIGNEE(S):

Daicel Chemical Industries, Ltd., Japan

SOURCE:

PCT Int. Appl., 120 pp. CODEN: PIXXD2

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
	WO 2001057597 W: KR, US	A1	20010809	WO 2001-JP515	20010126
	RW: DE, FR,	GB			
	JP 2001215703	A2	20010810	JP 2000-24527	20000201
	EP 1172694	A1	20020116	EP 2001-949041	20010126
	R: DE, FR,	GB			
PRIO	RITY APPLN. INFO.	:		JP 2000-24527 A	20000201
				WO 2001-JP515 W	20010126

## 353289-89-1P IT

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(polymeric compd. for photoresist and resin compn. for photoresist)

RN353289-89-1 CAPLUS

2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with CN2,5-furandione and 3a,4,7,7a-tetrahydro-4,7-methanoisobenzofuran-1(3H)-one (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 85718-44-1 CMF C9 H10 O2

CM

108-31-6 CMF C4 H2 O3

GI

AB The invention relates to a polymeric compd. for photoresists which comprises monomer units represented by formula I; and a resin compn. for photoresists which comprises the polymeric compd. and a photo-acid generator. The compn., which contains 3-(hydroxymethyl)-2-Norbornanecarboxylic acid .gamma.-lactone based repeating unit, has high adhesion to substrates and can precisely form a fine pattern.

REFERENCE COUNT: 19 THERE ARE 19 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 22 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 20

ACCESSION NUMBER: 2001:115197 CAPLUS

DOCUMENT NUMBER: 134:185945

TITLE: Polymer for photoresists and resin compositions for

photoresists

INVENTOR(S): Funaki, Yoshinori; Tsutsumi, Kiyoharu; Takaragi,

Akira; Inoue, Keizo

PATENT ASSIGNEE(S): Daicel Chemical Industries, Ltd., Japan

SOURCE: PCT Int. Appl., 152 pp.

CODEN: PIXXD2

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO. DATE
WO 2001010916 W: KR, US	A1	20010215	WO 2000-JP5168 20000802
RW: DE, FR,	GB		
JP 2001048931	A2	20010220	JP 1999-223110 19990805
JP 2001048933	A2	20010220	JP 1999-223144 19990805
EP 1172384	A1	20020116	EP 2000-949953 20000802
R: DE, FR,	GB		
PRIORITY APPLN. INFO	. :		JP 1999-223110 A 19990805
			JP 1999-223144 A 19990805
			WO 2000-JP5168 W 20000802

## IT 325991-46-6P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(polymer for photoresists and resin compns. for photoresists)

RN 325991-46-6 CAPLUS

CN 2-Propenoic acid, 1,5-dihydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CRN 325991-12-6 CMF C14 H20 O4

CM 2

CRN 249562-06-9 CMF C14 H20 O2

GI

\* STRUCTURE DIAGRAM TOO LARGE FOR DISPLAY - AVAILABLE VIA OFFLINE PRINT \*

AB A polymer comprises at least one kind of monomer units selected from I-IV (R1 = H, Me; R2,3 = H, OH, etc.; R5,6 = H, OH, CO; R7-9 = H, Me; R10,11 = C1-8 hydrocarbon; R12-14 = H, OH, Me), with the proviso that when the polymer comprises monomer units of III. It must also contain at least another kind of monomer units selected from among those represented by general formula V (R15,16 = H, OH, COOH; R17 = OH, CO, COOH) or the like. This polymer is excellent not only in transparency, soly. in alkali and tight adhesion but also in etching resistance, thus being useful as the resin for photoresists.

REFERENCE COUNT: 12 THERE ARE 12 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 23 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 21

ACCESSION NUMBER: 2001:178377 CAPLUS

DOCUMENT NUMBER: 134:229705

TITLE: Chemically amplified photoresist compositions and

process for the formation of stable photoresist

patterns

INVENTOR(S): Takechi, Satoshi; Kotachi, Akiko; Nozaki, Koji; Yano,

Ei; Watanabe, Keiji; Namiki, Takahisa; Igarashi, Miwa;

Makino, Yoko; Takahashi, Makoto

PATENT ASSIGNEE(S): Fujitsu Limited, Japan

SOURCE: U.S., 55 pp., Cont.-in-part of U.S. 6,013,416.

CODEN: USXXAM

DOCUMENT TYPE: Patent LANGUAGE: English

FAMILY ACC. NUM. COUNT: 3

## PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO. DATE
US 6200725	B1	20010313	US 1997-969368 19971128
JP 09090637	A2	19970404	JP 1995-312722 19951130
JP 3297272	B2	20020702	
JP 09073173	A2	19970318	JP 1996-50264 19960307
US 6013416	Α	20000111	US 1996-673739 19960627
US 5968713	Α	19991019	US 1997-896833 19970718
US 2001003640	A1	20010614	US 2000-739259 20001219
US 6329125	B2	20011211	
PRIORITY APPLN. INFO.	:		JP 1995-162287 A 19950628
			JP 1995-178717 A 19950714
			JP 1995-312722 A 19951130
			JP 1996-50264 A 19960307
			US 1996-673739 A2 19960627
			JP 1996-320105 A 19961129
			US 1997-969368 A3 19971128

## IT 186586-03-8P

RL: PEP (Physical, engineering or chemical process); PRP (Properties); SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); PROC (Process); USES (Uses)

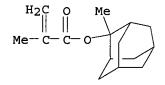
(prepn. of alkali-insol. polymers and copolymers for chem. amplified photoresist compn.)

RN 186586-03-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-propenal (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2



CM 2

CRN 107-02-8 CMF C3 H4 O

H2C== CH- CH== O

GI

An alkali-developable, chem. amplified photoresist compn. which comprises (1) an alkali-insol. polymer or copolymer comprising a structural unit contg. a protected alkali-sol. group in which unit a protective moiety of said protected alkali-sol. group contains a group represented by I (R1 = CH3, C2H5, Pr or i-Pr which may be substituted, Z = atoms necessary to complete an alicyclic hydrocarbon group along with a carbon atom) and (2) a photoacid generator capable of being decompd. upon exposure to a patterning radiation to produce an acid capable of causing cleavage of said protective moiety. The resist compn. can exhibit a high sensitivity (not more than 5 mJ/cm2) and therefore is particularly suitable for ArF lithog. and also can exhibit stable patterning properties.

REFERENCE COUNT:

THERE ARE 2 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 24 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 22

2

ACCESSION NUMBER: 2001:760380 CAPLUS

DOCUMENT NUMBER:

135:310933

TITLE:

Positive photoresists showing minimized dependency on

pattern density for deep-UV photolithography

INVENTOR(S):

Kodama, Kunihiko; Sato, Kenichiro; Aogo, Toshiaki Fuji Photo Film Co., Ltd., Japan

PATENT ASSIGNEE(S): SOURCE:

Jpn. Kokai Tokkyo Koho, 77 pp.

CODEN: JKXXAF

Patent

DOCUMENT TYPE: LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001290276 A2 20011019 JP 2000-383801 20001218

PRIORITY APPLN. INFO:: JP 1999-358017 A 19991216

JP 2000-28237 A 20000204

OTHER SOURCE(S):

MARPAT 135:310933

IT 307976-27-8P 332877-30-2P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

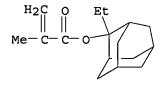
(chem.-amplified deep-UV pos. photoresists contg. fluoroalkylsulfonate salts as photoacid generators)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2



CM 2

CRN 156938-13-5 CMF C10 H14 O4

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-C-CO}_2 \text{H} \end{array}$$

RN 332877-30-2 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-(2-hydroxyethoxy)ethyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 177080-66-9 CMF C10 H14 O4

CM 3

CRN 2351-43-1 CMF C8 H14 O4

$$^{\rm H_2C}_{||}$$
 0 || || Me-C-C-O-CH<sub>2</sub>-CH<sub>2</sub>-O-CH<sub>2</sub>-OH

GI

$$\begin{array}{c} R^{01} \\ -(CH_{2}C) - \\ c = 0 \\ 0 \\ R^{02} \\ 0 \\ I \\ 0 \\ Z^{2} \\ 0 \\ II \\ R^{11'} \\ R^{12'} \\ III \end{array}$$

The photoresists, for ultramicrolithog. utilizing .ltoreq.220-nm actinic AB rays (esp. ArF excimer lasers), comprise (A) photoacid generators RFSO3-X+ [X = iodonium or sulfonium (Markush given); RF = C1-10 fluoroalkyl] where .gtoreg.1 pair of them satisfy difference in carbon no. of RF moieties 2-8 and (B) C.gtoreq.6-alicyclic group-bearing acid-labile polymers. Suitable polymers consist of I [R01 = H, C1-4 alkyl; R02 = C1-4 alkyl; W = single bond, alkylene, (thio)ether, carbonyl, and/or ester] and [CH2:CR'01(CO2WLc)] (Ra-f = H, C1-4 alkyl essentially contg. single bond or C1-4 alkylene; m, n = 0-3 integer; (m + n) = 2-6 integer). Other suitable polymers consist of (i) [CH(COXAR'1)CH(COXAR'2)] [R'1, R'2 = H, cyano, OH, etc.; X = O, S, NH, NHSO2, NHSO2NH; A = single bond, bivalent bridge] or II [Z2 = 0, NR'3 [R'3 = H, OH, OSO2R'4 [R'4 = (halo)alkyl,cycloalkyl, camphor residue]]] and (ii) III [R'11, R'12 = H, cyano, halo, alkyl; Z = (substituted) alicyclic group]. The photoresists may contain N-contg. basic compds. and/or F- and/or silicone-contg. surfactants. The photoresists show high resoln. and excellent pattern profile.

ANSWER 25 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 23

ACCESSION NUMBER:

2001:736886 CAPLUS 135:280515

DOCUMENT NUMBER: TITLE:

(Meth)acrylate ester polymer for photoresist and

photoresist composition

INVENTOR(S):

Arai, Takashi; Funaki, Katsunori; Sudo, Shinji

Daicel Chemical Industries, Ltd., Japan

SOURCE:

CN

Jpn. Kokai Tokkyo Koho, 20 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

. LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT ASSIGNEE(S):

PATENT NO. KIND DATE APPLICATION NO. DATE . . . . . . . . . . . . . . . JP 2001278919 A2 20011010 JP 2000-93286 20000330

IT 364063-50-3P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photoresist contg. (meth)acrylate ester polymer involving acid-sensitive leaving group with good adhesion to substrate)

RN364063-50-3 CAPLUS

> 2-Propenoic acid, 2-methyl-, butyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and

tetrahydro-5,5-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 280552-09-2 CMF C10 H14 O4

$$\begin{array}{c|c} & & & \\ & & & \\ \text{H}_2\text{C} & \text{O} & & \\ \parallel & \parallel & \\ \text{Me}-\text{C}-\text{C}-\text{O} & & \\ \end{array}$$

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 97-88-1 CMF C8 H14 O2

The polymer involves repeating units substituted with acid-sensitive leaving group, another repeating units substituted with groups for enhancing adhesion to substrates, and [CH2C(R1)CO2R2] (R1 = H, Me; R2 = C3-8 alkyl except tertiary alkyl). The photoresist compn. contains the polymer and a photosensitive acid-generating agent. The compn. shows good film-forming property assocd. with good alkali soly. and good adhesion to substrates. The compn. is applied on a substrate, exposed, and developed to give a pattern in semiconductor device fabrication.

6 ANSWER 26 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 24

ACCESSION NUMBER:

2001:726599 CAPLUS 135:280647

DOCUMENT NUMBER: TITLE:

Photosensitive resin compositions having high

sensitivity and their color filters having patterns

with uniform thickness

INVENTOR(S):

Kadono, Tomonobu

PATENT ASSIGNEE(S):

Dainippon Printing Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 7 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001272780 A2 20011005 JP 2000-87908 20000328

IT 261631-25-8P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photosensitive resin compns. with suppressed thermal shrinkage and discoloration for display color filters)

RN 261631-25-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with methyl 2-methyl-2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 80-62-6 CMF C5 H8 O2

$$H_2C$$
 O  $\parallel$   $\parallel$   $\parallel$   $Me-C-C-OMe$ 

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$^{\rm CH_2}_{||}_{\rm Me^-\,C^-\,CO_2H}$$

L6

AB The photosensitive resin compns. contain (a) photopolymn. initiators, (b) monomers bearing unsatd. double bonds, polyfunctional acrylate monomers preferably, (c) epoxy resins, and (c) alicyclic compd.-contg. resins which are prepd. by polymg. monomers bearing at least vinyl groups and/or isopropenyl groups, preferably, one of the double-bonded C in these groups being linked to carboxyl groups. Discoloration which causes energy loss of UV and thermal shrinkage of the compns. have been suppressed.

ACCESSION NUMBER:

2001:644598 CAPLUS

DOCUMENT NUMBER:

135:218729

TITLE:

Lactone ring-containing polymers and resin

compositions for photoresists

INVENTOR (S):

Gokochi, Toru; Okino, Takeshi; Asakawa, Koji; Shinoda,

Naomi; Funaki, Katsunori; Tsutsumi, Kiyoharu; Horai,

Akira

PATENT ASSIGNEE(S):

Toshiba Corp., Japan; Daicel Chemical Industries, Ltd.

Jpn. Kokai Tokkyo Koho, 49 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

SOURCE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE \_\_\_\_\_\_ --**-**-------JP 2001240625 A2 20010904 JP 2000-49549 20000225

IT 357340-58-0P

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

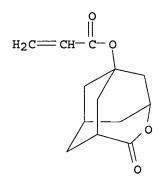
(prepn. of lactone ring-contg. polymers for photoresists)

357340-58-0 CAPLUS RN

2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with CN 5-oxo-4-oxatricyclo[4.3.1.13,8]undec-1-yl 2-propenoate and 4-oxotricyclo[3.3.1.13,7]dec-1-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 265999-35-7 CMF C13 H16 O4



CM 2

249562-06-9 CRN CMF C14 H20 O2

3

GI

AB Photoresist compns. contain polymers contg. monomer units I and/or II (R1, Ra-Rg = H, Me; X1-X3 = CH2, CO2; at least one of X1-X3 is CO2; m, p, q = 0-2) and photoacid generators. The compns. show good adhesion to substrates such as Si and can precisely form fine patterns in semiconductor manufg.

L6 ANSWER 28 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 26

ACCESSION NUMBER:

2001:579376 CAPLUS

DOCUMENT NUMBER:

135:172987

TITLE:

Positive-working chemically amplified photoresist

composition containing carboxylic acids of low

molecular weight

INVENTOR(S):

Kodama, Kunihiko; Sato, Kenichiro; Aogo, Toshiaki

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 36 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001215709 A2 20010810 JP 2000-29257 20000207

IT 307976-27-8P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(acid-sensitive resin in pos.-working chem. amplified photoresist compn.)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 156938-13-5 CMF C10 H14 O4

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-- C-- CO}_2\text{H} \end{array}$$

GΙ

Ι

AB The title compn. contains an acid-sensitive resin which increases the dissoln. rate on reacting with an acid, and a photoacid generator, wherein .ltoreq.2,000 mol. wt. carboxylic acid is added to the compn. The resin

has repeating units I and [-CH2-C(R1)(COO-W-Lc)-] ( R1 = H, Me, Lc = .gamma.-lactone deriv.; R2 = C1-4 alkyl; W = single bond, alkylene, ether, thioether, etc.). The resist compn., which the low mol. wt. carboxylic acids, provides the high sensitivity, the high resoln., the reduced residue of the development using the acid-sensitive resin.

ANSWER 29 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 27

ACCESSION NUMBER: 2001:496392 CAPLUS

DOCUMENT NUMBER: 135:99845

TITLE: Positive-working photoresist composition containing

alkali-soluble polymer with silyl group

INVENTOR(S): Mizutani, Kazuyoshi; Yanami, Shoichiro

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 52 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ----------JP 2001188349 A2 20010710 JP 2000-303876 20001003 PRIORITY APPLN. INFO.: JP 1999-298606 A 19991020

348129-27-1P 348129-35-1P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos.-working photoresist compn. contg. binder with silyl group, acid generator, org. base, and surfactant)

348129-27-1 CAPLUS RN

2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with CN 2,5-furandione and trimethyl-2-propenylsilane (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 762-72-1 CMF C6 H14 Si

 $Me_3Si-CH_2-CH----CH_2$ 

CM 3

CRN 108-31-6 CMF C4 H2 O3

RN 348129-35-1 CAPLUS

CN 2-Propenoic acid, butyl ester, polymer with 2,5-furandione, 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-propenoate and trimethyl-2-propenylsilane (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 762-72-1 CMF C6 H14 Si

$$Me_3Si-CH_2-CH-CH_2$$

CM 3

CRN 141-32-2 CMF C7 H12 O2

$$\overset{\text{O}}{\parallel}_{\text{n-BuO-C-CH-----}}\text{CH}_{2}$$

CM 4

CRN 108-31-6 CMF C4 H2 O3

AB The compn. comprises (A) a binder resin having a repeating unit bearing a structure (CH2)nSiR1R2R3 (R1-3 = alkyl, haloalkyl, halo, alkoxy, trialkylsilyl, trialkylsilyloxy; n = 0, 1) and a repeating unit bering a group which decomps. by the action of an acid and increases the soly. in an alk. developer at the side chain, (B) a compd. generating an acid by the action of an actinic ray or radiation, (C) a solvent dissolving A and

B, (D) an org. base compd., (E) .gtoreq.l surfactant selected from a fluorosurfactant, a silicone surfactant, and a nonionic surfactant. The compn. shows high resoln. and gives patterns with rectangular cross section and is useful for manuf. of semiconductor device.

L6 ANSWER 30 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 28

ACCESSION NUMBER: 2001:496391 CAPLUS

DOCUMENT NUMBER: 135:99844

TITLE: Positive-working photoresist composition containing

vinyl copolymer with silyl group

INVENTOR(S): Mizutani, Kazuyoshi; Yasunami, Shouichiro

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 42 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 2

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001188348 A2 20010710 JP 2000-303875 20001003

PRIORITY APPLN. INFO: JP 1999-298606 A 19991020

IT 348129-27-1P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos.-working photoresist compn. contg. vinyl copolymer with silyl group and acid generator)

RN 348129-27-1 CAPLUS

CN 2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2,5-furandione and trimethyl-2-propenylsilane (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 762-72-1 CMF C6 H14 Si

 $Me_3Si-CH_2-CH-CH_2$ 

CM 3

CRN 108-31-6 CMF C4 H2 O3

GI

AB The photoresist compn. comprises (A) a binder resin whose soly. in an alk. developer increases by the action of an acid and having repeating units CH2CH[(CH2)nSiR1R2R3] (R1-3 = alkyl, haloalkyl, halo, alkoxy, trialkylsilyl, trialkylsilyloxy; n = 0,1) CH2CY(LCO2Q) (Y = H, Me, cyano, Cl; L = bond, divalent linkage,; Q = C5-20 tert-alkyl, alkoxymethyl, alkoxyethyl, isobornyl) and I (Z = O, NR3; R3 = H, OH, alkyl, OSO2R4; R4 = alkyl, trihalomethyl), (B) a compd. generating an acid by the action of an actinic ray or radiation, and (C) a solvent dissolving A and B. The compn. shows high resoln., less disappearance of rough pattern at the resoln. limit, and is useful for manuf. of semiconductor devices.

L6 ANSWER 31 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 29

ACCESSION NUMBER: 2001:496390 CAPLUS

DOCUMENT NUMBER:

135:99843

TITLE:

Radiation-sensitive polymer compositions with good dry

etching resistance for semiconductor fabrication Ishii, Hiroyuki; Doki, Katsuji; Kajita, Toru;

Shimokawa, Tsutomu

PATENT ASSIGNEE(S):

JSR Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 36 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

INVENTOR(S):

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001188347 A2 20010710 JP 2000-137757 20000510
PRIORITY APPLN. INFO.: JP 1999-296028 A 19991018

IT 348631-22-1P 348631-34-5P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(radiation-sensitive resists using alicyclic group-contg. acrylic polymers with good dry etching resistance)

RN 348631-22-1 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and 4-oxotricyclo[3.3.1.13,7]dec-1-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 216582-09-1 CMF C13 H16 O3

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

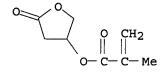
RN 348631-34-5 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

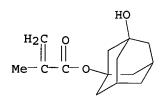
CRN 177080-67-0 CMF C15 H22 O2

CRN 130224-95-2 CMF C8 H10 O4



CM 3

CRN 115372-36-6 CMF C14 H20 O3



The compns. comprise (A) acid-dissocg. group-contg. alkali-insol. polymers having CR1[C(:0)OAR2]CH2 and CR6[C(:0)OR7]CH2 (R1, R6 = H, C1-4 alkyl, alkoxy, or hydroxyalkyl; A = single bond, C1-4 alkylene; R2 = R3X1, R4:X2, R5.tplbond.X3; R3-R5 = C4-20 alicyclic group; X1-X3 = O- or N-contg. group; R7 = C4-20 alicyclic group, CR83; R8 = C1-4 alkyl or alicyclic group) and showing alkali. soly. by dissocn. of the acid-dissocg. groups and (B) acid generators. The compns. show good storage stability, high transparency for radiation, and high resoln.

L6 ANSWER 32 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 30

ACCESSION NUMBER: 2001:356530 CAPLUS

DOCUMENT NUMBER: 134:346479

TITLE: Positive-working resist composition

INVENTOR(S): Kodama, Kunihiko; Sato, Kenichiro; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 34 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001133978 A2 20010518 JP 1999-317147 19991108

OTHER SOURCE(S): MARPAT 134:346479

IT 307976-27-8 332877-30-2

RL: POF (Polymer in formulation); TEM (Technical or engineered material use); USES (Uses)

(pos.-working resist compn. contg.)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 156938-13-5 CMF C10 H14 O4

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$^{
m CH_2}_{||}_{
m Me}-^{
m C-}_{
m CO_2H}$$

RN 332877-30-2 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-(2-hydroxyethoxy)ethyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CRN 177080-66-9 CMF C10 H14 O4

$$\begin{array}{c|c} H_2C & \text{Me} & \\ & & \\ Me-C-C-O & \\ & & \\ O & \\ \end{array}$$

CM 3

CRN 2351-43-1 CMF C8 H14 O4

$$^{\rm H_2C}$$
 O  $^{\rm H_2}$   $^{\rm H_$ 

GΙ

The pos.-working resist compn. comprises (A) a resin which has repeating units I and [H2C-CR01{C(:0)OWLc}] (R01 = H, C1-4 alkyl, etc.; R02 = C1-4 alkyl; W = single bond, alkylene, etc.; Lc = substituent) whose soly. rate increases in an alk. developer by reacting with an acid and (B) .gtoreq.1 photoacid generating a sulfonic acid. This pos.-working resist compn. showed sufficient sensitivity to a 193-nm ArF excimer laser.

6 ANSWER 33 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 31

ACCESSION NUMBER: 2001:280498 CAPLUS

DOCUMENT NUMBER: 134:318676

TITLE: Positive-working far-UV-sensitive photoresist

composition containing acid-sensitive resin having

lactone group

INVENTOR(S): Aogo, Toshiaki; Sato, Kenichiro; Kodama, Kunihiko

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 58 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ----------JP 2001109154 A2 20010420 JP 1999-285762 19991006

335163-68-3P, 2-Methyl-2-adamantylmethacrylate-IT

Bicyclo[2.2.1]heptane-2-carboxylic acid,7-hydroxy-,.gamma.-lactone,

5-exo-methacrylate ester copolymer

RL: SPN (Synthetic preparation); TEM (Technical or engineered material

use); PREP (Preparation); USES (Uses)

(pos.-working far-UV-sensitive photoresist compn.)

RN 335163-68-3 CAPLUS

CN 2-Propenoic acid, 2-methyl-, (3S,3aR,5S,6S,6aS)-hexahydro-2-oxo-3,5methano-2H-cyclopenta[b] furan-6-yl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

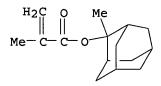
CM 1

CRN 335163-67-2 CMF C12 H14 O4

Relative stereochemistry.

CM 2

CRN 177080-67-0 CMF C15 H22 O2



AB The title compn. contains a photoacid generator and a resin, which increases the soly. towards an alkali developer reacting with an acid, of a lactone repeating group. The compn., which contains the acid-sensitive, resin having lactone group, shows the high sensitivity and provides the pattern of the high resoln., the good contact with substrate, and little edge roughness.

ACCESSION NUMBER:

2001:261353 CAPLUS

DOCUMENT NUMBER:

134:303020

TITLE:

Far-UV sensitive positive-working chemically amplified

photoresist composition for micro photolithography

INVENTOR(S):

Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 45 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT NO.

PATENT INFORMATION:

KIND DATE

APPLICATION NO. DATE \_\_\_\_\_

\_\_\_\_\_ JP 2001100421

----A2 20010413

JP 1999-280202 19990930

IT 334643-62-8P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material

use); PREP (Preparation); USES (Uses)

(resin contq. quaternary ammonium salt group in far-UV sensitive

pos.-working chem. amplified photoresist compn.)

RN334643-62-8 CAPLUS

CN 1-Propanaminium, N,N,N-triethyl-3-[(2-methyl-1-oxo-2-propenyl)oxy]-, salt with trifluoromethanesulfonic acid (1:1), polymer with

2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and

tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM1

CRN 209982-56-9 CMF C16 H24 O2

H<sub>2</sub>C

CM 2

CRN 195000-66-9 CMF C8 H10 O4

 ${\tt CH_2}$ O- C- C- Me

> CM 3

CRN 334643-61-7

CMF C13 H26 N O2 . C F3 O3 S

CM

CRN 334643-60-6

$$^{\text{H}_2\text{C}}_{\parallel}$$
 0  $^{\parallel}_{\parallel}$   $^{\parallel}_{\parallel}$  Me-C-C-O-(CH<sub>2</sub>)<sub>3</sub>-N+Et<sub>3</sub>

CRN 37181-39-8 CMF C F3 O3 S

AB The title compn. contains a photoacid generator and a resin increasing the soly. towards an alkali developer by reacting with an acid, wherein the resin has a quaternary ammonium salt group. The addn. of the acid-sensitive resin contg. quaternary ammonium salt group to the compn. provides improved development characteristics and eliminates rough edges on the pattern.

L6 ANSWER 35 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 33

ACCESSION NUMBER:

2001:143826 CAPLUS

DOCUMENT NUMBER:

134:200525

TITLE:

SOURCE:

Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S):

Aogo, Toshiaki; Sato, Kenichiro; Kodama, Kunihiko

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 55 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001056557 A2 20010227 JP 1999-234240 19990820

IT 324771-00-8P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(far UV sensitive photoresist contg. acid generator, alkali-sol. resin, and surfactant)

RN 324771-00-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with tetrahydro-2,2,3-trimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-27-5 CMF C11 H16 O4

CRN 209982-56-9 CMF C16 H24 O2

GI

$$\begin{bmatrix} R^2 \\ R^3 \end{bmatrix}_m \begin{bmatrix} R^4 \\ R^5 \end{bmatrix}_n$$

AB The compn. comprises (A) a compd. generating acid by actinic ray or radiation, (B) a resin contg. I [R1 = H, C1-4 alkyl; R2-7 = H, (substituted) alkyl, cycloalkyl, alkenyl, .gtoreq.1 of R6 and R7 is not H, R6 and R7 may form a ring; m, n = 0, 1] as a repeating unit and whose sol. in alkali is increased by the action of acid, and (C) a fluoro- and/or silicone-type surfactant. The photoresist shows high sensitivity to far UV ray and generation of development defect and edge roughness is prevented.

ANSWER 36 OF 76 CAPLUS COPYRIGHT 2002 ACS **DUPLICATE 34** 

ACCESSION NUMBER: 2001:142246 CAPLUS

DOCUMENT NUMBER: 134:200521

TITLE:

Positive-working photoresist composition for far

ultraviolet ray exposure

Aogo, Toshiaki; Sato, Kenichiro; Kodama, Kunihiko INVENTOR(S):

Fuji Photo Film Co., Ltd., Japan PATENT ASSIGNEE(S):

Jpn. Kokai Tokkyo Koho, 55 pp. SOURCE:

CODEN: JKXXAF

DOCUMENT TYPE: Patent

LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: PATENT INFORMATION:

> PATENT NO. KIND DATE APPLICATION NO. DATE ---------------**A2** JP 2001056556 20010227 JP 1999-234239 19990820

IT 324771-00-8P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material

use); PREP (Preparation); USES (Uses)
 (far UV photoresist compn. contg. alkali-sol. resin and acid generator)
324771-00-8 CAPLUS
2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester,
polymer with tetrahydro-2,2,3-trimethyl-5-oxo-3-furanyl
2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

RN

CN

CRN 324761-27-5 CMF C11 H16 O4

CM 2

CRN 209982-56-9 CMF C16 H24 O2

GI

$$\begin{bmatrix} R^3 \\ R^2 \end{bmatrix}_m \begin{bmatrix} R^4 \\ R^5 \end{bmatrix}_n$$

$$0 \qquad 0 \qquad R^7 \qquad 1$$

The compn. comprises (A) a compd. generating acid by actinic ray or radiation, (B) a resin contg. I [R1 = H, C1-4 alkyl; R2-7 = H, (substituted) alkyl, cycloalkyl, alkenyl, .gtoreq.1 of R6 and R7 is not H, R6 and R7 may form a ring; m, n = 0, 1] as a repeating unit and whose sol. in alkali is increased by the action of an acid, and (C) a solvent contg. 60-90 wt.% (based on the total solvent) of .gtoreq.1 selected from propylene glycol monomethyl ether acetate, propylene glycol monomethyl ether propionate, Me 3-methoxypropionate, Et 3-methoxypropionate, Me 3-ethoxypropionate, and Et 3-ethoxypropionate. The photoresist shows high sensitivity, resoln., dry etching resistance and generation of development defect and edge roughness is prevented.

DUPLICATE 35

ANSWER 37 OF 76 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2001:117245 CAPLUS

DOCUMENT NUMBER: 134:170832

TITLE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR (S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 48 pp.

SOURCE: Jpn. Koka

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

т. з

PATENT INFORMATION:

PATENT NO.

KIND DATE

APPLICATION NO. DATE

JP 2001042535

A2 20010216

JP 1999-211370 19990726

IT 324761-26-4P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-26-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 5-hydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-methyl-N-(methylsulfonyl)-2-propenamide and tetrahydro-2,3-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-25-3 CMF C10 H14 O4

CM 2

CRN 324761-17-3 CMF C15 H22 O3

CM 3

CRN 208761-54-0 CMF C5 H9 N O3 S

AB The title compn. contains a photoacid generator, a polymer having an alicyclic hydrocarbon group, and a surfactant, wherein the surfactant is fluoro or silicon-based. The compn. generates little faulty development and provides the good pattern profiles.

L6 ANSWER 38 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 36

ACCESSION NUMBER:

2001:117244 CAPLUS

DOCUMENT NUMBER:

134:170858

TITLE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S): SOURCE:

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 48 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2001042534	A2	20010216	JP 1999-211369	19990726

IT 324761-26-4P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-26-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 5-hydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-methyl-N-(methylsulfonyl)-2-propenamide and tetrahydro-2,3-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-25-3 CMF C10 H14 O4

CM 2

CRN 324761-17-3 CMF C15 H22 O3

CRN 208761-54-0 CMF C5 H9 N O3 S

AB The title compn. contains a photoacid generator, a polymer having an alicyclic hydrocarbon group, and a mixed solvent, wherein the solvent contains 2-heptanone. The compn. provides the good pattern profiles and the excellent storageability.

L6 ANSWER 39 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 37

ACCESSION NUMBER: 2001:117243 CAPLUS

DOCUMENT NUMBER:

134:170831

TITLE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 47 pp.

SOURCE: Jpn. Kokai To CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2001042533	A2	20010216	JP 1999-211368	19990726

IT 324761-26-4P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(alicyclic polymer in pos.-working photoresist compn.)

RN 324761-26-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 5-hydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-methyl-N-(methylsulfonyl)-2-propenamide and tetrahydro-2,3-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-25-3 CMF C10 H14 O4

CRN 324761-17-3 CMF C15 H22 O3

CM 3

CRN 208761-54-0 CMF C5 H9 N O3 S

$$\begin{array}{c|cccc} \text{O} & \text{O} & \text{CH}_2 \\ \parallel & \parallel & \parallel \\ \text{Me-} & \text{S-} & \text{NH-} & \text{C-} & \text{C-} & \text{Me} \\ \parallel & & & & & \\ \text{O} & & & & & \\ \end{array}$$

The title compn. contains a photoacid generator, a polymer having an AB alicyclic hydrocarbon group, and a mixed solvent, wherein the solvent contains propylene glycol monomethyl ether acetate or propylene glycol monomethyl ether propionate. The compn. provides the evenly coated layer and the good storageability.

ANSWER 40 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 38

ACCESSION NUMBER: DOCUMENT NUMBER:

2001:117242 CAPLUS 134:170830

TITLE:

Positive-working photoresist composition suitable for

exposed with ArF excimer laser

INVENTOR(S):

Sato, Kenichiro; Shirakawa, Hiroshi; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 47 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ---------JP 1999-211367 JP 2001042532 20010216 A2 19990726

IT 324761-26-4P

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (alicyclic polymer in pos.-working photoresist compn.)

RN 324761-26-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 5-hydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-methyl-N-(methylsulfonyl)-2-propenamide and tetrahydro-2,3-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-25-3 CMF C10 H14 O4

CM 2

CRN 324761-17-3 CMF C15 H22 O3

CM 3

CRN 208761-54-0 CMF C5 H9 N O3 S

AB The title compn. contains a photoacid generator, a polymer, and a mixed solvent contg. Et lactate and Bu acetate, wherein the polymer has an alicyclic hydrocarbon group. The compn. provides the evenly coated layer and the good storageability.

L6 ANSWER 41 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 39

ACCESSION NUMBER: 2001:98660 CAPLUS

DOCUMENT NUMBER: 134:170819

TITLE: Positive-working photoresist composition for exposure

to far ultraviolet light

INVENTOR(S): Aogo, Toshiaki; Sato, Kenichiro; Kodama, Kunihiko

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 56 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001033971 A2 20010209 JP 1999-207958 19990722

IT 324771-00-8P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos.-working photoresist compn. for exposure to far UV light for formation of pattern with high resoln. and low edge roughness)

RN 324771-00-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with tetrahydro-2,2,3-trimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-27-5 CMF C11 H16 O4

CM 2

CRN 209982-56-9 CMF C16 H24 O2

GI

$$\begin{bmatrix} R^3 \\ R^2 \end{bmatrix}_{\mathfrak{m}} \begin{bmatrix} R^4 \\ R^5 \end{bmatrix}_{\mathfrak{n}}$$

AB The title compn. contains (1) a compd. which generates acids by irradn. of actinic ray or radiation and (2) a polymer contg. a repeating unit represented by I [R1 = H, (substituted) C1-4 alkyl; R2-7 = H, (substituted) alkyl, cycloalkyl, or alkenyl, where at least R6 or R7 is group other than H; R6 and R7 may connect to form ring; m, n = 0, 1; m = n

.noteq. 0]. The polymer decomps. by acids and increases in alkali soly. The compn. is sensitive to far UV light, esp. to ArF excimer laser light, and resist patterns with low edge roughness and high resoln. can be offered.

L6 ANSWER 42 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 40

ACCESSION NUMBER: 2001:98658 CAPLUS

DOCUMENT NUMBER: 134:170817

TITLE: Positive-working photoresist composition for exposure

to far ultraviolet light

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 47 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001033969 A2 20010209 JP 1999-203676 19990716

IT 324761-26-4P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos.-working photoresist compn. contg. polymer with alicyclic group for exposure to far UV light)

RN 324761-26-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 5-hydroxy-2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-methyl-N-(methylsulfonyl)-2-propenamide and tetrahydro-2,3-dimethyl-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 324761-25-3 CMF C10 H14 O4

CM 2

CRN 324761-17-3 CMF C15 H22 O3

GΙ

$$\begin{array}{c}
O \\
\parallel \\
C \\
O \\
\end{array}$$

$$\begin{array}{c}
A \\
\end{array}$$

$$\begin{array}{c}
C \\
O \\
\end{array}$$

$$\begin{array}{c}
A \\
\end{array}$$

$$\begin{array}{c}
A \\
\end{array}$$

$$\begin{array}{c}
A \\
\end{array}$$

AB The title compn. contains (1) a compd. which generates acids by irradn. of actinic ray or radiation and (2) a polymer contg. .gtoreq.1 group with an alicyclic hydrocarbon structure represented by I (R1 = Me, Et, n- or iso-Pr, n-, iso-, or sec-butyl; ZA = at. group required for forming alicyclic hydrocarbon group; a = 1, 2) and -CO2CR2R3ZB(OH)b (R2, R3 = C1-4 alkyl; ZB = 2- or 3-valent alicyclic hydrocarbon group; b = 1, 2). The polymer has alkali soly. which increases by acids. The compn. is sensitive to far UV light, esp. to ArF excimer laser light, and resist patterns with low edge roughness can be offered.

ANSWER 43 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 41

ACCESSION NUMBER:

2001:62635 CAPLUS

DOCUMENT NUMBER:

134:123586

TITLE:

Resist resin for chemically amplified resist resin composition suitable for excimer and electron beam lithography and method for pattern formation using

same

INVENTOR(S):

Fujiwara, Tadayuki; Wakisaka, Koya Mitsubishi Rayon Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 8 pp. CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT ASSIGNEE(S):

PATENT NO. KIND DATE APPLICATION NO. DATE ----------JP 2001022076 A2 20010126 JP 1999-198165 19990712 321378-94-3P, 2-Methyl-2-adamantylmethacrylate-.beta.-methacryloxy-IT .gamma.-butyrolactone-methacryloxypropyltrimethoxysilane copolymer RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resist resin for chem. amplified resist compn. and method for pattern formation using same)

321378-94-3 CAPLUS RN

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with tetrahydro-5-oxo-3-furanyl 2-methyl-2-propenoate and 3-(trimethoxysilyl)propyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 130224-95-2 CMF C8 H10 O4

CM 3

CRN 2530-85-0 CMF C10 H20 O5 Si

$$egin{array}{c|cccc} H_2C & O & OMe \\ \parallel & \parallel & \parallel & \parallel \\ Me-C-C-O-(CH_2)_3-Si-OMe \\ \parallel & & & & & & & \\ OMe & & & & & \\ \end{array}$$

GI

AB The title resin becomes sol. in an alkali upon reacting with an acid and contains repeating unit I (R1 = H, F, Cl, alkyl, silyl; R2-4 = F, Cl, alkyl, alkoxy; n = 0, 1). The resin provides the improved dry-etching resistance.

L6 ANSWER 44 OF 76 CAPLUS COPYRIGHT 2002 ACS ACCESSION NUMBER: 2001:62631 CAPLUS

DOCUMENT NUMBER:

134:123583

TITLE:

Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S): PATENT ASSIGNEE(S): Sato, Kenichiro; Kawabe, Yasumasa Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 44 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

1

FAMILY ACC. NUM. COUNT:

Japanese

PATENT INFORMATION:

KIND DATE

APPLICATION NO. DATE

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PATENT NO.

JP 2001022072 A2 20010126

JP 1999-193603 19990707

ΙT 307976-27-8P 320779-35-9P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material

use); PREP (Preparation); USES (Uses)

(photoresist compn. contg. acid generator, alkali-sol. resin., and

solvent)

RN307976-27-8 CAPLUS

2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-CN

yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9

CMF C16 H24 O2

CM

CRN 156938-13-5 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ & & & \\ H_2C & O & & \\ \parallel & \parallel & & \\ Me-C-C-O & & Me & \\ \end{array}$$

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$^{\rm CH_2}_{||}_{\rm Me^-\,C^-\,CO_2H}$$

RN 320779-35-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-[[[(7,7-dimethyl-2-oxobicyclo[2.2.1]hept-1-yl)methyl]amino]sulfonyl]amino]propyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 320779-34-8 CMF C17 H28 N2 O5 S

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 156938-13-5 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ & & & \\ H_2C & O & & \\ \parallel & \parallel & & \\ \text{Me-} & C-C-O & & \text{Me} \end{array}$$

GI

$$\begin{array}{c|c}
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AB The title compn. contains (a) a compd. generating an acid by actinic ray or radiation irradn., (b) a resin which has .gtoreq.1 repeating unit selected from the following (i), (ii), and (iii) and is cleaved by the action of acid to increase the soly. to alkali, and (c) a mixed solvent contg. (1) heptanone and (2) .gamma.-butyrolactone, ethylene carbonate, and/or propylene carbonate. (i) a repeating unit having alkali-sol. groups protected with .gtoreq.1 group selected from alicyclic hydrocarbon structure-contg. groups I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II (R11 = Me, Et, Pr, iso-Pr, Bu, iso-Bu, sec-Bu; Z = atoms required to form an alicyclic hydrocarbon group along with the C atom; R12-16 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or either R15 or R16 is alicyclic hydrocarbon; R17-21 = H, C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is alicyclic hydrocarbon and either R19 or R21 is C1-4 straight-chain or branched alkyl or alicyclic hydrocarbon; R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R22-25 is alicyclic hydrocarbon). (ii) a repeating unit CH2CR1(CO2X1Lc)(R1 = H, halo, C1-4 straight- chain or branched alkyl; X1 =divalent linking group; Lc = lactone group). (iii) .gtoreq.1 repeating unit selected from CH2CR1(CO2H), CH2CR1X2OCR30R32CR31R33O(CR34R35CR36R37O) mR, CH2CR1(Z1R38AR39), and CH2CR1(CO2R40SO2OR41) [R1 = H, halo, C1-4 straight-chain or branched alkyl; R30-37 = H, (substituted) alkyl; R = H, alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); m = 1-10; X2 = single bond, alkylene, cyclic alkylene, arylene, divalent group which is composed of .gtoreq.1 of ether, thioether, carbonyl, ester, amide, sulfonamide, urethane, and urea groups and is not cleaved by the action of acid; Z1 = single bond, ether, ester, amide, alkylene, divalent group composed of these groups; R38 = single bond, alkylene, arylene, divalent group composed of these groups; R40= alkylene, arylene, divalent group composed of these groups; R39 = alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); R41 = H, alkyl, cyclic alkyl, alkenyl, aryl, aralkyl (these groups may be substituted); A = CONHSO2, SO2NHCO, NHCONHSO2, SO2NHCONH, OCONHSO2, SO2NHCO2, SO2NHSO2]. The resist shows high sensitivity toward far UV rays, esp. ArF excimer laser beams and the resist soln. exhibits improved storage stability.

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L6 ANSWER 45 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 43
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ACCESSION NUMBER:

2001:62630 CAPLUS

DOCUMENT NUMBER:

134:123582

TITLE:

SOURCE:

LANGUAGE:

Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S):
PATENT ASSIGNEE(S):

Sato, Kenichiro; Kawabe, Yasumasa Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 44 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001022071 A2 20010126 JP 1999-193602 19990707

IT 307976-27-8P 320779-35-9P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photoresist compn. contg. acid generator, alkali-sol. resin., and solvent)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl
2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 156938-13-5 CMF C10 H14 O4

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$^{\mathrm{CH_2}}_{\parallel}$$
 Me-C-CO<sub>2</sub>H

RN 320779-35-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-[[[(7,7-dimethyl-2-oxobicyclo[2.2.1]hept-1-yl)methyl]amino]sulfonyl]amino]propyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 320779-34-8 CMF C17 H28 N2 O5 S

$$\begin{array}{c|c} & & & & & & \text{O} & & \text{CH}_2 \\ & & & & & & & & \\ \text{CH}_2 - \text{NH} - \text{S} - \text{NH} - \text{(CH}_2)}_3 - \text{O} - \text{C} - \text{C} - \text{Me} \\ & & & & & \\ \text{O} & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ \end{array}$$

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 156938-13-5 CMF C10 H14 O4

GΙ

AB The title compn. contains (a) a compd. generating an acid by actinic ray or radiation irradn., (b) a resin which has .gtoreq.1 repeating unit selected from the following (i), (ii), and (iii) and is cleaved by the action of acid to increase the soly. to alkali, and (c) a mixed solvent contg. (1) propyleneglycol monomethyl ether acetate or propyleneglycol monomethyl ether propionate and (2) .gamma.-butyrolactone, ethylene carbonate, and/or propylene carbonate. (i) a repeating unit having alkali-sol. groups protected with .gtoreq.1 group selected from alicyclic hydrocarbon structure-contg. groups I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II (R11 = Me, Et, Pr, iso-Pr, Bu, iso-Bu, sec-Bu; Z = atoms required to form an alicyclic hydrocarbon group along with the C atom; R12-16 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or either R15 or R16 is alicyclic hydrocarbon; R17-21 = H, C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is alicyclic hydrocarbon and either R19 or R21 is C1-4 straight-chain or branched alkyl or alicyclic hydrocarbon; R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R22-25 is alicyclic hydrocarbon). (ii) a repeating unit CH2CR1(CO2X1Lc)(R1 = H, halo, C1-4 straight- chain or branched alkyl; X1 = divalent linking group; Lc = lactone group). (iii) .gtoreq.1 repeating unit selected from CH2CR1(CO2H), CH2CR1X2OCR30R32CR31R330(CR34R35CR36R370)mR, CH2CR1(Z1R38AR39), and CH2CR1(CO2R40SO2OR41) [R1 = H, halo, C1-4 straight-chain or branched alkyl; R30-37 = H, (substituted) alkyl; R = H, alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); m = 1-10; X2 = single bond,

alkylene, cyclic alkylene, arylene, divalent group which is composed of .gtoreq.1 of ether, thioether, carbonyl, ester, amide, sulfonamide, urethane, and urea groups and is not cleaved by the action of acid; Z1 = single bond, ether, ester, amide, alkylene, divalent group composed of these groups; R38 = single bond, alkylene, arylene, divalent group composed of these groups; R40= alkylene, arylene, divalent group composed of these groups; R39 = alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); R41 = H, alkyl, cyclic alkyl, alkenyl, aryl, aralkyl (these groups may be substituted); A = CONHSO2, SO2NHCO, NHCONHSO2, SO2NHCONH, OCONHSO2, SO2NHCO2, SO2NHSO2]. The resist shows high sensitivity toward far UV rays, esp. ArF excimer laser beams and the resist soln. exhibits improved storage stability.

L6 ANSWER 46 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 44

ACCESSION NUMBER: 2001:62629 CAPLUS

DOCUMENT NUMBER: 134:123581

TITLE: Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S): Sato, Kenichiro; Kawabe, Yasumasa PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 44 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001022070 A2 20010126 JP 1999-193601 19990707

IT 307976-27-8P 320779-35-9P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photoresist compn. contg. acid generator, alkali-sol. resin., and solvent)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

H<sub>2</sub>C O Et || || Me-C-C-O

CM 2

CRN 156938-13-5 CMF C10 H14 O4

$$H_2C$$
  $O$   $Me$   $Me$ 

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-- C-- CO}_2\text{H} \end{array}$$

RN 320779-35-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-[[[(7,7-dimethyl-2-oxobicyclo[2.2.1]hept-1-yl)methyl]amino]sulfonyl]amino]propyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 320779-34-8 CMF C17 H28 N2 O5 S

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 156938-13-5 CMF C10 H14 O4

GI

AB The title compn. contains (a) a compd. generating an acid by actinic ray or radiation irradn., (b) a resin which has .gtoreq.1 repeating unit selected from the following (i), (ii), and (iii) and is cleaved by the action of acid to increase the soly, to alkali, and (c) a mixed solvent contg. heptanone and .gtoreq.1 selected from Et lactate, propyleneglycol monomethylether, and ethoxyethyl propionate. (i) a repeating unit having alkali-sol. groups protected with .gtoreq.1 group selected from alicyclic hydrocarbon structure-contg. groups I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II (R11 = Me, Et, Pr, iso-Pr, Bu, iso-Bu, sec-Bu; Z = atoms required to form an alicyclic hydrocarbon group along with the C atom; R12-16 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or either R15 or R16 is alicyclic hydrocarbon; R17-21 = H, C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is alicyclic hydrocarbon and either R19 or R21 is C1-4 straight-chain or branched alkyl or alicyclic hydrocarbon; R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R22-25 is alicyclic hydrocarbon). (ii) a repeating unit CH2CR1(CO2X1Lc)(R1 = H, halo, C1-4 straight- chain or branched alkyl; X1 = divalent linking group; Lc = lactone group). .gtoreq.1 repeating unit selected from CH2CR1(CO2H), CH2CR1X2OCR30R32CR31R330(CR34R35CR36R370)mR, CH2CR1(Z1R38AR39), and CH2CR1(CO2R40SO2OR41) [R1 = H, halo, C1-4 straight-chain or branched alkyl; R30-37 = H, (substituted) alkyl; R = H, alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); m = 1-10; X2 = single bond, alkylene, cyclic alkylene, arylene, divalent group which is composed of .gtoreq.1 of ether, thioether, carbonyl, ester, amide, sulfonamide, urethane, and urea groups and is not cleaved by the action of acid; Z1 = single bond, ether, ester, amide, alkylene, divalent group composed of these groups; R38 = single bond, alkylene, arylene, divalent group composed of these groups; R40= alkylene, arylene, divalent group composed of these groups; R39 = alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); R41 = H, alkyl, cyclic alkyl, alkenyl, aryl, aralkyl (these groups may be substituted); A = CONHSO2, SO2NHCO, NHCONHSO2, SO2NHCONH, OCONHSO2, SO2NHCO2, SO2NHSO2]. The resist shows high resoln. toward far UV rays, esp. ArF excimer laser beams, and improved edge roughness.

L6 ANSWER 47 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 45

ACCESSION NUMBER: 2001:46104 CAPLUS

DOCUMENT NUMBER: 134:123570

TITLE: Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S): Sato, Kenichiro; Kawabe, Yasumasa PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 41 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

LANGUAGE:

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001013686 A2 20010119 JP 1999-186607 19990630

IT 307976-27-8P 320779-35-9P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photoresist compn. contg. acid generator, alkali-sol. resin., and solvent)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 156938-13-5 CMF C10 H14 O4

$$H_2C$$
 O  $Me$   $Me$ 

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$^{
m CH_2}_{||}$$
 Me- C- CO<sub>2</sub>H

RN 320779-35-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-[[[(7,7-dimethyl-2-oxobicyclo[2.2.1]hept-1-yl)methyl]amino]sulfonyl]amino]propyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA

INDEX NAME)

CM 1

CRN 320779-34-8 CMF C17 H28 N2 O5 S

$$\begin{array}{c|c} & O & CH_2 \\ \parallel & \parallel & \parallel \\ CH_2-NH-S-NH-(CH_2)_3-O-C-C-Me \\ \hline O & & Me \\ Me & & Me \end{array}$$

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 156938-13-5 CMF C10 H14 O4

GI

AB The title compn. contains (a) a compd. generating an acid by actinic ray or radiation irradn., (b) a resin which has .gtoreq.1 repeating unit selected from the following (i), (ii), and (iii) and is cleaved by the action of acid to increase the soly. to alkali, and (c) a mixed solvent contg. propyleneglycol monomethylether acetate or propionate and .gtoreq.1 selected from Et lactate, propyleneglycol monomethylether, and ethoxyethyl

.gtoreq.1 group selected from alicyclic hydrocarbon structure-contg. groups I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II (R11 = Me, Et, Pr, iso-Pr, Bu, iso-Bu, sec-Bu; Z = atoms required to form an alicyclic hydrocarbon group along with the C atom; R12-16 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or either R15 or R16 is alicyclic hydrocarbon; R17-21 = H, C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is alicyclic hydrocarbon and either R19 or R21 is C1-4 straight-chain or branched alkyl or alicyclic hydrocarbon; R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R22-25 is alicyclic hydrocarbon). (ii) a repeating unit CH2CR1(CO2X1Lc)(R1 = H, halo, C1-4 straight- chain or branched alkyl; X1 = divalent linking group; Lc = lactone group). (iii) .gtoreq.1 repeating unit selected from CH2CR1(CO2H), CH2CR1X2OCR30R32CR31R33O(CR34R35CR36R37O) mR, CH2CR1(Z1R38AR39), and CH2CR1(CO2R40SO2OR41) [R1 = H, halo, C1-4 straight-chain or branched alkyl; R30-37 = H, (substituted) alkyl; R = H, alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); m = 1-10; X2 = single bond, alkylene, cyclic alkylene, arylene, divalent group which is composed of .gtoreq.1 of ether, thioether, carbonyl, ester, amide, sulfonamide, urethane, and urea groups and is not cleaved by the action of acid; Z1 = single bond, ether, ester, amide, alkylene, divalent group composed of these groups; R38 = single bond, alkylene, arylene, divalent group composed of these groups; R40= alkylene, arylene, divalent group composed of these groups; R39 = alkyl, cyclic alkyl, aryl, aralkyl (these groups may be substituted); R41 = H, alkyl, cyclic alkyl, alkenyl, aryl, aralkyl (these groups may be substituted); A = CONHSO2, SO2NHCO, NHCONHSO2, SO2NHCONH, OCONHSO2, SO2NHCO2, SO2NHSO2]. The resist shows high sensitivity toward far UV rays, esp. ArF excimer laser beams and the resist soln. exhibits improved storage stability.

propionate. (i) a repeating unit having alkali-sol. groups protected with

L6 ANSWER 48 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 46

ACCESSION NUMBER: 2001:780439 CAPLUS

DOCUMENT NUMBER: 135:304286

TITLE: polymers of ester compounds for resist compositions

and patterning

INVENTOR(S): Hasegawa, Koji; Nishi, Tsunehiro; Kinsho, Takeshi;

Watanabe, Takeru; Nakashima, Mutsuo; Tachibana,

Seiichiro; Hatakeyama, Jun

PATENT ASSIGNEE(S): Shin-Etsu Chemical Co., Ltd., Japan

SOURCE: Eur. Pat. Appl., 38 pp.

CODEN: EPXXDW

DOCUMENT TYPE: Patent LANGUAGE: English

FAMILY ACC. NUM. COUNT: 2

PATENT INFORMATION:

PATE	ENT NO.	KIND DAT	E	APPLICATION NO	D. DATE		
EP 1	L148044	A1 200	11024	EP 2001-303574	20010419		
	•	•		B, GR, IT, LI,	LU, NL, SE, MC, PT,		
	IE, SI,	LT, LV, FI	, RO				
JP 2	2002003537	A2 200	20109	JP 2001-115209	9 20010413		
JP 2	2002030114	A2 200	20131	JP 2001-115142	2 20010413		
US 2	2001044071	A1 200	11122	US 2001-837378	3 20010419		
US 2	2002004178	A1 200	20110	US 2001-837219	9 20010419		
PRIORITY	APPLN. INFO	.:	JE	2000-119410	A 20000420		
OTHER SOURCE(S): MARPAT 135:304286							
IT 366809-11-2P							
RL: IMF (Industrial manufacture); TEM (Technical or engineered material							

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(polymers of ester compds. for photoresist and patterning)

RN 366809-11-2 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, tetrahydro-2-oxo-3-furanyl

ester, polymer with 2,5-furandione and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 264193-09-1 CMF C12 H14 O4

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 108-31-6 CMF C4 H2 O3

GI

AB An ester compd. of the following formula (I) is provided wherein R1 is H, Me or CH2CO2R3, R3 is H, Me or CO2R3, R3 is C1-C15 alkyl, Z is a divalent C2-C20 hydrocarbon group which forms a single ring or bridged ring with

the carbon atom and which may contain a hetero atom, m is 0 or 1, n is 0, 1, 2 or 3, and 2m+n=2 or 3. Thus,1-cyclohexylcyclopentyl acrylate 66.6, 2-oxooxolan-3-yl 2-norbornene-5-carboxylate 77.7 and maleic anhydride 34.3 g were polymd. to give a polymer at yield 45.3% as photoresist, showing resoln. 0.16 nm.

REFERENCE COUNT: 3 THERE ARE 3 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 49 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 47

ACCESSION NUMBER: 2001:747251 CAPLUS

DOCUMENT NUMBER: 135:296190

TITLE: Chemically amplified positive resist composition

INVENTOR(S): Uetani, Yasunori; Yamada, Airi; Miya, Yoshiko; Takata,

Yoshiyuki

PATENT ASSIGNEE(S): Sumitomo Chemical Company, Limited, Japan

SOURCE: Eur. Pat. Appl., 18 pp.

CODEN: EPXXDW

DOCUMENT TYPE: Patent LANGUAGE: English

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO. DATE	
EP 1143299	A1	20011010	EP 2001-107747 20010402	
R: AT, BE,	CH, DE	, DK, ES,	FR, GB, GR, IT, LI, LU, NL, SE, M	MC, PT,
IE, SI,	LT, LV	, FI, RO		
CN 1316675	Α	20011010	CN 2001-110230 20010402	
US 2001044070	<b>A1</b>	20011122	US 2001-824227 20010403	
PRIORITY APPLN. INFO	.:		JP 2000-101868 A 20000404	
			JP 2000-133328 A 20000502	
			JP 2000-209505 A 20000711	

## IT 364736-27-6P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (chem. amplified pos. resist compn. contg.)

RN 364736-27-6 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b] furan-6-yl 2-methyl-2-propenoate, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 254900-07-7 CMF C12 H14 O4

CM 2

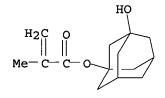
CRN 209982-56-9 CMF C16 H24 O2

CM 3

CRN 195000-66-9 CMF C8 H10 O4

CM 4

CRN 115372-36-6 CMF C14 H20 O3



GI

## \* STRUCTURE DIAGRAM TOO LARGE FOR DISPLAY - AVAILABLE VIA OFFLINE PRINT \*

AB A chem. amplification type pos. resist compn. comprises an acid generating agent and a resin having polymeric units (A), (B) and (C). The polymeric unit (A) is an alicyclic lactone selected from polymeric units I and II (R1,2 = H, Me; and n = 1-3). The polymeric unit (B) is selected 3-hydroxy-1-adamantyl (meth)acrylate represented by III, IV (R3 = H, methyl; R4 = H, hydroxyl; R5,6 = H, C1-3 alkyl or hydroxyalkyl, etc.) and a unit derived from unsatd. dicarboxylic acid anhydride selected from maleic anhydride and itaconic anhydride and a polymeric unit of (.alpha.).beta.-(meth)acryloyloxy-.gamma. -butyrolactone represented by V (R7 = H, Me). The polymeric unit (C) is the one which becomes alkali-sol. by cleavage of a part of groups by the action of an acid. The pos. resist compn. of this invention is excellent in balance of properties such as resoln., profile, sensitivity, dry etching resistance, adhesion, and the like.

2

REFERENCE COUNT:

THERE ARE 2 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

1.6 ANSWER 50 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 48

ACCESSION NUMBER: 2001:631979 CAPLUS

DOCUMENT NUMBER: 135:187722

Photoresist compositions comprising novel copolymers TITLE: INVENTOR(S):

Barclay, George G.; Caporale, Stefan J.; Yueh, Wang;

Mao, Zhibiao; Mattia, Joseph PATENT ASSIGNEE(S): Shipley Company L.L.C., USA

SOURCE: Eur. Pat. Appl., 21 pp.

CODEN: EPXXDW

DOCUMENT TYPE: Patent English LANGUAGE:

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ----------A2 20010829 EP 2001-301613 20010222

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2001296663 A2 20011026 JP 2001-50681 20010226 PRIORITY APPLN. INFO.: US 2000-185345P P 20000226 US 2000-567814 A 20000509

IT 355395-09-4P

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photoresist compn. contg. photoacid labile acrylate and cyclic olefin)

RN355395-09-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, .alpha.cyclopentylbicyclo[2.2.1]hept-2-ene-2-methanol and 2,5-furandione (9CI) (CA INDEX NAME)

CM 1

CRN 355395-08-3 CMF C13 H20 O

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 498-66-8



CM

CRN 108-31-6 CMF C4 H2 O3

AB The present invention includes polymers and photoresist compns. that comprise the polymers as a resin binder component. Photoresists of the invention include chem .- amplified pos. - acting resists that can be effectively imaged at short wavelengths such as sub-200 nm, particularly 193 nm. Polymers of the invention suitably contain (1) photoacid labile groups that preferably contain an alicyclic moiety; (2) a polymd. electron-deficient monomer; and (3) a polymd. cyclic olefin moiety. Particularly preferred polymers of the invention are tetrapolymers or pentapolymers, preferably with differing polymd. norbornene units.

ANSWER 51 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 49

ACCESSION NUMBER:

PATENT ASSIGNEE(S):

2001:581558 CAPLUS

DOCUMENT NUMBER:

135:160152

TITLE:

Chemically amplified positive resist composition

INVENTOR(S):

Nakanishi, Junji; Takata, Yoshiyuki Sumitomo Chemical Co., Ltd., Japan

SOURCE:

Eur. Pat. Appl., 11 pp.

CODEN: EPXXDW

DOCUMENT TYPE:

Patent

LANGUAGE:

English

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

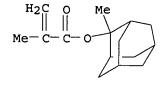
	PATENT NO.	KIND DATE	APPLICATION NO. DATE			
	EP 1122604	A2 20010808	EP 2001-101672 20010129			
	R: AT, BE,	CH, DE, DK, ES,	FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,			
		LT, LV, FI, RO				
	JP 2001215704	A2 20010810	JP 2000-21687 20000131			
	US 2001016298	A1 20010823	US 2001-770212 20010129			
	CN 1312489	A 20010912	CN 2001-102197 20010131			
PRIO	RITY APPLN. INFO	.:	JP 2000-21687 A 20000131			
IT 348631-34-5P, .betaMethacryloyloxygammaButyrolactone-3-						
	Hydroxy-1-adamantyl methacrylate-2-methyl-2-adamantyl methacrylate					
	copolymer					
• •						
	RL: SPN (Synthetic preparation); TEM (Technical or engineered material					
	use); PREP (Preparation); USES (Uses)					
		fied pos. resist				
RN	348631-34-5 CA	PLUS				

2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, CN polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX

NAME)

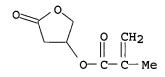
CM 1

CRN 177080-67-0 CMF C15 H22 O2



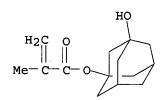
CM 2

CRN 130224-95-2 CMF C8 H10 O4



CM 3

CRN 115372-36-6 CMF C14 H20 O3



AB A chem. amplified pos. resist compn. comprises a resin which, per se, is insol. or slightly sol. in alkali but becomes sol. in alkali due to an action of acid, and has a polymeric unit derived from 3-hydroxy-1-adamantyl(meth)acrylate and a polymeric unit derived from .beta.-(meth)acryloyloxy-.gamma.-butyrolactone wherein the lactone ring may optionally be substituted by alkyl and a photoacid. The chem. amplified pos. resist compn. is capable of giving a resist film excellent in adhesion to a substrate and excellent in various resist performance characteristics such as dry etching resistance, sensitivity and resoln.

L6 ANSWER 52 OF 76 CAPLUS COPYRIGHT 2002 ACS

PLUS COPYRIGHT 2002 ACS DUPLICATE 50 2001:261176 CAPLUS

ACCESSION NUMBER: DOCUMENT NUMBER:

134:287866

TITLE:

Positive-working resist composition

INVENTOR(S):

Sato, Kenichiro; Kodama, Kunihiko; Aoai, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan

SOURCE:

Eur. Pat. Appl., 114 pp.

CODEN: EPXXDW

DOCUMENT TYPE:

Patent English

LANGUAGE:

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

APPLICATION NO. DATE PATENT NO. KIND DATE --------------

A1 20010411 EP 2000-121277 20001006 EP 1091248

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2001109153 JP 1999-285761 A2 20010420 19991006

JP 2001264985 A2 20010928 JP 2000-80519 20000322

PRIORITY APPLN. INFO.: JP 1999-285761 A 19991006 JP 2000-80519 A 20000322

307976-27-8P 332877-30-2P IT

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(acid-decomposable resin in pos.-working resist compn.)

RN307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-

yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9

CMF C16 H24 O2

CM 2

CRN 156938-13-5 CMF C10 H14 O4

Me

CM 3

CRN 79-41-4 CMF C4 H6 O2

CH<sub>2</sub> Me-C-CO2H

Me- C- C- O

RN 332877-30-2 CAPLUS CN 2-Propenoic acid, 2-methyl-, 2-(2-hydroxyethoxy)ethyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 177080-66-9 CMF C10 H14 O4

CM 3

CRN 2351-43-1 CMF C8 H14 O4

AB The present invention provides a high sensitivity chem. amplified pos.-working resist compn. which eliminates edge roughness on pattern and provides an excellent resist pattern profile. A novel pos.-working resist compn. is provided comprising (A) a resin contg. an alkali-sol. group protected by at least one of moieties contg. alicyclic hydrocarbon group and having a monomer component content of 5% or less of the total pattern area as detd. by gel permeation chromatog. (GPC), which increases in its soln. velocity with respect to an alk. developer by the action of an acid and (B) a compd. which is capable of generating an acid by irradn. with an active ray or radiation.

REFERENCE COUNT:

THERE ARE 9 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

DUPLICATE 51

L6 ANSWER 53 OF 76 CAPLUS COPYRIGHT 2002 ACS

2001:208019 CAPLUS

ACCESSION NUMBER: DOCUMENT NUMBER:

134:245232

TITLE:

Radiation-sensitive resin composition as

chemically-amplified photoresist with superior dry

A 19991116

etching resistance and resolution for deep UV

lithography

INVENTOR(S):

Douki, Katsuji; Murata, Kiyoshi; Ishii, Hiroyuki;

Kajita, Toru; Shimokawa, Tsutomu

PATENT ASSIGNEE(S):

SOURCE:

JSR Corporation, Japan Eur. Pat. Appl., 52 pp.

CODEN: EPXXDW

DOCUMENT TYPE:

Patent

LANGUAGE:

English

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE \_\_\_\_\_ ---------

20010321 A1 EP 2000-120000 20000914

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2001109157 JP 1999-291291 19991013 A2 20010420 JP 2001209181 A2 20010803 JP 2000-277966 20000913 PRIORITY APPLN. INFO.: JP 1999-264110 A 19990917

A 19991013 JP 1999-291291 JP 1999-325222

IT 330576-52-8P

> RL: PEP (Physical, engineering or chemical process); PRP (Properties); SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); PROC (Process); USES (Uses)

(copolymer compns. as chem.-amplified photoresist with superior dry etching resistance, sensitivity and resoln. properties for deep UV lithog.)

RN 330576-52-8 CAPLUS

CN 2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2,5-furandione and 1,2,3,4,4a,5,8,8a-octahydro-1,4:5,8-dimethanonaphthalen-2-ol (9CI) (CA INDEX NAME)

CM 1

CRN 249562-06-9 CMF C14 H20 O2

CM 2

CRN 7388-87-6 CMF C12 H16 O

GI

\* STRUCTURE DIAGRAM TOO LARGE FOR DISPLAY - AVAILABLE VIA OFFLINE PRINT \*

AΒ A radiation-sensitive resin compn. comprises (a) a resin contg. an acid-dissociable group which is insol. or scarcely sol. in alkali and becomes alkali sol. when the acid-dissociable group dissocs., comprising the following recurring unit I, recurring unit II, and at least one of the recurring units III and IV (A, B = H, C1-4-alkyl; X, Y = H, monovalent O or N contg. polar group, X joining together with Y may form dicarboxylic anhydride group; n = 0-2; R1 = H, CH3; R2 = CR33; R3 = monovalent alicyclic hydrocarbon group having 4-20 carbon atoms, its deriv., C1-4-alkyl; R4 = divalent hydrocarbon group having alicyclic skeleton contg. 3-15 carbons), (b) a photoacid generator, (c) an acid diffusion controller, and (d) alicyclic additive. The radiation-sensitive resin compn. is suitable for use as a chem.-amplified resist showing sensitivity to active radiation such as deep UV rays represented by a KrF excimer laser or ArF excimer laser, exhibiting superior dry etching resistance without being affected by types of etching gas, having high radiation transmittance, exhibiting excellent basic characteristics as a resist such as sensitivity, resoln., and pattern shape, possessing excellent storage stability as a compn., and exhibiting sufficient adhesion to substrates. REFERENCE COUNT: THERE ARE 5 CITED REFERENCES AVAILABLE FOR THIS

L6 ANSWER 54 OF 76 USPATFULL

ACCESSION NUMBER:

2001:212077 USPATFULL

TITLE:

Novel ester compounds, polymers, resist compositions

RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

and patterning process

INVENTOR(S):

Hasegawa, Koji, Niigata-ken, Japan Nishi, Tsunehiro, Niigata-ken, Japan Kinsho, Takeshi, Niigata-ken, Japan Watanabe, Takeru, Niigata-ken, Japan Nakashima, Mutsuo, Niigata-ken, Japan Tachibana, Seiichiro, Niigata-ken, Japan Hatakeyama, Jun, Niigata-ken, Japan

PATENT ASSIGNEE(S):

Shin-Etsu Chemical Co., Ltd, Tokyo, Japan (non-U.S.

corporation)

PATENT INFORMATION: APPLICATION INFO.:

NUMBER DATE

PRIORITY INFORMATION:

JP 2000-119410 20000420

DOCUMENT TYPE:

Utility

FILE SEGMENT:

APPLICATION

LEGAL REPRESENTATIVE:

MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: 6
EXEMPLARY CLAIM: 1
LINE COUNT: 1476

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 366809-11-2P

(polymers of ester compds. for photoresist and patterning)

RN 366809-11-2 USPATFULL

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, tetrahydro-2-oxo-3-furanyl ester, polymer with 2,5-furandione and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

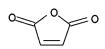
CRN 264193-09-1 CMF C12 H14 O4

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 108-31-6 CMF C4 H2 O3



AB An ester compound of the following formula (1) is provided. ##STR1##

R.sup.1 is H, methyl or CH.sub.2CO.sub.2R.sup.3, R.sup.2 is H, methyl or CO.sub.2R.sup.3, R.sup.3 is C.sub.1-C.sub.15 alkyl, Z is a divalent C.sub.2-C.sub.20 hydrocarbon group which forms a single ring or bridged ring with the carbon atom and which may contain a hetero atom, m is 0 or 1, n is 0, 1, 2 or 3, and 2m+n=2 or 3. A resist composition comprising as the base resin a polymer resulting from the ester compound is sensitive to high-energy radiation, has excellent sensitivity and resolution, and is suited for micropatterning using electron beams or deep-UV.

## CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 55 OF 76 USPATFULL

ACCESSION NUMBER: 2001:212076 USPATFULL

TITLE: Chemically amplified positive resist composition

INVENTOR(S):

Uetani, Yasunori, Osaka, Japan
Yamada, Airi, Osaka, Japan
Miya, Yoshiko, Muko-shi, Japan

Miya, Yoshiko, Muko-shi, Japan Takata, Yoshiyuki, Osaka, Japan

NUMBER DATE

PRIORITY INFORMATION: JP 2000-101868 20000404

JP 2000-133328 20000502 JP 2000-209505 20000711

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: 5
EXEMPLARY CLAIM: 1
LINE COUNT: 894

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 364736-27-6P, 2-Ethyl-2-adamantyl methacrylate-3-hydroxy-1-

adamantyl methacrylate-5-methacryloyloxy-2,6-norbornanecarbolactone-

.alpha.-methacryloyloxy-.gamma.-butyrolactone copolymer

(chem. amplified pos. resist compn. contg.)

RN 364736-27-6 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b] furan-6-yl

2-methyl-2-propenoate, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl

2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 254900-07-7 CMF C12 H14 O4

CM 2

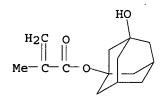
CRN 209982-56-9 CMF C16 H24 O2

CM 3

CRN 195000-66-9 CMF C8 H10 O4

CM 4

CRN 115372-36-6 CMF C14 H20 O3



AB A chemical amplification type positive resist composition excellent in balance of properties such as resolution, profile, sensitivity, dry etching resistance, adhesion and the like which comprises a resin which has the following polymeric units (A), (B) and (C); and an acid generating agent.

- (A): At least one polymeric unit of an alicyclic lactcone selected from
  polymeric units represented by the following formulae (Ia) and (Ib):
  ##STR1##
- (B): At least one polymeric unit selected from a polymeric unit of 3-hydroxy-1-adamantyl (meth)acrylate represented by the following formula (II), a polymeric unit of a combination of a unit represented by the following formula (III) and a unit derived from unsaturated dicarboxylic acid anhydride selected from maleic anhydride and itaconic anhydride and a polymeric unit of (.alpha.).beta.-(meth)acryloyloxy-.gamma.-butyrolactone represented by the following formula (IV): ##STR2##
- (C) A polymeric unit which becomes alkali-soluble by cleavage of a part of groups by the action of an acid.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 56 OF 76 USPATFULL ACCESSION NUMBER: 2001:139256 USPATFULL

TITLE

Chemically amplified positive resist composition

INVENTOR(S):

Nakanishi, Junji, Kyoto-shi, Japan Takata, Yoshiyuki, Osaka, Japan

NUMBER KIND DATE -----

PATENT INFORMATION:

US 2001016298 A1 20010823 US 2001-770212 A1 20010129

APPLICATION INFO.:

20010129 (9)

NUMBER DATE

PRIORITY INFORMATION:

JP 2000-21687

20000131

DOCUMENT TYPE:

Utility

FILE SEGMENT:

APPLICATION

LEGAL REPRESENTATIVE:

BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

-----

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

LINE COUNT:

591

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 348631-34-5P, .beta.-Methacryloyloxy-.gamma.-Butyrolactone-3-

Hydroxy-1-adamantyl methacrylate-2-methyl-2-adamantyl methacrylate

copolymer

(Chem. amplified pos. resist compn.)

RN 348631-34-5 USPATFULL

2-Propenoic acid, 2-methyl-, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl ester, CNpolymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-5-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX

NAME)

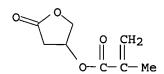
CM· 1

CRN 177080-67-0

CMF C15 H22 O2

CM 2

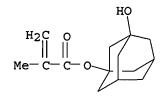
CRN 130224-95-2 CMF C8 H10 O4



CM 3

CRN 115372-36-6

CMF C14 H20 O3



AB A chemically amplified positive resist composition capable of giving a resist film excellent in adhesion to a substrate;

excellent in various resist performance characteristics such as dry etching resistance, sensitivity and resolution; and comprising

a resin (X) which

per se, is insoluble or slightly soluble in alkali but becomes soluble in alkali due to an action of acid,

and has a polymeric unit (a) derived from 3-hydroxy-1-adamantyl(meth)acrylate and a polymeric unit (b) derived from .beta.-(meth)acryloyloxy-.gamma.-butyrolactone wherein the lactone ring may optionally be substituted by alkyl; and an acid generating agent (Y).

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 57 OF 76 USPATFULL

INVENTOR(S):

ACCESSION NUMBER: 2001:91491 USPATFULL

TITLE: Chemically amplified resist compositions and process

for the formation of resist patterns
Takechi, Satoshi, Kawasaki-shi, Japan
Kotachi, Akiko, Kawasaki-shi, Japan
Nozaki, Koji, Kawasaki-shi, Japan

Yano, Ei, Kawasaki-shi, Japan

Watanabe, Keiji, Kawasaki-shi, Japan Namiki, Takahisa, Kawasaki-shi, Japan Igarashi, Miwa, Kawasaki-shi, Japan Makino, Yoko, Kawasaki-shi, Japan Takahashi, Makoto, Kawasaki-shi, Japan

PATENT ASSIGNEE(S): FUJITSU LIMITED, Kawasaki, Japan (non-U.S. corporation)

RELATED APPLN. INFO.: Division of Ser. No. US 1997-969368, filed on 28 Nov

1997, GRANTED, Pat. No. US 6200725 Continuation-in-part

of Ser. No. US 1996-673739, filed on 27 Jun 1996,

GRANTED, Pat. No. US 6013416

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: ARMSTRONG, WESTERMAN, HATTORI, , MCLELAND & NAUGHTON,

LLP, 1725 K STREET, NW, SUITE 1000, WASHINGTON, DC,

20006

NUMBER OF CLAIMS:

EXEMPLARY CLAIM:

11 1

2 Drawing Page(s) NUMBER OF DRAWINGS: 4388

LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 186585-94-4P 186586-03-8P

(chem. amplification resist compn.)

RN186585-94-4 USPATFULL

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, CN polymer with 3-ethenyldihydro-2,5-furandione (9CI) (CA INDEX NAME)

CM1

CRN 177080-67-0

CMF C15 H22 O2

CM

CRN 39739-64-5 CMF C6 H6 O3

$$0$$
  $0$   $0$   $CH = CH2$ 

186586-03-8 USPATFULL RN

CN2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-propenal (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0

CMF C15 H22 O2

CM 2

CRN 107-02-8

CMF C3 H4 O

## $H_2C = CH - CH = O$

Alkali-developable, chemically amplified resist composition which AB comprises an alkali-insoluble compound having a structural unit containing a protected alkali-soluble group in which unit a protective moiety of said protected alkali-soluble group contains an alicyclic hydrocarbon group having bonded to a carbon atom thereof a --CH.sub.2--R.sub.1' group wherein R.sub.1' is methyl, ethyl, propyl or isopropyl, and said alkali-soluble group is cleaved upon action of an acid generated from a photoacid generator used in combination with said compound, thereby releasing said protective moiety from the alkali-soluble group and converting said compound to an alkali-soluble one, and a photoacid generator capable of being decomposed upon exposure to a patterning radiation to thereby produce an acid capable of causing cleavage of said protective moiety. The resist composition can exhibit a high sensitivity (not more than 5 mJ/cm.sup.2) and therefore is particularly suitable for ArF lithography and also can exhibit stable patterning properties.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

ANSWER 58 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 52

ACCESSION NUMBER: 2001:803939 CAPLUS

DOCUMENT NUMBER: 136:93382

TITLE: Effect of end group structures of methacrylate

polymers on ArF photoresist performances

AUTHOR (S): Momose, Hikaru; Wakabayashi, Shigeo; Fujiwara,

Tadayuki; Ichimura, Kiyoshi; Nakauchi, Jun

CORPORATE SOURCE: Corporate Research Laboratories, Mitsubishi Rayon Co.,

Ltd., Otake, Hiroshima, 739-0693, Japan

Proceedings of SPIE-The International Society for SOURCE:

Optical Engineering (2001), 4345 (Pt. 2, Advances in Resist Technology and Processing XVIII), 695-702

CODEN: PSISDG; ISSN: 0277-786X

SPIE-The International Society for Optical Engineering PUBLISHER:

DOCUMENT TYPE: Journal LANGUAGE: English

IT 386705-43-7

RL: CAT (Catalyst use); USES (Uses)

(photoresist; relationship between sensitivity of ArF photoresist and end-group of hydroxybutyrolactone methacrylate and methyladamantyl

methacrylate copolymer)

386705-43-7 CAPLUS RN

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, CN telomer with cyclohexanethiol and tetrahydro-5-oxo-3-furanyl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 1569-69-3 CMF C6 H12 S

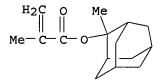
CRN 195000-69-2

CMF (C15 H22 O2 . C8 H10 O4)x

PMS CCI

> CM 3

CRN 177080-67-0 CMF C15 H22 O2



CM

CRN 130224-95-2 CMF C8 H10 O4

AB The relation between the sensitivity of ArF photoresist and the end group structures of copolymers consisting of .beta.-hydroxy-.gamma. -butyrolactone methacrylate (HGBMA) and 2-methyl-2-adamantyl methacrylate (MadMA) was studied. The sensitivity is strongly dependent on the kind and amt. of end groups. The copolymer with relatively nonpolar end group structure has higher sensitivity than that with polar end group structure, and the sensitivity of copolymer with end groups of methylisobutyrate and 1-octhylthio moieties showed .apprx.3 times higher than that of copolymer with end groups of isobutyronitrile and 2-hydroxyethylthio moieties. The difference of sensitivity among these copolymers was discussed from the view point of the change of development rate attributed to the amt. of carboxylic acid groups formed in the resist film by exposure of 193nm light.

REFERENCE COUNT:

THERE ARE 7 CITED REFERENCES AVAILABLE FOR THIS RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L6 ANSWER 59 OF 76 CAPLUS COPYRIGHT 2002 ACS

7

DUPLICATE 53

ACCESSION NUMBER:

2000:877012 CAPLUS

DOCUMENT NUMBER:

134:63889

TITLE: INVENTOR(S):

SOURCE:

Far-UV positive-working photoresist composition Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 45 pp.

CODEN: JKXXAF

-----

DOCUMENT TYPE:

Patent Japanese

LANGUAGE:

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. ----

KIND DATE

APPLICATION NO. DATE

JP 2000347409

A2 20001215

JP 1999-158695 19990604

IT 312620-58-9P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(far-UV pos.-working photoresist compn. from)

RN 312620-58-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 195000-66-9 CMF C8 H10 O4

CM 3

CRN 115372-36-6 CMF C14 H20 O3

CM 4

CRN 79-41-4 CMF C4 H6 O2

$$^{\rm CH_2}_{||}_{\rm Me^-\,C^-\,CO_2H}$$

GI

\* STRUCTURE DIAGRAM TOO LARGE FOR DISPLAY - AVAILABLE VIA OFFLINE PRINT \*

AB The far-UV pos.-working photoresist compn. comprises a photoacid represented by I or II (R1-5 = H, alkyl, etc.; p, q, n1 = 1-5; m, n = 0-5; X = counter ion) and a resin which has repeating unit of III (Rb1-b4 = substituent) and increases its soly. in an alk. developer upon reaction with an acid. This photoresist compn. was particularly suited for .ltoreq.220.nu.m exposure.

L6 ANSWER 60 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 54

ACCESSION NUMBER: 2000:877011 CAPLUS

DOCUMENT NUMBER: 134:63888

TITLE: Positive-working chemical amplification photoresist

composition for far-ultraviolet ray exposure

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan

SOURCE: Jpn. Kokai Tokkyo Koho, 52 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent

LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000347408 A2 20001215 JP 1999-158693 19990604

IT 312620-58-9P

RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

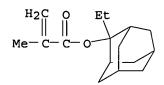
(pos.-working chem. amplification photoresist compn. for far-UV ray exposure)

RN 312620-58-9 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2



CRN 195000-66-9 CMF C8 H10 O4

CM 3

CRN 115372-36-6 CMF C14 H20 O3

CM 4

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-- C-- CO}_2\text{H} \end{array}$$

GI

$$\begin{array}{c|c}
R^1 \\
-CH_2 - C - \\
CO \\
0 \\
R^2 \\
R^3 \qquad I
\end{array}$$

AB A pos.-working photoresist contg. (A) a compd. generating an acid upon irradn. with active ray or radioactive ray, (B) a resin having a repeating unit (I; R1 = H, halo, C1-4 linear or branched alkyl; R2 - R4 = H or OH, provided that at least one of R2 - R4 is OH) and decompg. upon reaction with an acid to increase the soly. in an alkali developer, and (C) a compd. generating sulfonic acid is described. This photoresist decreases

the development of defects or the formation of scums when using an exposure source of 150 nm wavelength, in particular .ltoreq.220 nm, and improves microlithog. (photolithog.) process of LSI and microchips using far-UV ray such as excimer laser beam.

ANSWER 61 OF 76 CAPLUS COPYRIGHT 2002 ACS L6 DUPLICATE 55

ACCESSION NUMBER: 2000:863757 CAPLUS

DOCUMENT NUMBER: 134:49200

TITLE: Far-UV positive-working photoresist composition

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 38 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE ----JP 2000338674 A2 20001208 JP 1999-146775 19990526

IT 312620-58-9P

> RL: POF (Polymer in formulation); SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (far-UV pos.-working photoresist compn. from)

312620-58-9 CAPLUS RN

2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-CN yl 2-methyl-2-propenoate, 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 195000-66-9 CMF C8 H10 O4

CM 3

CRN 115372-36-6 CMF C14 H20 O3

CM 4

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me--C--CO}_2 \text{H} \end{array}$$

GI

The title photoresist compn. comprises a photoacid and a resin which, increasing alk. soly. upon the reaction with an acid, contains a repating unit having .gtoreq.1 protective group selected from I, CR12R13R14, -CHR16(OR15), CR19R21R17C=CR18R20, -R22R25CCHR23C(:O)R24, and II (R11 = Me, Et, etc.; R12-16 = C1-4 alkyl, aliph.; R15,16 = aliph.; R17-21 = H, C1-4 alkyl, aliph.; R22-25 = C1-4 alkyl, aliph.) and III (R1 = H, halo, C1-4 alkyl; R2-4 = H, OH).

L6 ANSWER 62 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 56

ACCESSION NUMBER: 2000:823000 CAPLUS

DOCUMENT NUMBER: 133:367848

TITLE: Positive-working resist composition

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 32 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

11-24-00

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000321771 A2 20001124 JP 1999-127296 19990507

IT 307976-27-8P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos. photoresist compn. contg. acrylic polymer and acid generator)

RN 307976-27-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4,4-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 156938-13-5 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ H_2C & O & & & \\ \parallel & \parallel & & \\ Me-C-C-O & Me & & \end{array}$$

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-C-CO}_2 \text{H} \end{array}$$

GΙ

$$\begin{array}{c|c}
R^1 \\
+ CH_2 - C - + \\
\hline
COO \\
R^4 \\
\hline
R^3 \\
\hline
O \\
II
\end{array}$$

AΒ The title resist compn. contains (a) a resin which has repeating units I, II, and .gtoreq.1 selected from CH2CR1(CO2H), CH2CR1 [XOCR5R7CR6R80 (CR9R10CR11R120) mR], CH2CR1 (ZR13AR14), and CH2CR1(CO2R15SO2OR16) [R1 = H, Me; R2 = C1-4 alkyl; R3, R4 = H, C1-4 alkyl; R5-12 = H, (substituted) alkyl;  $\dot{R}$  = H, (substituted) alkyl, (substituted) cycloalkyl, (substituted) aryl, (substituted) aralkyl; m = 1-10; X = single bond, (substituted) alkylene, (substituted) cycloalkylene, (substituted) arylene, divalent group which is composed of .gtoreq.1 group selected from ether, thioether, carbonyl, ester, amide, sulfonamide, urethane, and urea groups and is not decompd. by the action of acid; Z = single bond, ether, ester, amide, alkylene, divalent group composed of these groups; R13 = single bond, alkylene, arylene, divalent group composed of these groups; R14 = (substituted) alkyl, (substituted) cycloalkyl, (substituted) aryl, (substituted) aralkyl; R15 = alkylene, arylene, divalent group composed of these groups; R16 = H, (substituted) alkyl, (substituted) cycloalkyl, (substituted) alkenyl, (substituted) aryl, (substituted) aralkyl; A = CONHSO2, SO2NHCO, NHCONHSO2, SO2NHCONH, OCONHSO2, SO2NHCO2, SO2NHSO2] and of which the dissoln. rate to alk. developing solns. is increased by the action of acid and (b) a compd. that generates an acid by irradn. with actinic ray or radiation. The compn. shows improved applicability to micro-photo-fabrication using far UV rays, esp. ArF excimer laser beams and developability and provides resist patterns with good profile and high resoln. contact holes.

L6 ANSWER 63 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 57

ACCESSION NUMBER: 2000:768008 CAPLUS

DOCUMENT NUMBER: 133:342484

TITLE: Positive-working resist composition

INVENTOR(S): Sato, Kenichiro, Kodama, Kunihiko, Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 38 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000305271 A2 20001102 JP 1999-114082 19990421

IT 304441-26-7

RL: TEM (Technical or engineered material use); USES (Uses) (pos.-working resist compn.)

RN 304441-26-7 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 1,1-dimethyl-2-oxo-2-[(tetrahydro-2-oxo-3furanyl)oxy]ethyl ester, polymer with 2-ethyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and 2-(2-methoxyethoxy)ethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 288303-54-8 CMF C12 H16 O6

CM 2

CRN 209982-56-9 CMF C16 H24 O2

CM 3

CRN 45103-58-0 CMF C9 H16 O4

AB The pos.-working resist compn. used for ultramicrolithog. comprises a photoacid and a resin which increases the soly. rate in an alk. developer upon contacting an acid and has a group OCR1R3CR2R40[CR5R6CR7R80]mR (R1-8 = H, alkyl; R = H,m alkyl, cyclic alkyl, aryl, aralkyl; and m = 1-10) bonded to the polymer backbone chain directly or indirectly via an acid-stable bonding group.

ANSWER 64 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 58 2000:624801 CAPLUS

ACCESSION NUMBER:

133:215460

DOCUMENT NUMBER: TITLE:

Positive-working far UV-sensitive resist composition Kodama, Kunihiko; Sato, Kenichiro; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 36 pp.

INVENTOR(S): SOURCE:

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000241977 A2 20000908 JP 1999-44978 19990223

IT 290304-49-3P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(resin in pos.-working far UV sensitive resist compn.)

RN 290304-49-3 CAPLUS

CN Tricyclo[3.3.1.13,7]decane-2-acetic acid, 2-[(2-methyl-1-oxo-2-propenyl)oxy]-, 1,1-dimethylethyl ester, polymer with tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 290304-38-0 CMF C20 H30 O4

CM 2

CRN 177080-66-9 CMF C10 H14 O4

$$\begin{array}{c|c} H_2C & \text{Me} \\ & \\ Me-C-C-O \\ & \\ O \end{array}$$

The pos.-working far UV-sensitive resist compn. has a photoacid generator and a resin, which has -O-C(R')(R'')(X-COR) (R', R'' = alkyl, cyclic hydrocarbon; X = single bond, divalent connecting group; R = alkoxy, amide, amino, etc.) group in the side chain, increasing the soly. towards an alkali developer upon reacting with an acid. The compn. having the resin is suitable for exposure with .ltoreq.250 nm far UV light.

L6 ANSWER 65 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 59

ACCESSION NUMBER: 2000:563063 CAPLUS

DOCUMENT NUMBER: 133:185531

TITLE: Positive-working photoresist composition for far UV

exposure

INVENTOR(S): Sato, Kenichiro; Ohashi, Hidekazu; Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 31 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

1

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

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-----JP 2000227659

---- **----**A2 20000815

JP 1999-30209

19990208

IT 288303-50-4P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material

use); PREP (Preparation); USES (Uses)

(photoresist compn. contg. photoacid generator, alkali-sol. resin, and sulfonic acid generator)

RN288303-50-4 CAPLUS

2-Propenoic acid, 2-methyl-, polymer with 2-methyltricyclo[3.3.1.13,7]dec-CN

2-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-2H-pyran-4-yl

2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 288303-49-1 CMF C9 H12 O4

CM

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-- C-- CO}_2 \text{H} \end{array}$$

$$\begin{array}{c|c}
R^{11} & O & R^{11} \\
C & -C - O - C \\
\end{array}$$

AB The title photoresist compn. contains (a) a compd. which generates an acid by irradn. with activating ray or radiation, (b) a resin which has alkali-sol. groups protected with .gtoreq.1 of alicyclic hydrocarbon-contg. partial structures I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II (R11= Me, Et, Pr, iso-Pr, Bu, iso-Bu, sec-Bu; Z = atoms required to form a alicyclic hydrocarbon along with the C atom; R12-16, R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or R22-25 or either R15 or R16 is alicyclic hydrocarbon; .gtoreq.1 of R22-25 is alicyclic hydrocarbon; R17-21 = H, C1-4 straight-chain or alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is alicyclic hydrocarbon and either R19 or R21 is C1-4 straight-chain or branched alkyl or alicyclic hydrocarbon) and is cleaved by the action of acid to increase the soly. to alkali, and (c) a compd. which is cleaved by the action of acid to generate a sulfonic acid. The compn. shows high sensitivity toward far UV rays of wavelength 170-220 nm and improved developability and provides high resoln. resist patterns with good line width reproducibility.

L6 ANSWER 66 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 60

ACCESSION NUMBER: 2000:357221 CAPLUS

DOCUMENT NUMBER: 133:11016

TITLE: Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 35 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 2

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO. DATE
JP 2000147776	A2	20000526	JP 1998-327054 19981117
US 2002081518	A1	20020627	US 1999-438789 19991112
US 6420082	B1	20020716	
PRIORITY APPLN. INFO.	:		JP 1998-323783 A 19981113
			.TD 1998-327054 A 19981117

## IT 270900-71-5P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(pos. photoresist contg. acid generator and alkali-sol. resin)

RN 270900-71-5 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-[[(methylsulfonyl)amino]sulfonyl]propyl ester, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 270900-52-2 CMF C8 H15 N O6 S2

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 177080-66-9 CMF C10 H14 O4

$$\begin{array}{c|c} H_2C & \text{Me} \\ \parallel & \\ \text{Me}-C-C-O \\ \parallel & \\ O \end{array}$$

GI

$$\begin{array}{c|c}
R^{11} & O & R^{11} \\
C & -C - O - C
\end{array}$$

AB The title photoresist compn. contains (a) a compd. that generates an acid by irradn. with activating ray or radiation and (b) a resin having alkali-sol. groups protected with .gtoreq.1 group selected from I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II [R11 = Me, Et, n- or iso-Pr, n-, iso- or sec-Bu; Z = atoms required to form an alicyclic hydrocarbon group along with the C atom; R12-16, R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or 1 of R15 and R16 is an alicyclic hydrocarbon group, .gtoreq.1 of R22-25 is an alicyclic hydrocarbon group; R17-21 = H, C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is an alicyclic hydrocarbon group, R19 or R21 is a C1-4 straight-chain or branched alkyl or cyclic hydrocarbon group] and groups AXR5 [A is a combination of .gtoreq.1 group selected from single bond, (substituted) alkylene, ether, thioether, carbonyl, and ester; X = NHSO2, SO2NH, SO2NHSO2, NHCONHSO2, CONHSO2, SO2NHCO, SO2NHCONH, OCONHSO2,

SO2NHCO2; R5 = (substituted) alkyl, (substituted) alicyclic hydrocarbon], which is cleaved by the action of acid to increase the soly. to alkali. The compn. shows high sensitivity in the wavelength region of 170-220 nm and provides high resoln. resist patterns with improved dense and coarse dependence.

L6 ANSWER 67 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 61

ACCESSION NUMBER: 2000:357220 CAPLUS

DOCUMENT NUMBER: 133:11015

TITLE: Positive-working photoresist composition for far

ultraviolet ray exposure

INVENTOR(S): Sato, Kenichiro; Kodama, Kunihiko; Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 31 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000147775 A2 20000526 JP 1998-327052 19981117

IT 270251-49-5P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

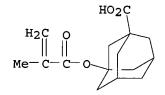
(photoresist compn. contg. photoacid generator and alkali-sol. resin)

RN 270251-49-5 CAPLUS

CN Tricyclo[3.3.1.13,7]decane-1-carboxylic acid, 3-[(2-methyl-1-oxo-2-propenyl)oxy]-, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-4-methyl-2-oxo-2H-pyran-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 212580-10-4 CMF C15 H20 O4



CM 2

CRN 177080-67-0 CMF C15 H22 O2

CRN 177080-66-9 CMF C10 H14 O4

$$\begin{array}{c|c} H_2C & \text{Me} \\ & \\ Me-C-C-O \\ & \\ O \end{array}$$

GI

$$\begin{array}{c|c}
 & O & R^{11} \\
 & C & -C - O - C
\end{array}$$

The title photoresist compn. contains (a) a compd. that generates an acid by irradn. with activating ray or radiation and (b) a resin contg. a repeating unit having alkali-sol. groups protected with .gtoreq.1 group selected from I, CR12R13R14, CH(OR15)R16, CR19R21CR17:CR18R20, CR22R25CHR23COR24, and II [R11 = Me, Et, n- or iso-Pr, n-, iso- or sec-Bu; Z = atoms required to form an alicyclic hydrocarbon group along with the Catom; R12-16, R22-25 = C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R12-14 or 1 of R15 and R16 is an alicyclic hydrocarbon group, .gtoreq.1 of R22-25 is an alicyclic hydrocarbon group; R17-21 = H, C1-4 straight-chain or branched alkyl, alicyclic hydrocarbon, .gtoreq.1 of R17-21 is an alicyclic hydrocarbon group, R19 or R21 is a C1-4 straight-chain or branched alkyl or cyclic hydrocarbon group] and another repeating unit CR1R3CR2R4 [R1-4 = H, halo, C1-4 straight-chain or branched alkyl, .gtoreq.1 of R1-4 is CO2RnARmCO2H; R is a combination of .gtoreq.1 group selected from single bond, (substituted) alkylene, ether, thioether, carbonyl, and ester; A = alicyclic hydrocarbon; m, n = 0 or 1],which is cleaved by the action of acid to increase the soly. to alkali. The compn. shows improved suitability to the std. developing soln. and high sensitivity in the wavelength region of 170-220 nm and provides high resoln. resist patterns with improved dense and coarse dependence.

L6 ANSWER 68 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 62

ACCESSION NUMBER:

2000:267288 CAPLUS

DOCUMENT NUMBER:

132:300949

TITLE:

Photoresist resin composition having acid sensitive

(meth)acrylate polymer

INVENTOR(S):

Nakano, Tatsuya; Mori, Misao

PATENT ASSIGNEE(S):

Daicel Chemical Industries, Ltd., Japan

SOURCE: Jpn. Kokai Tokkyo Koho, 9 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000119588 A2 20000425 JP 1998-293563 19981015

## IT 264616-27-5P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(acid sensitive (meth)acrylate polymer)

RN 264616-27-5 CAPLUS

CN 2-Propenoic acid, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 3,5,5-trimethyl-7-oxo-3-oxepanyl 2-propenoate and 4,6,6-trimethyl-2-oxo-4-oxepanyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN

264616-25-3

CMF C12 H18 O4

$$\begin{array}{c|c}
 & O \\
 & | \\
 & | \\
 & O \\
 & C \\
 & CH_2
\end{array}$$
Me
O
O

CM 2

CRN 264616-24-2 CMF C12 H18 O4

CM 3

CRN 249562-06-9 CMF C14 H20 O2

$$\begin{array}{c|c} & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & & \\ & &$$

AB The photoresist compn. has acid sensitive (meth)acrylate polymer with repeating unit I (R = H, Me; X, Y = single bond, O) and a light-sensitive acid-generating agent. The Photoresist resin compn. with the (meth)acrylate polymer provides the pattern of the improved precision.

L6 ANSWER 69 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 63

ACCESSION NUMBER: 2000:205773 CAPLUS

DOCUMENT NUMBER: 132:229519

TITLE: Method for forming chemically amplified resist pattern

for semiconductor device fabrication

INVENTOR(S):
Sasako, Masaru

PATENT ASSIGNEE(S): Matsushita Electric Industrial Co., Ltd., Japan

SOURCE: Jpn. Kokai Tokkyo Koho, 6 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000089464 A2 20000331 JP 1998-254076 19980908

IT 261631-25-8P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(chem. amplified resist)

RN 261631-25-8 CAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with methyl 2-methyl-2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 80-62-6

CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-C-CO}_2 \text{H} \end{array}$$

AB The method for forming a chem. amplified resist pattern includes steps of: forming a chem. amplified resist film made from an acrylic polymer having an aliph. ring on a substrate; patternwise exposing the resist with vacuum UV or extreme UV light; and developing the resist to form a pattern. The method provides the excellent pattern profile.

L6 ANSWER 70 OF 76 CAPLUS COPYRIGHT 2002 ACS

DUPLICATE 64

ACCESSION NUMBER:

2000:67678 CAPLUS

DOCUMENT NUMBER:

132:130026

TITLE:

Positive-working resist composition suited for use in

deep UV ray exposure

INVENTOR(S):

Aogo, Toshiaki

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Japan Jpn. Kokai Tokkyo Koho, 44 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

SOURCE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2000029219	A2	20000128	JP 1998-197730	19980713

IT 256346-99-3P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(deep UV-sensitive pos. resist compn.)

RN 256346-99-3 CAPLUS

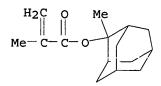
CN Tricyclo[3.3.1.13,7]decane-1-carboxylic acid, 3-[(2-methyl-1-oxo-2-propenyl)oxy]-, 1-ethoxyethyl ester, polymer with 2-methyl-2-propenoic acid and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 216308-47-3 CMF C19 H28 O5

CM 2

CRN 177080-67-0 CMF C15 H22 O2



CM 3

CRN 79-41-4 CMF C4 H6 O2

$$\begin{array}{c} \text{CH}_2 \\ || \\ \text{Me-} \text{C-} \text{CO}_2 \text{H} \end{array}$$

The title resist compn. contains (a) a compd. generating an acid upon activating ray or radiation irradn., (b) a resin having polycyclic alicyclic groups and CO2H groups, (c) a compd. having .gtoreq.2 groups CR1R2C:CR3Z [R1-3 = H, (substituted) alkyl, (substituted) cycloalkyl, 2 of R13 may link each other to form a ring structure comprising 3-8 C atoms and heteroatoms; Z = O, S, SO2, NH], (d) a cyclic aliph. org. carboxylic acid with mol. wt. .ltoreq.1000 and/or a naphthalene ring-contg. org. carboxylic acid, (e) a N-contg. basic compd., and (f) a F-type and/or Si-type surfactant. The compn. shows improved developability and provides a resoln. pattern with high residual film rate and good profile using deep UV rays, esp., ArF excimer lasers.

L6 ANSWER 71 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 65

ACCESSION NUMBER: 2000:67677 CAPLUS

DOCUMENT NUMBER: 132:130025

TITLE: Positive-working resist composition suited for use in

deep ultraviolet ray exposure

INVENTOR(S): Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 44 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000029218 A2 20000128 JP 1998-197729 19980713

IT 256346-99-3P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(deep UV-sensitive pos. resist compn.)

RN 256346-99-3 CAPLUS

CN Tricyclo[3.3.1.13,7]decane-1-carboxylic acid, 3-[(2-methyl-1-oxo-2-propenyl)oxy]-, 1-ethoxyethyl ester, polymer with 2-methyl-2-propenoic acid and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 216308-47-3 CMF C19 H28 O5

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 79-41-4 CMF C4 H6 O2

AB The title resist compn. contains (a) a compd. generating an acid upon activating ray or radiation irradn., (b) a resin having polycyclic alicyclic groups and CO2H groups, (c) a compd. having .gtoreq.2 groups CR1R2C:CR3Z [R1-3 = H, (substituted) alkyl, (substituted) cycloalkyl, 2 of R13 may link each other to form a ring structure comprising 3-8 C atoms and heteroatoms; Z = O, S, SO2, NH], (d) a N-contg. basic compd., and (e) a F-type and/or Si-type surfactant. The compn. shows improved

developability and provides a pattern with high residual film rate and good profile using deep UV rays, esp., ArF excimer lasers.

L6 ANSWER 72 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 66

ACCESSION NUMBER: 2000:67675 CAPLUS

DOCUMENT NUMBER: 132:130024

TITLE: Positive-working resist composition suited for use in

deep ultraviolet ray exposure

INVENTOR(S): Aogo, Toshiaki

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan SOURCE: Jpn. Kokai Tokkyo Koho, 44 pp.

CODEN: JKXXAF

DOCUMENT TYPE: Patent LANGUAGE: Japanese

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2000029216 A2 20000128 JP 1998-194566 19980709

IT 256346-99-3P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(deep UV-sensitive pos. resist compn.)

RN 256346-99-3 CAPLUS

CN Tricyclo[3.3.1.13,7]decane-1-carboxylic acid, 3-[(2-methyl-1-oxo-2-propenyl)oxy]-, 1-ethoxyethyl ester, polymer with 2-methyl-2-propenoic acid and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 216308-47-3 CMF C19 H28 O5

CM 2

CRN 177080-67-0 CMF C15 H22 O2

```
CH<sub>2</sub>
Me-C-CO2H
```

AB The title resist compn. contains (a) a compd. generating an acid upon activating ray or radiation irradn., (b) a resin having polycyclic alicyclic groups and CO2H groups, (c) a compd. having .gtoreq.2 groups CR1R2C:CR3Z [R1-3 = H, (substituted) alkyl, (substituted) cycloalkyl, 2 of R1-3 may link each other to form a ring structure comprising 3-8 C atoms and heteroatoms; Z = O, S, SO2, NH], (d) a compd. having a N-contg. basic group and acidic group in its mol., and (e) a F-type and/or Si-type surfactant. The compn. shows improved developability and provides a resoln. pattern with high residual film rate and good profile using deep UV rays, esp., ArF excimer lasers.

ANSWER 73 OF 76 USPATFULL

ACCESSION NUMBER:

2000:4579 USPATFULL

TITLE:

Chemically amplified resist compositions and process

for the formation of resist patterns

INVENTOR(S):

Nozaki, Koji, Kawasaki, Japan

Yano, Ei, Kawasaki, Japan

Watanabe, Keiji, Kawasaki, Japan Namiki, Takahisa, Kawasaki, Japan Igarashi, Miwa, Kawasaki, Japan Kuramitsu, Yoko, Kawasaki, Japan Takechi, Satoshi, Kawasaki, Japan Kotachi, Akiko, Kawasaki, Japan Takahashi, Makoto, Kawasaki, Japan

PATENT ASSIGNEE(S):

Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation)

	NUMBER	KIND	DATE	
110	6013416		20000111	
	1996-673739		19960627	C

PATENT INFORMATION: APPLICATION INFO.:

US 1996-673739

19960627 (8)

NUMBER DATE -----JP 1995-162287 PRIORITY INFORMATION: 19950628 JP 1995-178717 19950714 JP 1995-312722 19951130 JP 1996-50264 19960307 DOCUMENT TYPE:

FILE SEGMENT:

Utility

Granted

PRIMARY EXAMINER:

Hamilton, Cynthia

LEGAL REPRESENTATIVE:

Armstrong, Westerman Hattori, McLeland & Naughton

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

15

LINE COUNT:

3627

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 186585-94-4P 186586-03-8P

(chem. amplification resist compn.)

ΡN 186585-94-4 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester,

polymer with 3-ethenyldihydro-2,5-furandione (9CI) (CA INDEX NAME)

CM

CRN 177080-67-0

CM 2

CRN 39739-64-5 CMF C6 H6 O3

RN 186586-03-8 USPATFULL

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-propenal (9CI) (CA INDEX NAME)

CM 1

CN

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 107-02-8 CMF C3 H4 O

$$H_2C \longrightarrow CH - CH \longrightarrow O$$

AB Alkali-developable, chemically amplified resist composition which comprises an alkali-insoluble, film-forming compound having a structural unit containing a protected alkali-soluble group in which unit a protective moiety of said protected alkali-soluble group is cleaved upon action of an acid generated from a photoacid generator used in combination with said compound, thereby releasing a protective moiety from the alkali-soluble group and converting said compound to an alkali-soluble one, and a photoacid generator capable of being decomposed upon exposure to a patterning radiation to thereby produce an acid capable of causing cleavage of said protective moiety. The resist composition is particularly suitable for excimer laser lithography using

an alkaline developer, and the formed resist patterns can exhibit a high sensitivity and excellent dry etch resistance without swelling.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L6 ANSWER 74 OF 76 USPATFULL

ACCESSION NUMBER: 1999:128329 USPATFULL

TITLE: Chemically amplified resist compositions and process

for the formation of resist patterns

INVENTOR(S): Nozaki, Koji, Kawasaki, Japan

Yano, Ei, Kawasaki, Japan

Watanabe, Keiji, Kawasaki, Japan Namiki, Takahisa, Kawasaki, Japan Igarashi, Miwa, Kawasaki, Japan Kuramitsu, Yoko, Kawasaki, Japan Takechi, Satoshi, Kawasaki, Japan Kotachi, Akiko, Kawasaki, Japan

Takahashi, Makoto, Kawasaki, Japan

PATENT ASSIGNEE(S): Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation)

NUMBER KIND DATE
-----US 5968713 19991019

PATENT INFORMATION: US 5968713 19991019
APPLICATION INFO.: US 1997-896833 19970718 (8)

RELATED APPLN. INFO.: Division of Ser. No. US 1996-673739, filed on 27 Jun

1996

DOCUMENT TYPE: Utility FILE SEGMENT: Granted

PRIMARY EXAMINER: Hamilton, Cynthia

LEGAL REPRESENTATIVE: Armstrong, Westerman, Hattori, McLeland, and, Naughton

NUMBER OF CLAIMS: 20 EXEMPLARY CLAIM: 1,11 LINE COUNT: 3663

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 186585-94-4P 186586-03-8P

(chem. amplification resist compn.)

RN 186585-94-4 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 3-ethenyldihydro-2,5-furandione (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

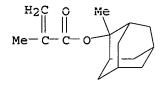
H2C O Me | | | | Me-C-C-O CRN 39739-64-5 CMF C6 H6 O3

186586-03-8 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, CN polymer with 2-propenal (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2



CM 2

CRN 107-02-8 CMF C3 H4 O

H2C== CH- CH== O

AΒ Alkali-developable, chemically amplified resist composition which comprises an alkali-insoluble, film-forming compound having a structural unit containing a protected alkali-soluble group in which unit a protective moiety of said protected alkali-soluble group is cleaved upon action of an acid generated from a photoacid generator used in combination with said compound, thereby releasing a protective moiety from the alkali-soluble group and converting said compound to an alkali-soluble one, and a photoacid generator capable of being decomposed upon exposure to a patterning radiation to thereby produce an acid capable of causing cleavage of said protective moiety. The resist composition is particularly suitable for excimer laser lithography using an alkaline developer, and the formed resist patterns can exhibit a high sensitivity and excellent dry etch resistance without swelling.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

ANSWER 75 OF 76 CAPLUS COPYRIGHT 2002 ACS

**DUPLICATE 67** 

ACCESSION NUMBER:

1997:290215 CAPLUS

DOCUMENT NUMBER:

126:270390

TITLE:

Resist composition containing a base resin with

repeating unit having protected hydroxy groups and the

patterning method

INVENTOR(S):

Kodachi, Akiko

PATENT ASSIGNEE(S):

Fujitsu Ltd, Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 29 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

LANGUAGE:

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE 19970218 JP 1995-202343 19950808 \_\_\_\_\_\_ JP 09050126 A2 IT 188823-68-9P, 3-O-Methacryloyl-1,2:5,6-di-O-isopropylidene-.alpha.-D-glucofuranose-2-methyl-2-adamantyl methacrylate copolymer RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (water-developable resist compn. contg. base polymer having group derived from OH-protected glucofuranose) RN 188823-68-9 CAPLUS CN .alpha.-D-Glucofuranose, 1,2:5,6-bis-O-(1-methylethylidene)-, 2-methyl-2-propenoate, polymer with 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 6613-70-3 CMF C16 H24 O7 CDES 5:A-D-GLUCO

Absolute stereochemistry.

AB The resist compn. contains a base resin and a photoacid generator, and the resin comprises a polymer with a repeating unit having protected OH group(s). The repeating unit having protected OH group(s) may be [CH2CR1[CO2(CH2)nX]] [R1 = H, C1-6 alkyl, halo, haloalkyl; X = group derived from OH-protected glucofuranose, i.e. I,II (R2-5 = C1-6 alkyl, haloalkyl; R6-9 = group capable of being released by acids); n .gtoreq. 1]. The resist compn. is developable with H2O.

L6 ANSWER 76 OF 76 CAPLUS COPYRIGHT 2002 ACS DUPLICATE 68

ACCESSION NUMBER: 1997:134745 CAPLUS

DOCUMENT NUMBER:

126:150516

TITLE:

Chemical amplification resist composition and method

to manufacture resist master using the same

INVENTOR(S):

Nozaki, Koji; Yano, Ei; Watanabe, Keiji; Namiki, Takahisa; Igarashi, Miwa; Kuramitsu, Yoko; Takechi,

Satoshi; Kotachi, Akiko; Takahashi, Makoto

PATENT ASSIGNEE(S):

SOURCE:

Fujitsu Ltd., Japan Ger. Offen., 87 pp.

CODEN: GWXXBX

DOCUMENT TYPE:

Patent German

LANGUAGE:

German

FAMILY ACC. NUM. COUNT: 3

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO. DATE
DE 19626003	A1	19970102	DE 1996-19626003 19960628
DE 19626003	C2	20020214	
JP 09090637	A2	19970404	JP 1995-312722 19951130
JP 3297272	B2	20020702	
JP 09073173	A2	19970318	JP 1996-50264 19960307
PRIORITY APPLN. INFO.	:		JP 1995-162287 A 19950628
			JP 1995-178717 A 19950714
			JP 1995-312722 A 19951130
			JP 1996-50264 A 19960307

IT 186585-94-4P 186586-03-8P

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(chem. amplification resist compn.)

RN 186585-94-4 CAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 3-ethenyldihydro-2,5-furandione (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 39739-64-5 CMF C6 H6 O3

RN 186586-03-8 CAPLUS

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-propenal (9CI) (CA INDEX NAME)

CM 1

CN

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 107-02-8 CMF C3 H4 O

$$H_2C = CH - CH = O$$

AB The title alkali-developable resist compn. comprises a compd. with lactone component (Markush structure given) and alicyclic hydrocarbyl component (Markush structure given). The lactone component may be (.+-.)-mevalonic lactone and the alicyclic hydrocarbyl component may be 2-alkyl-2-adamantyl. The compn. is useful in an Excimer laser lithog. to produce resist-master with high sensitivity and excellent dry etch-resistance.

## => d 16 1-7 ibib abs hitstr

DO NOT REMOVE \*

ANSWER 1 OF 7 USPATFULL

ACCESSION NUMBER:

2001:196771 USPATFULL

TITLE:

Ester compounds, polymers, resist compositions and

patterning process

INVENTOR(S):

Kinsho, Takeshi, Nakakubiki-gun, Japan Nishi, Tsunehiro, Nakakubiki-gun, Japan Kurihara, Hideshi, Usui-gun, Japan Hasegawa, Koji, Nakakubiki-gun, Japan Watanabe, Takeru, Nakakubiki-gun, Japan Watanabe, Osamu, Nakakubiki-gun, Japan Nakashima, Mutsuo, Nakakubiki-gun, Japan

Takeda, Takanobu, Nakakubiki-gun, Japan Hatakeyama, Jun, Nakakubiki-gun, Japan

PATENT ASSIGNEE(S):

Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S.

corporation)

NUMBER KIND \_\_\_\_\_ \_\_\_ US 6312867 B1 20011106 US 1999-431139 19991101 PATENT INFORMATION: APPLICATION INFO.: 19991101 (9)

NUMBER DATE

PRIORITY INFORMATION:

JP 1998-312533 19981102 19990319 JP 1999-75355

Utility GRANTED

DOCUMENT TYPE: FILE SEGMENT: PRIMARY EXAMINER:

LEGAL REPRESENTATIVE:

Ashton, Rosemary E. Millen, White, Zelano & Branigan, P.C.

NUMBER OF CLAIMS: 17 EXEMPLARY CLAIM: LINE COUNT: 2117

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

A novel ester compound having an exo-form 2-alkylbicyclo[2.2.1]heptan-2yl group as the protective group is provided as well as a polymer comprising units of the ester compound. The polymer is used as a base resin to formulate a resist composition having a higher sensitivity, resolution and etching resistance than conventional resist compositions.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 271599-49-6P

(ester monomers, polymers, resist compns. and patterning process)

271599-49-6 USPATFULL RN

2-Propenoic acid, 2-methyl-, (3aR, 4S, 5R, 7S, 7aR)-5-ethyloctahydro-4,7-CN methano-1H-inden-5-yl ester, rel-, polymer with 1,1-dimethylethyl 4-ethenylphenyl carbonate, 4-ethenylphenol and 2-(4ethenylphenoxy)tetrahydro-2H-pyran (9CI) (CA INDEX NAME)

CM 1

CRN 271598-65-3 CMF C16 H24 O2

Relative stereochemistry.

CM

CRN 87188-51-0 CMF C13 H16 O3

CM 3

CRN 65409-15-6 CMF C13 H16 O2

CM

CRN 2628-17-3 CMF C8 H8 O

ANSWER 2 OF 7 USPATFULL L6

ACCESSION NUMBER:

2000:57502 USPATFULL Photosensitive material

TITLE: INVENTOR(S):

Shida, Naomi, Kawasaki, Japan Ushirogouchi, Toru, Yokohama, Japan

Naito, Takuya, Tokyo, Japan Nakase, Makoto, Tokyo, Japan

PATENT ASSIGNEE(S):

Kabushiki Kaisha Toshiba, Kawasaki, Japan (non-U.S.

corporation)

NUMBER KIND DATE

PATENT INFORMATION: US 6060207 20000509

APPLICATION INFO.: US 1995-499974 19950710 (8)

NUMBER DATE

PRIORITY INFORMATION: JP 1994-158512 19940711

DOCUMENT TYPE: Utility FILE SEGMENT: Granted

PRIMARY EXAMINER: Hamilton, Cynthia

LEGAL REPRESENTATIVE: Oblon, Spivak, McClelland, Maier & Neustadt, P.C.

NUMBER OF CLAIMS: 21

EXEMPLARY CLAIM: 1,8,10,12,21

NUMBER OF DRAWINGS: 1 Drawing Figure(s); 1 Drawing Page(s)

LINE COUNT: 16582

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

AB A photosensitive material which is very low in absorption of a light source of short wavelength and excellent in dry etch resistance. This photosensitive material comprises a compound having a terpenoid skeleton. Preferably, the compound having a terpenoid skeleton is a compound having a monovalent menthyl group or menthyl derivative group which can be represented by the general formula (1). ##STR1## wherein R is a hydrogen atom or a monovalent hydrocarbon group, R.sup.1 may be the same with or different from each other and individually represents a hydrogen atom, a halogen atom, a hydrocarbon group, a hydroxyl group, an alkoxyl group, an amino group, an alkoxyl group, an amino group, an alkoxyl group, a carbonyl group, or a sulfonamide group, and a pair of neighboring R.sup.1 may be connected together to form a closed ring.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 174951-73-6P

CN

(photoresist compn.)

RN 174951-73-6 USPATFULL

2-Propenoic acid, 2-methyl-, octahydro-3,6,8,8-tetramethyl-1H-3a,7-methanoazulen-6-yl ester, [3R-(3.alpha.,3a.beta.,6.alpha.,7.beta.,8a.alpha.)]-, polymer with oxiranylmethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

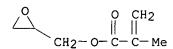
CM 1

CRN 132603-01-1 CMF C19 H30 O2

Absolute stereochemistry.

CM 2

CRN 106-91-2 CMF C7 H10 O3



L6 ANSWER 3 OF 7 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2001:496390 CAPLUS

DOCUMENT NUMBER:

135:99843

TITLE:

Radiation-sensitive polymer compositions with good dry

etching resistance for semiconductor fabrication

INVENTOR(S):

Ishii, Hiroyuki; Doki, Katsuji; Kajita, Toru;

Shimokawa, Tsutomu

PATENT ASSIGNEE(S):

JSR Co., Ltd., Japan

SOURCE:

Jpn. Kokai Tokkyo Koho, 36 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001188347 A2 20010710 JP 2000-137757 20000510
PRIORITY APPLN. INFO.: JP 1999-296028 A 19991018

The compns. comprise (A) acid-dissocg. group-contg. alkali-insol. polymers having CR1[C(:0)OAR2]CH2 and CR6[C(:0)OR7]CH2 (R1, R6 = H, C1-4 alkyl, alkoxy, or hydroxyalkyl; A = single bond, C1-4 alkylene; R2 = R3X1, R4:X2, R5.tplbond.X3; R3-R5 = C4-20 alicyclic group; X1-X3 = O- or N-contg. group; R7 = C4-20 alicyclic group, CR83; R8 = C1-4 alkyl or alicyclic group) and showing alkali. soly. by dissocn. of the acid-dissocg. groups and (B) acid generators. The compns. show good storage stability, high transparency for radiation, and high resoln.

IT 348631-22-1P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(radiation-sensitive resists using alicyclic group-contg. acrylic polymers with good dry etching resistance)

RN 348631-22-1 CAPLUS

CN Bicyclo[2.2.1]hept-5-ene-2-carboxylic acid, 1,1-dimethylethyl ester, polymer with 2,5-furandione, 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and 4-oxotricyclo[3.3.1.13,7]dec-1-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 216582-09-1 CMF C13 H16 O3

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 154970-45-3 CMF C12 H18 O2

CM 4

CRN 108-31-6 CMF C4 H2 O3

L6 ANSWER 4 OF 7 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2000:367047 CAPLUS

DOCUMENT NUMBER:

133:18002

TITLE:

Ester monomers, polymers, resist compositions and

patterning process

INVENTOR(S):

Kinsho, Takeshi; Nishi, Tsunehiro; Kurihara, Hideshi; Hasegawa, Koji; Watanabe, Takeru; Watanabe, Osamu;

Nakashima, Mutsuo; Takeda, Takanobu; Hatakeyama, Jun Shin-Etsu Chemical Co., Ltd., Japan

PATENT ASSIGNEE(S):

Eur. Pat. Appl., 65 pp.

SOURCE:

CODEN: EPXXDW

DOCUMENT TYPE:

Patent

LANGUAGE:

English

1

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
EP 1004568	A2	20000531	EP 1999-308687	19991102
EP 1004568	А3	20010228		

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2000336121 A2 20001205 JP 1999-307148 19991028

KR 2000035130 A 20000626 KR 1999-47904 19991101 US 6312867 B1 20011106 US 1999-431139 19991101 PRIORITY APPLN. INFO.: JP 1998-312533 A 19981102 JP 1999-75355 A 19990319

AB An ester compd. having an exo-form 2-alkylbicyclo[2.2.1]heptan-2-yl group as the protective group is provided as well as a polymer comprising units of the ester compd. The polymer is used as a base resin to formulate a resist compn. having a higher sensitivity, resoln. and etching resistance than conventional resist compns. A polymer was prepd. from 8-ethyltricyclo[5.2.1.02,6]decan-8-yl methacrylate and 5-methyl-2-oxooxolan-5-yl methacrylate.

IT 271599-49-6P

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(ester monomers, polymers, resist compns. and patterning process)

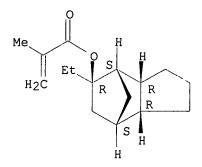
RN 271599-49-6 CAPLUS

CN 2-Propenoic acid, 2-methyl-, (3aR, 4S, 5R, 7S, 7aR)-5-ethyloctahydro-4,7-methano-1H-inden-5-yl ester, rel-, polymer with 1,1-dimethylethyl 4-ethenylphenyl carbonate, 4-ethenylphenol and 2-(4-ethenylphenoxy)tetrahydro-2H-pyran (9CI) (CA INDEX NAME)

CM 1

CRN 271598-65-3 CMF C16 H24 O2

Relative stereochemistry.



CM 2

CRN 87188-51-0 CMF C13 H16 O3

CM 3

CRN 65409-15-6 CMF C13 H16 O2

CM 4

CRN 2628-17-3 CMF C8 H8 O

L6 ANSWER 5 OF 7 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

1996:190901 CAPLUS

DOCUMENT NUMBER:

124:302576

TITLE:

Photosensitive material

INVENTOR(S):

Shida, Naomi; Ushirogouchi, Toru; Naito, Takuya;

Nakase, Makoto

PATENT ASSIGNEE(S):

Kabushiki Kaisha Toshiba, Japan

SOURCE:

Ger. Offen., 371 pp. CODEN: GWXXBX

DOCUMENT TYPE:

Patent

LANGUAGE:

German

FAMILY ACC. NUM. COUNT:

. 1

Ι

PATENT INFORMATION:

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
DE 19525221	A1	19960125	DE 1995-19525221	19950711
JP 08082925	A2	19960326	JP 1995-185046	19950629
US 6060207	Α	20000509	US 1995-499974	19950710
PRIORITY APPLN. INFO.	:		JP 1994-158512	19940711
GI				

AB The title material comprises a compd. contg. a monomer from an acrylate ester of a terpenoid compd. CH:C(R4)CO2R3 [R3 = I (R = H, hydrocarbon; R1 = H, halogen, hydrocarbon; hydroxyl, alkoxy, amino, imide, amide, sulfonyl, carboxyl, carbonyl, sulfonamide where 2 adjoining groups may

form ring)]. The material has improved absorption for shorter wavelength light.

IT 174951-73-6P

> RL: SPN (Synthetic preparation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(photoresist compn.)

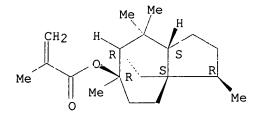
174951-73-6 CAPLUS RN

2-Propenoic acid, 2-methyl-, octahydro-3,6,8,8-tetramethyl-1H-3a,7-CN methanoazulen-6-yl ester, [3R-(3.alpha.,3a.beta.,6.alpha.,7.beta.,8a.alpha .)]-, polymer with oxiranylmethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 132603-01-1 CMF C19 H30 O2

Absolute stereochemistry.



2 CM

CRN 106-91-2 CMF C7 H10 O3

ANSWER 6 OF 7 CAPLUS COPYRIGHT 2002 ACS ACCESSION NUMBER:

1971:142576 CAPLUS

DOCUMENT NUMBER:

74:142576

TITLE:

Compounds synthesized by condensation of monomer and polymer anhydrides with resorcinol and aminophenols

AUTHOR(S):

Spasovska, N.; Panaiotov, Ivan M.

CORPORATE SOURCE:

SOURCE:

Dokl. Bolg. Akad. Nauk (1970), 23(11), 1369-72

CODEN: DBANAD

DOCUMENT TYPE:

Journal

LANGUAGE:

English

For diagram(s), see printed CA Issue. GΙ

Fluorescing polyanhydride-substituted phenol condensates such as I and II, AΒ where X = H or Me and R = OH, NH2, or NEt2, were prepd. from polyitaconic, polyacrylic, or polymethacrylic anhydrides and resorcinol (III), m-aminophenol (IV), or N,N-diethyl-m-aminophenol (V) and the analogous substituted phenol-anhydride condensate monomers such as VI and VII where X = H or Me and R = OH, NH2, or NEt2, were prepd. from itaconic, acrylic, and methacrylic anhydrides and III, IV, or V in the presence of CuCl. Both the monomeric and polymeric products were studied by thermogravimetric anal., soly. tests, and ir spectroscopy.

IT 32191-24-5P

RL: SPN (Synthetic preparation); PREP (Preparation)

(prepn. of)

RN 32191-24-5 CAPLUS

CN Methacrylic acid, 3,6-diamino-9-isopropenylxanthen-9-yl ester (8CI) (CA INDEX NAME)

L6 ANSWER 7 OF 7 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

1971:142562 CAPLUS

DOCUMENT NUMBER:

74:142562

TITLE:

Electronic spectra of compounds obtained on the bases

of acrylic, methacrylic, itaconic, and maleic anhydrides and the corresponding polyanhydrides

AUTHOR(S):

Spasovska, N.

CORPORATE SOURCE:

Bulg.

SOURCE:

Dokl. Bolg. Akad. Nauk (1970), 23(11), 1373-6

CODEN: DBANAD

DOCUMENT TYPE:

Journal

LANGUAGE:

English

GI For diagram(s), see printed CA Issue.

AB No major differences were obsd. when the uv, visible, and fluorescent absorption and emission spectra of xanthene monomers, such as I, II, and III, where X = H, or Me and R = OH, NH2, or NEt2, obtained by condensing acrylic, methacrylic, itaconic, and maleic anhydrides with resorcinol (IV), m-aminophenol (V), and N,N-diethyl-m-aminophenol (VI) were compared with spectra for polyanhydride-phenol condensate polymers, such as VII, VIII, and IX, where R = OH, NH2, or N(Et)2 (obtained by condensing polyacrylic, polymethacrylic, polyitaconic, and polymaleic anhydrides with IV, V, and VI).

IT 32191-24-5

RL: PRP (Properties)

(spectrum of)

RN 32191-24-5 CAPLUS

CN Methacrylic acid, 3,6-diamino-9-isopropenylxanthen-9-yl ester (8CI) (CA INDEX NAME)

L17 ANSWER 1 OF 167 USPATFULL

ACCESSION NUMBER:

2002:60870 USPATFULL

TITLE:

Crosslinked positive-working photoresist

composition

INVENTOR(S):

Oomori, Katsumi, Chigasaki-shi, JAPAN Kinoshita, Yohei, Sagamihara-shi, JAPAN Yamada, Tomotaka, Atsugi-shi, JAPAN Takayama, Toshikazu, Kanagawa-ken, JAPAN

KIND DATE NUMBER \_\_\_\_\_\_ 20020321

PATENT INFORMATION: APPLICATION INFO.:

US 2002034704 A1 US 2001-928399 A1 20010814 (9)

NUMBER DATE

PRIORITY INFORMATION:

JP 2000-250174 20000821 JP 2000-250175 20000821

DOCUMENT TYPE: FILE SEGMENT:

Utility APPLICATION

LEGAL REPRESENTATIVE:

WENDEROTH, LIND & PONACK, L.L.P., 2033 K STREET N. W., SUITE 800, WASHINGTON, DC, 20006-1021

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

14 1 765

LINE COUNT: CAS INDEXING IS AVAILABLE FOR THIS PATENT.

The invention discloses a chemical-amplification positive-working photoresist composition of the crosslinked type used for photolithographic patterning works in the manufacture of electronic devices. While the composition comprises a film-forming resinous ingredient capable of being imparted with increased alkali-solubility in the presence of an acid and a radiation-sensitive acidgenerating compound, optionally, with further admixture of an aliphatic amine compound and an acid compound, the inventive photoresist composition is characterized by the unique resinous ingredient which consists of four types of monomeric units including hydroxystyrene units, styrene units, monomeric units having acid-dissociable solubility-reducing groups and crosslinking units. The acid-dissociable solubility-reducing group is not conventional tert-butoxycarbonýloxy group but characteristically a 1-alkylcyclohexyl group or a polycyclic saturated aliphatic hydrocarbon group.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

400865-44-3, 2,5-Dimethyl-2,5-hexanediol diacrylate-1ethylcyclohexyl acrylate-hydroxystyrene-styrene copolymer 400865-46-5 400865-47-6

(crosslinked pos.-working photoresist compn. contg.)

RN 400865-44-3 USPATFULL

2-Propenoic acid, 1,1,4,4-tetramethyl-1,4-butanediyl ester, polymer with CN ethenylbenzene, ethenylphenol and 1-ethylcyclohexyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 251909-25-8 CMF C11 H18 O2

..CM 2

CRN 188837-15-2 CMF C14 H22 O4

CM 3

CRN 31257-96-2 CMF C8 H8 O CCI IDS CDES 8:ID



D1- OH

 $D1-CH=CH_2$ 

CM 4

CRN 100-42-5 CMF C8 H8

 $H_2C = CH - Ph$ 

RN 400865-46-5 USPATFULL
CN 2-Propenoic acid, 1,1,5-trimethyl-3-[1-methyl-1-[(1-oxo-2-propenyl)oxy]ethyl]-1,5-propanediyl ester, polymer with ethenylbenzene, ethenylphenol and 1-ethylcyclohexyl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 400865-45-4 CMF C20 H30 O6

CM 2

CRN 251909-25-8 CMF C11 H18 O2

CM 3

CRN 31257-96-2 CMF C8 H8 O CCI IDS CDES 8:ID



D1-OH

 $D1-CH = CH_2$ 

CM 4

CRN 100-42-5 CMF C8 H8  $H_2C = CH - Ph$ 

RN 400865-47-6 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with ethenylbenzene, ethenylphenol and 1,1,4,4-tetramethyl-1,4-butanediyl di-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 188837-15-2 CMF C14 H22 O4

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 31257-96-2 CMF C8 H8 O CCI IDS CDES 8:ID



D1-OH

 $D1-CH \longrightarrow CH_2$ 

CM 4

 $H_2C \longrightarrow CH - Ph$ 

L17 ANSWER 2 OF 167 USPATFULL

ACCESSION NUMBER: 2002:54559 USPATFULL

Novel copolymer, photoresist TITLE:

composition, and process for forming resist pattern with high aspect ratio

INVENTOR(S):

Nakamura, Tsuyoshi, Kanagawa, JAPAN Ikegawa, Taeko, Kanagawa, JAPAN Sawano, Atsushi, Kanagawa, JAPAN Doi, Kousuke, Kanagawa, JAPAN Kohara, Hidekatsu, Kanagawa, JAPAN

TOKYO OHKA KOGYO CO., LTD. (non-U.S. corporation) PATENT ASSIGNEE(S):

NUMBER KIND DATE \_\_\_\_\_\_

US 2002031720 A1 20020314 US 2001-901657 A1 20010711 (9) PATENT INFORMATION: APPLICATION INFO.:

NUMBER DATE JP 2000-214451 20000714 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility

APPLICATION FILE SEGMENT:

SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC, 2100 LEGAL REPRESENTATIVE:

Pennsylvania Avenue, N.W., Washington, DC, 20037 13

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1

2 Drawing Page(s) NUMBER OF DRAWINGS: LINE COUNT: 745

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

A novel copolymer includes a repeating unit (B) derived from an unsaturated carboxylic anhydride, a repeating unit (C) represented by Formula (II), and a repeating unit (D) represented by Formula (III). ##STR1##

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 348129-45-3, Allyltrimethylsilane; maleic anhydride; 2-

methyladamantyl methacrylate copolymer

(new copolymers for deep UV workable photoresists with good light transmittance and high sensitivity and resoln. and method for forming resist patterns with high aspect ratio using copolymers)

348129-45-3 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, CN polymer with 2,5-furandione and trimethyl-2-propenylsilane (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

2 CM

CRN 762-72-1 CMF C6 H14 Si

 $Me_3Si-CH_2-CH \longrightarrow CH_2$ 

CM 3

CRN 108-31-6 CMF C4 H2 O3

L17 ANSWER 3 OF 167 USPATFULL

ACCESSION NUMBER:

2002:54558 USPATFULL

TITLE:

Novel copolymer, photoresist

composition, and process for forming resist

pattern with high aspect ratio

Nakamura, Tsuyoshi, Kanagawa, JAPAN Ikegawa, Taeko, Kanagawa, JAPAN INVENTOR(S):

Sawano, Atsushi, Kanagawa, JAPAN Doi, Kousuke, Kanagawa, JAPAN Kohara, Hidekatsu, Kanagawa, JAPAN

PATENT ASSIGNEE(S):

TOKYO OHKA KOGYO CO., LTD. (non-U.S. corporation)

NUMBER KIND DATE US 2002031719 A1 20020314 US 2001-901646 A1 20010711 PATENT INFORMATION: 20010711 (9) APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_ JP 2000-214450 20000714 PRIORITY INFORMATION:

DOCUMENT TYPE:

Utility

FILE SEGMENT:

APPLICATION

LEGAL REPRESENTATIVE:

SUGHRUE, MION, ZINN, MACPEAK & SEAS, 2100 Pennsylvania

Avenue, N.W., Washington, DC, 20037

16 NUMBER OF CLAIMS: EXEMPLARY CLAIM:

NUMBER OF DRAWINGS:

2 Drawing Page(s)

LINE COUNT:

805

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

A novel copolymer includes a repeating unit (A) represented by, for example, Formula (I) below, and a repeating unit (B) derived

from an unsaturated carboxylic anhydride. The novel copolymer

is suitable for the preparation of a **photoresist** composition that has satisfactory transparency, high sensitivity and definition and exhibits satisfactory DOF properties in the field of photolithography using a deep UV light source. By the use of the **photoresist** composition, a process forms a **resist** pattern with a high aspect ratio. ##STR1##

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 391208-99-4P, Allyltrimethylsilane; 1-ethyl-1-cyclohexyl methacrylate; maleic anhydride; 2-methyl-2-adamantyl methacrylate copolymer 391209-01-1P, 1-Ethyl-1-cyclohexyl methacrylate; maleic anhydride copolymer 391209-02-2P, Allyltrimethylsilane; 1-ethyl-1-cyclohexyl methacrylate; maleic anhydride copolymer (new copolymers for deep UV workable photoresists with good light transmittance and high sensitivity and resoln. and method for forming resist patterns with high aspect ratio using copolymers)

RN 391208-99-4 USPATFULL

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 1-ethylcyclohexyl 2-methyl-2-propenoate, 2,5-furandione and trimethyl-2-propenylsilane (9CI) (CA INDEX NAME)

CM 1

CN

CRN 274248-09-8 CMF C12 H20 O2

CM 2

CRN 177080-67-0 CMF C15 H22 O2

CM 3

CRN 762-72-1 CMF C6 H14 Si

 $Me_3Si-CH_2-CH-CH_2$ 

CRN 108-31-6 CMF C4 H2 O3

391209-01-1 USPATFULL RN

2-Propenoic acid, 2-methyl-, 1-ethylcyclohexyl ester, polymer with CN 2,5-furandione (9CI) (CA INDEX NAME)

CM

CRN 274248-09-8 CMF C12 H20 O2

2 CM

CRN 108-31-6 CMF C4 H2 O3

391209-02-2 USPATFULL RN

2-Propenoic acid, 2-methyl-, 1-ethylcyclohexyl ester, polymer with 2,5-furandione and trimethyl-2-propenylsilane (9CI) (CA INDEX NAME) CN

1 CM

CRN 274248-09-8 CMF C12 H20 O2

CRN 762-72-1 CMF C6 H14 Si

 $Me_3Si-CH_2-CH \longrightarrow CH_2$ 

CM 3

CRN 108-31-6 CMF C4 H2 O3

L17 ANSWER 4 OF 167 USPATFULL

ACCESSION NUMBER:

2002:34281 USPATFULL

TITLE:

AΒ

Chemical amplification type positive resist

INVENTOR(S):

Uetani, Yasunori, Toyonaka, JAPAN

Oohashi, Kenji, Yawata, JAPAN Inoue, Hiroki, Toyonaka, JAPAN

PATENT ASSIGNEE(S):

Sumitomo Chemical Company, Limited, Osaka, JAPAN

(non-U.S. corporation)

NUMBER DATE

NORDER DATE

PRIORITY INFORMATION: JP 1999-92990 19990331 JP 1999-315264 19991105

DOCUMENT TYPE: Utility FILE SEGMENT: GRANTED

PRIMARY EXAMINER: Ashton, Rosemary

LEGAL REPRESENTATIVE: Birch, Stewart, Kolasch & Birch, LLP

NUMBER OF CLAIMS: 16
EXEMPLARY CLAIM: 1

NUMBER OF DRAWINGS: 0 Drawing Figure(s); 0 Drawing Page(s)

LINE COUNT: 1138

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

A chemical amplification type positive **resist** composition which is good in resolution, provide a good pattern profile under exposure using light of wavelength of 220 nm or shorter even when applied on a basic substrate or a low reflectance substrate and which comprises an **acid generator** comprising an aliphatic sulfonium salt represented by the following formula (I): ##STR1##

wherein Q.sup.1 represents an alkyl group, Q.sup.2 represents an alkyl or a residue of an **alicyclic** hydrocarbon and m represents an integer of 1 to 8; and onium salt selected from triphenylsulfonium salts represented by the following formula (IIa) and diphenyliodonium salts represented by the following formula (IIb): ##STR2##

wherein Q.sup.3, Q.sup.4, Q.sup.5, Q.sup.6 and Q.sup.7each independently represent a hydrogen atom, a hydroxyl group, an alkyl group having 1 to 6 carbon atoms, an alkoxy group having 1 to 6 carbon atoms, and q and p

represent a integer of 4 to 8; and (2) a **resin** which has a polymerization unit with a group unstable to an acid, and is insoluble or barely soluble in alkali by itself but changes soluble in alkali by an action of the acid, is provided.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

IT 195000-67-0P, .alpha.-Methacryloyloxy-.gamma.-butyrolactone-2 methyl-2-adamantyl methacrylate copolymer 258879-89-9P,
 .alpha.-Methacryloyloxy-.gamma.-butyrolactone;2-ethyl-2-adamantyl
 methacrylate;3-hydroxy-1-adamantyl methacrylate copolymer
 299416-56-1P, 2-Ethyl-2-adamantyl methacrylate-3-hydroxy-1 adamantyl methacrylate-norbornene-maleic anhydride copolymer
 (manuf. of resin for chem.-amplified pos. resist contg.)

RN 195000-67-0 USPATFULL
CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester,
polymer with tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA

INDEX NAME)

CM 1

CRN 195000-66-9 CMF C8 H10 O4

CM 2

CRN 177080-67-0 CMF C15 H22 O2

RN 258879-89-9 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

2 CM

CRN 195000-66-9 CMF C8 H10 O4

CM 3

CRN 115372-36-6 CMF C14 H20 O3

299416-56-1 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione and 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate (9CI) (CA CN INDEX NAME)

1 CM

CRN 209982-56-9 CMF C16 H24 O2

2 CM

CRN 115372-36-6 CMF C14 H20 O3

3 CM

CRN 498-66-8 CMF C7 H10



4 CM

CRN 108-31-6 CMF C4 H2 O3

IT 177080-67-0P, 2-Methyl-2-adamantyl methacrylate 209982-56-9P

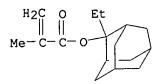
(synthesis of, for manuf. of resin for chem.-amplified pos. resist)

177080-67-0 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester CN (9CI) (CA INDEX NAME)

209982-56-9 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester CN (9CI) (CA INDEX NAME)



L17 ANSWER 5 OF 167 USPATFULL

2002:27067 USPATFULL ACCESSION NUMBER:

Chemical amplifying type positive resist TITLE:

composition and sulfonium salt Uetani, Yasunori, Osaka, JAPAN INVENTOR(S): Oohashi, Kenji, Yawata-shi, JAPAN

Kamabuchi, Akira, Ashiya-shi, JAPAN

NUMBER KIND DATE US 2002015913 A1 20020207 US 2001-886386 A1 20010622 (9) PATENT INFORMATION: APPLICATION INFO .:

> NUMBER DATE \_\_\_\_\_\_

PRIORITY INFORMATION: JP 2000-189120 20000623

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

CHURCH, VA, 22040-0747 LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 LINE COUNT: 2075

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

A chemical amplifying type positive resist composition which provides a resist pattern having an exceedingly improved line edge roughness, and is excellent in various resist performances such as dry etching resistance, sensitivity and resolution; and comprises:

(A) an acid generator containing (a) a sulfonium salt represented by the following formula (I): ##STR1##

wherein Q.sup.1 and Q.sup.2 is alkyl or a cycloalkyl, or Q.sup.1 and Q.sup.2 form, together with a sulfur atom to which Q.sup.1 and Q.sup.2 are adjacent, an heteroalicyclic group; Q.sup.3 represents a hydrogen atom, Q.sup.4 represents alkyl or a cycloalkyl, or Q.sup.3 and Q4 form, together with a CHC(O) group to which Q.sup.3 and Q4 are adjacent, a 2-oxocycloalkyl group; and Q.sup.5SO.sub.3.sup.- represents an organosulfonate ion, and

(b) at least one onium salt selected from a triphenylsulfonium salt represented by the following formula (IIa), and a diphenyliodonium salt represented by the following formula (IIb); ##STR2##

wherein P.sup.1 to P.sup.5 represent hydrogen, a hydroxyl group, alkyl, or alkoxy; and P.sup.6SO.sub.3.sup.- and P.sup.7SO.sub.3.sup.- each independently represent an organosulfonate ion; and

(B) a resin which has a polymerization unit having a group instable against an acid, and is alkali-insoluble or -slightly soluble itself, but is converted to alkali-soluble by the action of an acid.

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

## IT 341969-10-6P

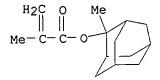
(chem. amplifying type pos. resist compn. contg. resin)

341969-10-6 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, CN polymer with 4-ethenylphenyl acetate (9CI) (CA INDEX NAME)

CM

177080-67-0 CRN CMF C15 H22 O2



2 CM

CRN 2628-16-2 CMF C10 H10 O2

## IT 258879-89-9P 299416-56-1P 341969-10-6DP,

p-Acetoxystyrene-2-methyl-2-admantylmethacrylate copolymer, hydrolyzed 364736-22-1P, 2-Ethyl-2-adamantyl methacrylate-5-methacryloyloxy-2,6-norbornanelactone-.alpha.-methacryloyloxy-.gamma.-butyrolactone copolymer

(chem. amplifying type pos. resist compn. contg. resin)

258879-89-9 USPATFULL RN

2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CN

209982-56-9 CRN CMF C16 H24 O2

CRN 195000-66-9 CMF C8 H10 O4

CM 3

CRN 115372-36-6 CMF C14 H20 O3

RN 299416-56-1 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with bicyclo[2.2.1]hept-2-ene, 2,5-furandione and 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 209982-56-9 CMF C16 H24 O2

CM 2

CRN 115372-36-6 CMF C14 H20 O3

CM 3

CRN 498-66-8 CMF C7 H10



CM 4

CRN 108-31-6 CMF C4 H2 O3

RN 341969-10-6 USPATFULL

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 4-ethenylphenyl acetate (9CI) (CA INDEX NAME)

CM 1

CRN 177080-67-0 CMF C15 H22 O2

CM 2

CRN 2628-16-2 CMF C10 H10 O2

RN 364736-22-1 USPATFULL

2-Propenoic acid, 2-methyl-, 2-ethyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CRN 254900-07-7 CMF C12 H14 O4

## CM 2

CRN 209982-56-9 CMF C16 H24 O2

CM 3

CRN 195000-66-9 CMF C8 H10 O4

L17 ANSWER 1 OF 167 USPATFULL

2002:60870 USPATFULL ACCESSION NUMBER:

Crosslinked positive-working photoresist TITLE:

composition

Oomori, Katsumi, Chigasaki-shi, JAPAN INVENTOR(S):

Kinoshita, Yohei, Sagamihara-shi, JAPAN Yamada, Tomotaka, Atsugi-shi, JAPAN

Takayama, Toshikazu, Kanagawa-ken, JAPAN

NUMBER KIND DATE \_\_\_\_\_

US 2002034704 A1 20020321 US 2001-928399 A1 20010814 PATENT INFORMATION: A1 20010814 (9) APPLICATION INFO .:

NUMBER DATE

JP 2000-250174 20000821 JP 2000-250175 20000821 PRIORITY INFORMATION: JP 2000-250175

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

WENDEROTH, LIND & PONACK, L.L.P., 2033 K STREET N. W., SUITE 800, WASHINGTON, DC, 20006-1021 LEGAL REPRESENTATIVE:

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 765 LINE COUNT:

INVENTOR(S):

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 2 OF 167 USPATFULL

2002:54559 USPATFULL ACCESSION NUMBER:

Novel copolymer, photoresist TITLE:

composition , and process for forming  ${\tt resist}$ 

pattern with high aspect ratio Nakamura, Tsuyoshi, Kanagawa, JAPAN

Ikegawa, Taeko, Kanagawa, JAPAN Sawano, Atsushi, Kanagawa, JAPAN Doi, Kousuke, Kanagawa, JAPAN Kohara, Hidekatsu, Kanagawa, JAPAN

TOKYO OHKA KOGYO CO., LTD. (non-U.S. corporation) PATENT ASSIGNEE(S):

NUMBER KIND DATE \_\_\_\_\_\_\_

US 2002031720 A1 20020314 US 2001-901657 A1 20010711 (9) PATENT INFORMATION: APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_ JP 2000-214451 20000714

PRIORITY INFORMATION: DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC, 2100 LEGAL REPRESENTATIVE:

Pennsylvania Avenue, N.W., Washington, DC, 20037

NUMBER OF CLAIMS: 13 EXEMPLARY CLAIM: 1

2 Drawing Page(s) NUMBER OF DRAWINGS:

745 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 3 OF 167 USPATFULL

2002:54558 USPATFULL ACCESSION NUMBER:

Novel copolymer, photoresist TITLE:

composition, and process for forming resist

pattern with high aspect ratio

INVENTOR(S):

Nakamura, Tsuyoshi, Kanagawa, JAPAN Ikegawa, Taeko, Kanagawa, JAPAN

Sawano, Atsushi, Kanagawa, JAPAN Doi, Kousuke, Kanagawa, JAPAN Kohara, Hidekatsu, Kanagawa, JAPAN

PATENT ASSIGNEE(S):

TOKYO OHKA KOGYO CO., LTD. (non-U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_

PATENT INFORMATION: APPLICATION INFO.:

US 2002031719 A1 20020314 US 2001-901646 A1 20010711

A1 20010711 (9)

NUMBER DATE

PRIORITY INFORMATION:

JP 2000-214450 20000714

DOCUMENT TYPE: FILE SEGMENT:

Utility APPLICATION

LEGAL REPRESENTATIVE: SUGHRUE, MION, ZINN, MACPEAK & SEAS, 2100 Pennsylvania

Avenue, N.W., Washington, DC, 20037

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

NUMBER OF DRAWINGS: 2 Drawing Page(s)
LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 4 OF 167 USPATFULL

ACCESSION NUMBER: 2002:34281 USPATFULL

TITLE:

Chemical amplification type positive resist

INVENTOR(S):

Uetani, Yasunori, Toyonaka, JAPAN Oohashi, Kenji, Yawata, JAPAN Inoue, Hiroki, Toyonaka, JAPAN

PATENT ASSIGNEE(S):

Sumitomo Chemical Company, Limited, Osaka, JAPAN

(non-U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_\_

PATENT INFORMATION: US 6348297 B1 20020219 APPLICATION INFO.: US 2000-533986 20000324 (9)

NUMBER DATE

PRIORITY INFORMATION:

 JP 1999-92990
 19990331

 JP 1999-315264
 19991105

DOCUMENT TYPE:

Utility

FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Ashton, Rosemary
LEGAL REPRESENTATIVE: Birch, Stewart, Kolasch & Birch, LLP

NUMBER OF CLAIMS:

16

EXEMPLARY CLAIM:

1 0 Drawing Figure(s); 0 Drawing Page(s)

NUMBER OF DRAWINGS:

1138

LINE COUNT: CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 5 OF 167 USPATFULL

ACCESSION NUMBER:

INVENTOR(S):

2002:27067 USPATFULL

TITLE:

Chemical amplifying type positive resist

composition and sulfonium salt Uetani, Yasunori, Osaka, JAPAN

Oohashi, Kenji, Yawata-shi, JAPAN Kamabuchi, Akira, Ashiya-shi, JAPAN

NUMBER KIND DATE

PATENT INFORMATION: US 2002015913 A1 20020207 APPLICATION INFO.: US 2001-886386 A1 20010622 (9)

PRIORITY INFORMATION: JP 2000-DOCUMENT TYPE: Utility

FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: 10 EXEMPLARY CLAIM: 1 LINE COUNT: 2075

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 6 OF 167 USPATFULL

ACCESSION NUMBER: 2002:16789 USPATFULL

TITLE: Radiation-sensitive resin composition
INVENTOR(S): Nishimura, Yukio, Yokkaichi, JAPAN
Yamahara, Noboru, Yokkaichi, JAPAN

Yamamoto, Masafumi, Yokkaichi, JAPAN Kajita, Toru, Yokkaichi, JAPAN Shimokawa, Tsutomu, Suzuka, JAPAN

Ito, Hiroshi, San Jose, CA, UNITED STATES

PRIORITY INFORMATION: JP 2000-182297 20000616
JP 2001-108824 20010406

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: Supervisor, Patent Prosecution Services, PIPER MARBURY

RUDNICK & WOLFE LLP, 1200 Nineteenth Street, N.W.,

Washington, DC, 20036-2412

NUMBER OF CLAIMS: 16
EXEMPLARY CLAIM: 1
LINE COUNT: 2918

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 7 OF 167 USPATFULL

ACCESSION NUMBER: 2002:16788 USPATFULL

TITLE: Radiation-sensitive resin composition INVENTOR(S): Nishimura, Yukio, Yokkaichi, JAPAN

Douki, Katsuji, Ithaca, NY, UNITED STATES

Kajita, Toru, Yokkaichi, JAPAN Shimokawa, Tsutomu, Suzuka, JAPAN

NUMBER DATE

PRIORITY INFORMATION: JP 2000-173708 20000609 JP 2001-95877 20010329

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: Supervisor, Patent Prosecution Services, PIPER MARBURY

RUDNICK & WOLFE LLP, 12000 Nineteenth Street, N.W.,

Washington, DC, 20036-2412

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1
LINE COUNT: 21 LINE COUNT: 2110

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 8 OF 167 USPATFULL

ACCESSION NUMBER: 2002:16787 USPATFULL

Positive photoresist composition TITLE: INVENTOR(S): Sato, Kenichiro, Shizuoka, JAPAN Aoai, Toshiaki, Shizuoka, JAPAN

NUMBER KIND DATE \_\_\_\_\_\_\_\_ US 2002009666 A1 20020124 US 2001-834639 A1 20010416 (9) PATENT INFORMATION: APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_\_ 
 JP 2000-115497
 20000417

 JP 2000-215574
 20000717

 JP 2000-231670
 20000731
 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC, 2100 Pennsylvania Avenue, N.W., Washington, DC, 20037

NUMBER OF CLAIMS: 18
EXEMPLARY CLAIM: 1
1642

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 9 OF 167 USPATFULL

ACCESSION NUMBER: 2002:12648 USPATFULL

Novel ester compounds, polymers, TITLE:

resist compositions and patterning process

Nishi, Tsunehiro, Niigata-ken, JAPAN INVENTOR(S): Hasegawa, Koji, Niigata-ken, JAPAN

Watanabe, Takeru, Niigata-ken, JAPAN Kinsho, Takeshi, Niigata-ken, JAPAN Nakashima, Mutsuo, Niigata-ken, JAPAN Tachibana, Seiichiro, Niigata-ken, JAPAN

Hatakeyama, Jun, Niigata-ken, JAPAN

Shin-Etsu Chemical Co., Ltd., Tokyo, JAPAN (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE US 2002007031 A1 20020117 US 2001-842007 A1 20010426 (9) PATENT INFORMATION: APPLICATION INFO.:

> NUMBER DATE \_\_\_\_\_ JP 2000-127532 20000427

PRIORITY INFORMATION: DOCUMENT TYPE: Utility

FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

2 Drawing Page(s) 1531 NUMBER OF DRAWINGS:

LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 10 OF 167 USPATFULL

ACCESSION NUMBER: 2002:12205 USPATFULL

Chemical amplification type positive resist TITLE:

compositions and sulfonium salts Inoue, Hiroki, Kashiba-shi, JAPAN INVENTOR(S):

Uetani, Yasunori, Toyonaka-shi, JAPAN

NUMBER KIND DATE \_\_\_\_\_ US 2002006582 A1 20020117 US 2001-849523 A1 20010507 PATENT INFORMATION: APPLICATION INFO.: 20010507 (9)

NUMBER DATE \_\_\_\_\_\_

JP 2000-135580 20000509 JP 2000-255119 20000825 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: 12 NUMBER OF CLAIM: 1
EXEMPLARY CLAIM: 1
988

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 11 OF 167 USPATFULL

2002:8569 USPATFULL ACCESSION NUMBER:

Polymer, chemically amplified resist TITLE: composition and patterning process Hatakeyama, Jun, Niigata-ken, JAPAN

INVENTOR(S): Watanabe, Jun, Niigata-ken, JAPAN Harada, Yuji, Niigata-ken, JAPAN

Shin-Etsu Chemical Co., Ltd., Chiyoda-ku, JAPAN PATENT ASSIGNEE(S):

(non-U.S. corporation)

NUMBER KIND DATE US 2002004569 A1 20020110 US 2001-842114 A1 20010426 (9) PATENT INFORMATION: APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_ PRIORITY INFORMATION: JP 2000-127513 20000427

PRIORITY INFORMATION
DOCUMENT TYPE: Utility
APPLICATION
MHIT

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM: LINE COUNT: 1226

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 12 OF 167 USPATFULL

2002:8180 USPATFULL ACCESSION NUMBER:

Novel ester compounds, polymers, TITLE:

resist compositions and patterning process

Hasegawa, Koji, Niigata-ken, JAPAN INVENTOR(S):

Nishi, Tsunehiro, Niigata-ken, JAPAN Kinsho, Takeshi, Niigata-ken, JAPAN Watanabe, Takeru, Niigata-ken, JAPAN Nakashima, Matsuo, Niigata-ken, JAPAN Tachibana, Seiichiro, Niigata-ken, JAPAN

Hatakeyama, Jun, Niigata-ken, JAPAN

Shin-Etsu Chemical Co., Ltd., Tokyo, JAPAN (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_

PATENT INFORMATION:

US 2002004178 A1 20020110 US 2001-837219 A1 20010419 20010419 (9) APPLICATION INFO.:

NUMBER DATE

JP 2000-119410 20000420 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON LEGAL REPRESENTATIVE:

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

1 Drawing Page(s) NUMBER OF DRAWINGS:

LINE COUNT: 1600

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 13 OF 167 USPATFULL

2001:229365 USPATFULL ACCESSION NUMBER:

Polymers, resist compositions and TITLE:

patterning process

Nishi, Tsunehiro, Niigata-ken, Japan INVENTOR(S): Nakashima, Mutsuo, Niigata-ken, Japan

Tachibana, Seiichiro, Niigata-ken, Japan Kinsho, Takeshi, Niigata-ken, Japan Hasegawa, Koji, Niigata-ken, Japan Watanabe, Takeru, Niigata-ken, Japan

Hatakeyama, Jun, Niigata-ken, Japan

Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE US 2001051316 A1 20011213 US 2001-842396 A1 20010426 PATENT INFORMATION: 20010426 (9) APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_

PRIORITY INFORMATION: DOCUMENT TYPE:

JP 2000-129042 20000428 Utility

FILE SEGMENT:

APPLICATION

MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON LEGAL REPRESENTATIVE:

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

1459 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 14 OF 167 USPATFULL

2001:229364 USPATFULL ACCESSION NUMBER:

Polymers, resist compositions and TITLE: patterning process

Nishi, Tsunehiro, Niigata-ken, Japan INVENTOR(S):

Tachibana, Seiichiro, Niigata-ken, Japan Nakashima, Mutsuo, Niigata-ken, Japan Kinsho, Takeshi, Niigata-ken, Japan Watanabe, Takeru, Niigata-ken, Japan

Hasegawa, Koji, Niigata-ken, Japan Hatakeyama, Jun, Niigata-ken, Japan

PATENT ASSIGNEE(S): Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S.

corporation)

NUMBER KIND DATE \_\_\_\_\_ \_\_\_ US 2001051315 A1 20011213 US 2001-842113 A1 20010426 (9) PATENT INFORMATION: APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_

JP 2000-129054 20000428 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 LINE COUNT: 1516

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 15 OF 167 USPATFULL

2001:223858 USPATFULL ACCESSION NUMBER: Pattern formation method TITLE:

Kishimura, Shinji, Hyogo, Japan INVENTOR(S): Katsuyama, Akiko, Kyoto, Japan Sasago, Masaru, Osaka, Japan

NUMBER KIND DATE PATENT INFORMATION: APPLICATION INFO.: US 2001049075 A1 20011206 US 2000-520805 A1 20000308 (9)

NUMBER DATE JP 1999-61184 19990309

PRIORITY INFORMATION: DOCUMENT TYPE: Utility

APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: NIXON PEABODY, LLP, 8180 GREENSBORO DRIVE, SUITE 800,

MCLEAN, VA, 22102

NUMBER OF CLAIMS: 17 EXEMPLARY CLAIM:

NUMBER OF DRAWINGS: 7 Drawing Page(s) LINE COUNT: 1028

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 16 OF 167 USPATFULL

2001:218153 USPATFULL ACCESSION NUMBER:

Chemically amplified positive resist TITLE:

composition

Uetani, Yasunori, Osaka, Japan INVENTOR(S):

Fujishima, Hiroaki, Osaka, Japan Takata, Yoshiyuki, Osaka, Japan

NUMBER KIND DATE PATENT INFORMATION: US 2001046641 A1 20011129 US 2001-791756 A1 20010226 (9) APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_ PRIORITY INFORMATION: JP 2000-51018 20000228 DOCUMENT TYPE: FILE SEGMENT: Utility APPLICATION

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 775 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 17 OF 167 USPATFULL

ACCESSION NUMBER: 2001:212078 USPATFULL

Photoresist compositions comprising blends of TITLE:

ionic and non-ionic photoacid

generators

Trefonas, Peter, III, Medway, MA, United States INVENTOR(S):

PATENT ASSIGNEE(S): Shipley Company, L.L.C., Marlborough, MA, United States

(U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_ PATENT INFORMATION: US 2001044072 A1 20011122 APPLICATION INFO.: US 2001-860938 A1 20010518 (9)

Continuation of Ser. No. US 1998-150965, filed on 10 RELATED APPLN. INFO.:

Sep 1998, GRANTED, Pat. No. US 6280911

DOCUMENT TYPE: FILE SEGMENT: Utility

FILE SEGMENT: APPLICATION
LEGAL REPRESENTATIVE: EDWARDS & ANGELL, LLP, Dike, Bronstein, Roberts &

Cushman, IP Group, P.O. Box 9169, Boston, MA, 02209

22 NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 808 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 18 OF 167 USPATFULL

2001:212077 USPATFULL ACCESSION NUMBER:

Novel ester compounds, polymers, TITLE:

resist compositions and patterning process

Hasegawa, Koji, Niigata-ken, Japan INVENTOR(S): Nishi, Tsunehiro, Niigata-ken, Japan

Kinsho, Takeshi, Niigata-ken, Japan Watanabe, Takeru, Niigata-ken, Japan Nakashima, Mutsuo, Niigata-ken, Japan Tachibana, Seiichiro, Niigata-ken, Japan

Hatakeyama, Jun, Niigata-ken, Japan

Shin-Etsu Chemical Co., Ltd, Tokyo, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE PATENT INFORMATION: US 2001044071 A1 20011122 US 2001-837378 A1 20010419 (9) APPLICATION INFO.:

NUMBER DATE \_\_\_\_\_ JP 2000-119410 20000420 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: 1 EXEMPLARY CLAIM: 1476 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 19 OF 167 USPATFULL

2001:212076 USPATFULL ACCESSION NUMBER:

TITLE:

Chemically amplified positive resist

composition

Uetani, Yasunori, Osaka, Japan INVENTOR(S): Yamada, Airi, Osaka, Japan Miya, Yoshiko, Muko-shi, Japan Takata, Yoshiyuki, Osaka, Japan

NUMBER KIND DATE \_\_\_\_\_ US 2001044070 A1 20011122 US 2001-824227 A1 20010403 PATENT INFORMATION: A1 20010403 (9) APPLICATION INFO .:

NUMBER DATE \_\_\_\_\_\_ JP 2000-101868 20000404 JP 2000-133328 20000502 PRIORITY INFORMATION:

20000711 JP 2000-209505

Utility DOCUMENT TYPE: APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 894 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 20 OF 167 USPATFULL

2001:199869 USPATFULL ACCESSION NUMBER:

Chemical amplification, positive resist TITLE:

compositions

Ohsawa, Youichi, Nakakubiki-gun, Japan INVENTOR(S):

Watanabe, Jun, Nakakubiki-gun, Japan Takeda, Takanobu, Nakakubiki-gun, Japan Seki, Akihiro, Nakakubiki-gun, Japan

NUMBER KIND DATE \_\_\_\_\_\_ US 2001038971 A1 20011108 US 2001-799052 A1 20010306 (9) PATENT INFORMATION: APPLICATION INFO .:

NUMBER DATE ------JP 2000-61350 20000307 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., Arlington

Courthouse Plaza I, Suite 1400, 2200 Clarendon

Boulevard, Arlington, VA, 22201

NUMBER OF CLAIMS: 1 EXEMPLARY CLAIM: 2083 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 21 OF 167 USPATFULL

2001:194079 USPATFULL ACCESSION NUMBER:

Chemical amplification type resist TITLE:

composition

Takeda, Takanobu, Nakakubiki-gun, Japan INVENTOR(S):

Watanabe, Osamu, Nakakubiki-gun, Japan

Watanabe, Jun, Nakakubiki-gun, Japan

Hatakeyama, Jun, Nakakubiki-gun, Japan Nishi, Tsunehiro, Nakakubiki-gun, Japan Kinsho, Takeshi, Nakakubiki-gun, Japan

PATENT ASSIGNEE(S):

Shin-Etsu Chemical Co., Ltd. (non-U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_\_ US 2001036593 A1 20011101 US 2001-760716 A1 20010117 PATENT INFORMATION: 20010117 (9) APPLICATION INFO.:

NUMBER DATE

PRIORITY INFORMATION:

JP 2000-7888 20000117

DOCUMENT TYPE: FILE SEGMENT:

Utility APPLICATION

LEGAL REPRESENTATIVE:

MILLEN, WHITE, ZELANO & BRANIGAN, P.C., ARLINGTON COURTHOUSE PLAZA I, SUITE 1400, 2200 CLARENDON

BOULEVARD, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM: LINE COUNT:

1033

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 22 OF 167 USPATFULL

ACCESSION NUMBER:

INVENTOR(S):

2001:192882 USPATFULL

TITLE:

Chemically amplified positive resist composition and patterning method Takeda, Takanobu, Niigata-ken, Japan Watanabe, Jun, Niigata-ken, Japan

Takemura, Katsuya, Niigata-ken, Japan Koizumi, Kenji, Niigata-ken, Japan

PATENT ASSIGNEE(S):

Shin-Etsu Chemical Co., Ltd., Chiyoda-ku, Japan

(non-U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_ US 2001035394 A1 20011101 US 2001-814049 A1 20010322 (9) PATENT INFORMATION: APPLICATION INFO.:

PRIORITY INFORMATION:

JP 2000-79414 20000322

NUMBER DATE

DOCUMENT TYPE: FILE SEGMENT:

Utility

LEGAL REPRESENTATIVE:

APPLICATION

MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

13

NUMBER OF DRAWINGS:

2 Drawing Page(s)

LINE COUNT:

2498

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 23 OF 167 USPATFULL

ACCESSION NUMBER:

2001:188362 USPATFULL

TITLE:

Chemical amplification, positive resist

compositions

INVENTOR(S):

Ohsawa, Youichi, Nakakubiki-gun, Japan Watanabe, Jun, Nakakubiki-gun, Japan Takeda, Takanobu, Nakakubiki-gun, Japan Seki, Akihiro, Nakakubiki-gun, Japan

NUMBER KIND DATE

PATENT INFORMATION: US 2001033994 A1 20011025 APPLICATION INFO.: US 2001-799009 A1 20010306 (9)

NUMBER DATE
PRIORITY INFORMATION: JP 2000-61357 20000307

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., Arlington

Courthouse Plaza 1, Suite 1400, 2200 Clarendon

Boulevard, Arlington, VA, 22201

NUMBER OF CLAIMS: 5
EXEMPLARY CLAIM: 1
LINE COUNT: 2076

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 24 OF 167 USPATFULL

ACCESSION NUMBER: 2001:188358 USPATFULL

TITLE: Resist compositions and patterning process INVENTOR(S): Hatakeyama, Jun, Niigata-ken, Japan

Ohsawa, Youichi, Niigata-ken, Japan Nishi, Tsunehiro, Niigata-ken, Japan Watanabe, Jun, Niigata-ken, Japan

PATENT ASSIGNEE(S): Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S.

corporation)

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., 2200 CLARENDON

BLVD., SUITE 1400, ARLINGTON, VA, 22201

NUMBER OF CLAIMS: 9
EXEMPLARY CLAIM: 1
LINE COUNT: 1431

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 25 OF 167 USPATFULL

ACCESSION NUMBER: 2001:188355 USPATFULL

TITLE: Chemically amplified positive resist composition

INVENTOR(S): Uetani, Yasunori, Osaka, Japan

Kim, Seong-Hyeon, Seaul, Korea, Republic of

APPLICATION INFO.: US 2000-726476 A1 20001201

NUMBER DATE

PRIORITY INFORMATION: JP 1999-344446 19991203 JP 2000-203648 20000705

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: 7
EXEMPLARY CLAIM: 1
LINE COUNT: 605

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 26 OF 167 USPATFULL

ACCESSION NUMBER: 2001:184995 USPATFULL

TITLE: Polymers containing oxygen and sulfur

alicyclic units and photoresist
compositions comprising same

INVENTOR(S): Barclay, George G., Jefferson, MA, United States

Yueh, Wang, Shrewsbury, MA, United States

PATENT ASSIGNEE(S): Shipley Company, L.L.C., Marlborough, MA, United States

(U.S. corporation)

PATENT INFORMATION: US 6306554 B1 20011023 APPLICATION INFO.: US 2000-567634 20000509 (9)

DOCUMENT TYPE: Utility FILE SEGMENT: GRANTED

FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Hamilton, Cynthia

LEGAL REPRESENTATIVE: Corless, Peter F., Frickey, Darryl P.Edwards & Angell,

LLP 45

NUMBER OF CLAIMS: 45 EXEMPLARY CLAIM: 1,16 LINE COUNT: 1128

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 27 OF 167 USPATFULL

ACCESSION NUMBER: 2001:182263 USPATFULL

TITLE: INVENTOR(S):

Chemical amplification resist compositions Takeda, Takanobu, Nakakubiki-gun, Japan Watanabe, Osamu, Nakakubiki-gun, Japan Hirahara, Kazuhiro, Nakakubiki-gun, Japan Takemura, Katsuya, Nakakubiki-gun, Japan Kusaki, Wataru, Nakakubiki-gun, Japan Seki, Akihiro, Nakakubiki-gun, Japan

NUMBER DATE

PRIORITY INFORMATION: JP 2000-64277 20000309

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., Suite 1400,

Arlington Courthouse Plaza, 2200 Clarendon Boulevard,

Arlington, VA, 22201

NUMBER OF CLAIMS: 4
EXEMPLARY CLAIM: 1
LINE COUNT: 942

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 28 OF 167 USPATFULL

ACCESSION NUMBER: 2001:178770 USPATFULL TITLE: Resin useful for resist,

resist composition and pattern forming process

using the same

INVENTOR(S): Okino, Takeshi, Yokohama, Japan

Asakawa, Koji, Kawasaki, Japan Shida, Naomi, Minato-Ku, Japan Ushirogouchi, Toru, Yokohama, Japan

Saito, Satoshi, Yamato, Japan

Kabushiki Kaisha Toshiba, Kawasaki, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ US 6303266 B1 20011016 US 1999-401181 19990923 PATENT INFORMATION:

19990923 (9) APPLICATION INFO .:

NUMBER DATE 

PRIORITY INFORMATION: JP 1998-269320 19980924

DOCUMENT TYPE: Utility

FILE SEGMENT: GRANTED PRIMARY EXAMINER: Ashton, Rosemary E.

LEGAL REPRESENTATIVE: Oblon, Spivak, McClelland, Maier & Neustadt, P.C.

NUMBER OF CLAIMS: 10 EXEMPLARY CLAIM:

NUMBER OF DRAWINGS: 5 Drawing Figure(s); 5 Drawing Page(s)

2905 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 29 OF 167 USPATFULL

2001:170853 USPATFULL ACCESSION NUMBER:

(Meth) acrylate derivative, polymer and TITLE: photoresist composition having lactone

structure, and method for forming pattern by using it

Maeda, Katsumi, Tokyo, Japan INVENTOR(S):

Iwasa, Shigeyuki, Tokyo, Japan Nakano, Kaichiro, Tokyo, Japan Hasegawa, Etsuo, Tokyo, Japan

NUMBER KIND DATE \_\_\_\_\_ US 2001026901 A1 20011004 US 2000-750116 A1 20001229 (9) PATENT INFORMATION: APPLICATION INFO .:

NUMBER DATE PRIORITY INFORMATION: JP 1998-188853 19980703 JP 1998-328491 19981118 WO 1999-JP3580 19990702

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICA APPLICATION

FILE SEGMENT: LEGAL REPRESENTATIVE: McGinn & Gibb, PLLC, Suite 200, 8321 Old Courthouse

Road, Vienna, VA, 22182-3817

23 NUMBER OF CLAIMS: EXEMPLARY CLAIM:

NUMBER OF DRAWINGS: 1 Drawing Page(s)

1084 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 30 OF 167 USPATFULL

2001:165553 USPATFULL ACCESSION NUMBER:

Photosensitive polymer including TITLE:

copolymer of alkyl vinyl ether and resist composition containing the same Choi, Sang-Jun, Seoul, Korea, Republic of

INVENTOR(S): Kim, Hyun-Woo, Seongnam-city, Korea, Republic of

NUMBER KIND DATE -----

PATENT INFORMATION: US 2001024763 A1 20010927 APPLICATION INFO.: US 2001-764150 A1 20010119 (9)

RELATED APPLN. INFO.: Continuation-in-part of Ser. No. US 2000-576053, filed

on 23 May 2000, PENDING

NUMBER DATE

PRIORITY INFORMATION:

KR 2000-20603 20000419 KR 2000-2489 20000119 US 2000-198761P 20000421 (60)

Utility DOCUMENT TYPE: APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: JONES VOLENTINE, LLC, SUITE 150, 12200 Sunrise Valley

Drive, RESTON, VA, 20191

NUMBER OF CLAIMS: 48 1 EXEMPLARY CLAIM:

NUMBER OF DRAWINGS: 2 Drawing Page(s)
1.THE COUNT: 1090

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 31 OF 167 USPATFULL

2001:162981 USPATFULL ACCESSION NUMBER:

Positive photoresist composition containing TITLE:

alicyclic dissolution inhibitors

Chang, Shang-Wern, Taipei, Taiwan, Province of China INVENTOR(S):

Li, Yen-Cheng, Sanchung, Taiwan, Province of China Lin, Shang-Ho, Taipei, Taiwan, Province of China Wang, Wen-Chieh, Chungho, Taiwan, Province of China

Everlight USA, Inc., Pineville, NC, United States (U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_\_\_

US 6294309 B1 20010925 US 2000-607943 20000630 (9) PATENT INFORMATION:
APPLICATION INFO.:
DOCUMENT TYPE:

DOCUMENT TYPE: Utility GRANTED FILE SEGMENT:

PRIMARY EXAMINER: Baxter, Janet
ASSISTANT EXAMINER: Ashton, Rosemary LEGAL REPRESENTATIVE: Bacon & Thomas

NUMBER OF CLAIMS: 15 EXEMPLARY CLAIM: 1 369 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 32 OF 167 USPATFULL

2001:160782 USPATFULL ACCESSION NUMBER:

Radiation-sensitive resin composition TITLE:

Numata, Jun, Tokyo, Japan INVENTOR(S): Suzuki, Aki, Tokyo, Japan

Hara, Hiromichi, Tokyo, Japan Natsume, Norihiro, Tokyo, Japan Murata, Kiyoshi, Tokyo, Japan Yamamoto, Masafumi, Tokyo, Japan Soyano, Akimasa, Tokyo, Japan Kajita, Toru, Tokyo, Japan

Shimokawa, Tsutomu, Tokyo, Japan

NUMBER KIND DATE \_\_\_\_\_\_ US 2001023050 A1 20010920 PATENT INFORMATION:

US 2001-774714 A1 20010201 (9) APPLICATION INFO.:

> NUMBER DATE \_\_\_\_\_

JP 2000-28456 20000204 JP 2000-273962 20000908 PRIORITY INFORMATION: JP 2000-273962

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: Supervisor, Patent Prosecution Services, PIPER MARBURY

RUDNICK & WOLFE LLP, 1200 Nineteenth Street, N.W.,

Washington, DC, 20036-2412

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 3425 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 33 OF 167 USPATFULL

ACCESSION NUMBER: 2001:157962 USPATFULL

Positive photosensitive composition TITLE: Kodama, Kunihiko, Shizuoka, Japan INVENTOR(S): Sato, Kenichiro, Shizuoka, Japan

Aoai, Toshiaki, Shizuoka, Japan

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Kanagawa, Japan (non-U.S.

corporation)

NUMBER KIND DATE \_\_\_\_\_ PATENT INFORMATION: US 6291130 B1 20010918 APPLICATION INFO.: US 1999-361568 19990727 (9)

NUMBER DATE \_\_\_\_\_ PRIORITY INFORMATION: JP 1998-211137 19980727
JP 1998-263392 19980917 JP 1999-6662 19990113 JP 1999-186809 19990630

Utility DOCUMENT TYPE: FILE SEGMENT: GRANTED PRIMARY EXAMINER: Ashton, Rosemary E.

LEGAL REPRESENTATIVE: Sughrue, Mion, Zinn, Macpeak & Seas, PLLC

NUMBER OF CLAIMS: 14 EXEMPLARY CLAIM: 1 2589 LINE COUNT:

INVENTOR(S):

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 34 OF 167 USPATFULL

ACCESSION NUMBER: 2001:147641 USPATFULL

Ester compounds, polymers, resist TITLE: compositions and patterning process

Kinsho, Takeshi, Nakakubiki-gun, Japan Nishi, Tsunehiro, Nakakubiki-gun, Japan

Kurihara, Hideshi, Usui-gun, Japan Nakashima, Mutsuo, Nakakubiki-gun, Japan Hasegawa, Koji, Nakakubiki-gun, Japan Watanabe, Takeru, Nakakubiki-gun, Japan

Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ PATENT INFORMATION: US 6284429 B1 20010904 APPLICATION INFO.: US 2000-512108 20000224 (9)

NUMBER DATE \_\_\_\_\_

JP 1999-47406 19990225 PRIORITY INFORMATION: 19990622 JP 1999-174945

DOCUMENT TYPE: Utility

FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Ashton, Rosemary E.

LEGAL REPRESENTATIVE: Millen, White, Zelano & Branigan, P.C

NUMBER OF CLAIMS: 19 EXEMPLARY CLAIM: 1 2016 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 35 OF 167 USPATFULL

2001:142055 USPATFULL ACCESSION NUMBER:

Photoresist compositions comprising blends of TITLE:

ionic and non-ionic photoacid

generators

Trefonas, III, Peter, Medway, MA, United States INVENTOR(S):

Shipley Company, L.L.C., Marlborough, MA, United States PATENT ASSIGNEE(S):

(U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_\_

PATENT INFORMATION: US 6280911 B1 20010828 APPLICATION INFO.: US 1998-150965 19980910 (9) APPLICATION INFO.:

DOCUMENT TYPE: Utility FILE SEGMENT: GRANTED

FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Ashton, Rosemary E.

LEGAL REPRESENTATIVE: Corless, Peter F., Frickey, Darryl P.Edwards & Angell,

LLP

10 NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 812 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 36 OF 167 USPATFULL

ACCESSION NUMBER: 2001:142042 USPATFULL

Lactone-containing compounds, polymers, TITLE:

resist compositions, and patterning method Hasegawa, Koji, Nakakubiki-gun, Japan INVENTOR(S):

Nishi, Tsunehiro, Nakakubiki-gun, Japan Kinsho, Takeshi, Nakakubiki-gun, Japan Hatakeyama, Jun, Nakakubiki-gun, Japan Watanabe, Osamu, Nakakubiki-gun, Japan

Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ US 6280898 B1 20010828 US 1999-404763 19990924 PATENT INFORMATION: 19990924 (9) APPLICATION INFO.:

NUMBER DATE

JP 1998-270373 19980925 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility GRANTED FILE SEGMENT:

PRIMARY EXAMINER: Baxter, Janet ASSISTANT EXAMINER: Ashton, Rosemary

LEGAL REPRESENTATIVE: Millen, White, Zelano & Branigan, P.C.

NUMBER OF CLAIMS: 21 EXEMPLARY CLAIM:

LINE COUNT: 1654

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 37 OF 167 USPATFULL

ACCESSION NUMBER: 2001:142041 USPATFULL

Photosensitive composition, method for forming pattern TITLE:

using the same, and method for manufacturing electronic

Asakawa, Koji, Kawasaki, Japan INVENTOR(S):

Kihara, Naoko, Matsudo, Japan Shida, Naomi, Kawasaki, Japan

Ushirogouchi, Toru, Yokohama, Japan

Okino, Takeshi, Yokohama, Japan Nakase, Makoto, Tokyo, Japan Naito, Takuya, Kawasaki, Japan Saito, Satoshi, Yokohama, Japan

Kabushiki Kaisha Toshiba, Kawasaki-shi, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ US 6280897 B1 20010828 US 1997-997623 19971223 PATENT INFORMATION: 19971223 (8) APPLICATION INFO .:

NUMBER DATE \_\_\_\_\_ PRIORITY INFORMATION:

JP 1996-344037 19961224 JP 1997-8819 19970121 JP 1997-189929 19970715

DOCUMENT TYPE: Utility FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Chu, John S.
LEGAL REPRESENTATION

LEGAL REPRESENTATIVE: Oblon, Spivak, McClelland, Maier & Neustadt, P.C.

NUMBER OF CLAIMS: 12 1,5,10 EXEMPLARY CLAIM:

NUMBER OF DRAWINGS: 6 Drawing Figure(s); 2 Drawing Page(s)

2966 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 38 OF 167 USPATFULL

2001:139256 USPATFULL ACCESSION NUMBER:

Chemically amplified positive resist TITLE:

composition

Nakanishi, Junji, Kyoto-shi, Japan INVENTOR(S):

Takata, Yoshiyuki, Osaka, Japan

NUMBER KIND DATE \_\_\_\_\_\_ PATENT INFORMATION: US 2001016298 A1 20010823 APPLICATION INFO.: US 2001-770212 A1 20010129 (9) APPLICATION INFO.:

NUMBER DATE JP 2000-21687 20000131 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1 591 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 39 OF 167 USPATFULL

2001:133979 USPATFULL ACCESSION NUMBER:

Chemically amplified positive resist TITLE:

composition

Uetani, Yasunori, Osaka, Japan INVENTOR(S):

Fujishima, Hiroaki, Osaka, Japan Takata, Yoshiyuki, Osaka, Japan

KIND DATE NUMBER -----

US 2001014428 A1 20010816 US 2000-741438 A1 20001221 (9) PATENT INFORMATION: APPLICATION INFO.:

> NUMBER DATE \_\_\_\_\_

PRIORITY INFORMATION: JP 1999-364726 19991222

DOCUMENT TYPE: Utility
FILE SEGMENT: APPLICATION FILE SEGMENT:

LEGAL REPRESENTATIVE: BIRCH STEWART KOLASCH & BIRCH, PO BOX 747, FALLS

CHURCH, VA, 22040-0747

NUMBER OF CLAIMS: 4 EXEMPLARY CLAIM: 1 584 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 40 OF 167 USPATFULL

ACCESSION NUMBER: 2001:125715 USPATFULL

Positive silicone-containing photosensitive composition

INVENTOR(S): Yasunami, Shoichiro, Shizuoka, Japan

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Kanagawa, Japan (non-U.S.

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ PATENT INFORMATION: US 6270941 B1 20010807 APPLICATION INFO.: US 2000-493285 20000128 20000128 (9)

NUMBER DATE \_\_\_\_\_ PRIORITY INFORMATION: JP 1999-20224 19990128 JP 1999-31591 19990209

JP 1999-31591

DOCUMENT TYPE: Utility
FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Ashton, Rosemary E.

LEGAL REPRESENTATIVE: Sughrue, Mion, Zinn, Macpeak & Seas, PLLC

NUMBER OF CLAIMS: 3 1 1359 EXEMPLARY CLAIM: LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 41 OF 167 USPATFULL

ACCESSION NUMBER: 2001:116737 USPATFULL

Alicyclic dissolution inhibitors and positive TITLE: potoresist composition containing the same

Chang, Shang-Wern, Taipei, Taiwan, Province of China INVENTOR(S):

Li, Yen-Cheng, Sanchung, Taiwan, Province of China Lin, Shang-Ho, Taipei, Taiwan, Province of China Wang, Wen-Chieh, Chungho, Taiwan, Province of China

Everlight USA. Inc., Pineville, NC, United States (U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE

PATENT INFORMATION: US 6265131 B1
APPLICATION INFO.: US 2000-541498
DOCUMENT TYPE: Utility

20010724 20000403 (9)

DOCUMENT TYPE:

GRANTED

FILE SEGMENT: GRANIED
PRIMARY EXAMINER: Ashton, Rosemary E.

LEGAL REPRESENTATIVE: Bacon & Thomas, PLLC

NUMBER OF CLAIMS: 14 EXEMPLARY CLAIM:

1 355

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 42 OF 167 USPATFULL

ACCESSION NUMBER:

2001:93685 USPATFULL

TITLE:

Preparation process for esters and resist

materials

INVENTOR(S):

Takechi, Satoshi, Kawasaki, Japan Kikukawa, Tadashi, Kyoto, Japan

PATENT ASSIGNEE(S):

Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation)

NUMBER KIND DATE -----

PATENT INFORMATION: APPLICATION INFO.:

US 6248920 B1 20010619 US 1997-996158 19971222 (8)

NUMBER DATE \_\_\_\_\_

PRIORITY INFORMATION: JP 1996-350765 19961227

DOCUMENT TYPE: Utility
FILE SEGMENT: GRANTED
PRIMARY EXAMINER: Geist, Gary
ASSISTANT EXAMINER: Oh, Taylor V.
LEGAL REPRESENTATIVE: Armstrong, Westerman, Hattori, McLeland & Naughton, LLP

NUMBER OF CLAIMS: 10 EXEMPLARY CLAIM: 1 LINE COUNT: 946

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 43 OF 167 USPATFULL

ACCESSION NUMBER: 2001:91622 USPATFULL

TITLE:

Polymer, resist composition and

patterning process

INVENTOR(S):

Hatakeyama, Jun, Nakakubiki-gun, Japan Kinsho, Takeshi, Nakakubiki-gun, Japan Nakashima, Mutsuo, Nakakubiki-gun, Japan Hasegawa, Koji, Nakakubiki-gun, Japan

NUMBER KIND DATE -----PATENT INFORMATION: US 2001003772 A1 20010614 US 2000-726592 A1 20001201 (9) APPLICATION INFO.:

NUMBER DATE PRIORITY INFORMATION: JP 1999-342380 19991201

DOCUMENT TYPE: Utility

APPLICATION

FILE SEGMENT:

LEGAL REPRESENTATIVE: MILLEN, WHITE, ZELANO & BRANIGAN, P.C., Arlington Courthouse Plaza I, Suite 1400, 2200 Clarendon

Boulevard, Arlington, VA, 22201

6 NUMBER OF CLAIMS:

EXEMPLARY CLAIM: 1 LINE COUNT: 1391

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 44 OF 167 USPATFULL

ACCESSION NUMBER:

2001:91491 USPATFULL

TITLE:

Chemically amplified resist compositions and process for the formation of resist patterns

INVENTOR(S):

Takechi, Satoshi, Kawasaki-shi, Japan Kotachi, Akiko, Kawasaki-shi, Japan Nozaki, Koji, Kawasaki-shi, Japan

Yano, Ei, Kawasaki-shi, Japan

Watanabe, Keiji, Kawasaki-shi, Japan Namiki, Takahisa, Kawasaki-shi, Japan Igarashi, Miwa, Kawasaki-shi, Japan Makino, Yoko, Kawasaki-shi, Japan Takahashi, Makoto, Kawasaki-shi, Japan

PATENT ASSIGNEE(S):

FUJITSU LIMITED, Kawasaki, Japan (non-U.S. corporation)

KIND DATE NUMBER \_\_\_\_\_\_\_ US 2001003640 A1 20010614 US 6329125 B2 20011211 US 2000-739259 A1 20001219 (9) PATENT INFORMATION:

APPLICATION INFO .:

Division of Ser. No. US 1997-969368, filed on 28 Nov RELATED APPLN. INFO.: 1997, GRANTED, Pat. No. US 6200725 Continuation-in-part

of Ser. No. US 1996-673739, filed on 27 Jun 1996,

GRANTED, Pat. No. US 6013416

NUMBER JP 1995-178717 19950714 JP 1995-162287 19950628 JP 1995-312722 19951130 JP 1996-50264 19960307 JP 1996-320105 19961129 PRIORITY INFORMATION:

DOCUMENT TYPE:

FILE SEGMENT:

APPLICATION

Utility

LEGAL REPRESENTATIVE:

ARMSTRONG, WESTERMAN, HATTORI,, MCLELAND & NAUGHTON, LLP, 1725 K STREET, NW, SUITE 1000, WASHINGTON, DC,

20006

NUMBER OF CLAIMS: EXEMPLARY CLAIM:

11 1

NUMBER OF DRAWINGS:

2 Drawing Page(s)

LINE COUNT:

4388

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 45 OF 167 USPATFULL

ACCESSION NUMBER:

2001:86189 USPATFULL

TITLE:

Positive resist composition

Aoai, Toshiaki, Shizuoka, Japan INVENTOR(S): Kondo, Shunichi, Shizuoka, Japan

Yamaoka, Tsuguo, Chiba, Japan Sato, Kenichiro, Shizuoka, Japan

PATENT ASSIGNEE(S):

Fuji Photo Film Co., Ltd., Kanagawa, Japan (non-U.S.

corporation)

NUMBER KIND DATE \_\_\_\_\_ US 6245485 B1 20010612 US 1998-75818 19980512 PATENT INFORMATION: 19980512 (9) APPLICATION INFO .:

NUMBER DATE

JP 1997-120919 19970512 JP 1997-260399 19970925 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility

FILE SEGMENT:

PRIMARY EXAMINER:

ASSISTANT EXAMINER:

LEGAL REPRESENTATIVE:

Sughrue, Mion, Zinn, Macpeak & Seas, PLLC

7

EXEMPLARY CLAIM: LINE COUNT: 2039

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 46 OF 167 USPATFULL

ACCESSION NUMBER: 2001:79255 USPATFULL

Chemical amplifying type positive resist TITLE:

composition

Fujishima, Hiroaki, Toyonaka, Japan INVENTOR(S):

Uetani, Yasunori, Toyonaka, Japan

Araki, Karou, Kyoto, Japan

PATENT ASSIGNEE(S): Sumitomo Chemical, Company Limited, Osaka, Japan

(non-U.S. corporation)

NUMBER KIND DATE PATENT INFORMATION: US 6239231 B1 20010529 APPLICATION INFO.: US 1999-384032 19990826 19990826 (9)

NUMBER DATE PRIORITY INFORMATION: JP 1998-240143 19980826

DOCUMENT TYPE: Utility
FILE SEGMENT: Granted
PRIMARY EXAMINER: Lipman, Bernard

LEGAL REPRESENTATIVE: Birch, Stewart, Kolasch & Birch, LLP

NUMBER OF CLAIMS: 16 EXEMPLARY CLAIM: 1 860 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 47 OF 167 USPATFULL

ACCESSION NUMBER: 2001:63853 USPATFULL

Positive-working photoresist composition TITLE:

Hada, Hideo, Hiratsuka, Japan INVENTOR(S): Sato, Kazufumi, Sagamihara, Japan Komano, Hiroshi, Samukawa-machi, Japan

PATENT ASSIGNEE(S): Tokyo Ohka Kogyo Co., Ltd., Kanagawa-ken, Japan

(non-U.S. corporation)

NUMBER KIND DATE \_\_\_\_\_\_ PATENT INFORMATION: US 6225476 B1 20010501 APPLICATION INFO.: US 2000-542952 20000404 (9)

RELATED APPLN. INFO.: Division of Ser. No. US 1998-102622, filed on 23 Jun

1998, now patented, Pat. No. US 6087063

NUMBER DATE \_\_\_\_\_\_ PRIORITY INFORMATION: JP 1997-171947 19970627

DOCUMENT TYPE: Utility Granted FILE SEGMENT: PRIMARY EXAMINER: Trinh, Ba K.

LEGAL REPRESENTATIVE: Wenderoth, Lind & Ponack, L.L.P.

NUMBER OF CLAIMS: 2 EXEMPLARY CLAIM: LINE COUNT: 781 CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 48 OF 167 USPATFULL

ACCESSION NUMBER: 2001:43900 USPATFULL

TITLE: Chemically amplified resist material and process for the formation of resist patterns

INVENTOR(S): Takechi, Satoshi, Kawasaki, Japan

Hanyu, Isamu, Kawasaki, Japan

PATENT ASSIGNEE(S): Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation)

DOCUMENT TYPE: Utility
FILE SEGMENT: Granted
PRIMARY EXAMINER: Chu, John S.

LEGAL REPRESENTATIVE: Armstrong, Westerman, Hattori, McLeland & Naughton, LLP

NUMBER OF CLAIMS: 8
EXEMPLARY CLAIM: 1
LINE COUNT: 947

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 49 OF 167 USPATFULL

ACCESSION NUMBER: 2001:36574 USPATFULL

TITLE: Chemically amplified resist compositions and

process for the formation of resist patterns

INVENTOR(S):

Takechi, Satoshi, Kawasaki, Japan
Kotachi, Akiko, Kawasaki, Japan
Nozaki, Koji, Kawasaki, Japan
Yano, Ei, Kawasaki, Japan

Watanabe, Keiji, Kawasaki, Japan Namiki, Takahisa, Kawasaki, Japan Igarashi, Miwa, Kawasaki, Japan Makino, Yoko, Kawasaki, Japan Takahashi, Makoto, Kawasaki, Japan

PATENT ASSIGNEE(S): Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation)

PATENT INFORMATION: US 6200725 B1 20010313 APPLICATION INFO.: US 1997-969368 19971128 (8)

RELATED APPLN. INFO.: Continuation-in-part of Ser. No. US 1996-673739, filed

on 27 Jun 1996, now patented, Pat. No. US 6013416

DOCUMENT TYPE: Utility FILE SEGMENT: Granted

PRIMARY EXAMINER: Hamilton, Cynthia

LEGAL REPRESENTATIVE: Armstrong, Westerman, Hattori, McLeland & Naughton

NUMBER OF CLAIMS: 8
EXEMPLARY CLAIM: 1

NUMBER OF DRAWINGS: 2 Drawing Figure(s); 2 Drawing Page(s)

LINE COUNT: 4312

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 50 OF 167 USPATFULL

ACCESSION NUMBER: 2000:164240 USPATFULL TITLE: Positive resist composition

INVENTOR(S): Takeda, Takanobu, Nakakubiki-gun, Japan

Watanabe, Osamu, Nakakubiki-gun, Japan Watanabe, Jun, Nakakubiki-gun, Japan Hatakeyama, Jun, Nakakubiki-gun, Japan Ohsawa, Youichi, Nakakubiki-gun, Japan Ishihara, Toshinobu, Nakakubiki-gun, Japan

PATENT ASSIGNEE(S): Shin-Etsu Chemical Co., Ltd., Tokyo, Japan (non-U.S.

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ PATENT INFORMATION: US 6156481 APPLICATION INFO.: US 1999-428911 20001205 19991028 (9)

NUMBER DATE -----

JP 1998-307727 19981029 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility FILE SEGMENT: Granted PRIMARY EXAMINER: Baxter, Janet
ASSISTANT EXAMINER: Ashton, Rosemary
LEGAL REPRESENTATIVE: Millen, White, Zelano & Branigan, P.C.

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1
TIME COUNT: 846

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 51 OF 167 USPATFULL

ACCESSION NUMBER: 2000:142068 USPATFULL TITLE: Polymers and photoresist compositions comprising same

INVENTOR(S): Trefonas, III, Peter, Medway, MA, United States

Taylor, Gary N., Northboro, MA, United States Barclay, George G., Jefferson, MA, United States

Shipley Company, L.L.C., Marlborough, MA, United States PATENT ASSIGNEE(S):

(U.S. corporation)

NUMBER KIND DATE -----PATENT INFORMATION: US 6136501 20001024
APPLICATION INFO.: US 1998-143462 19980828 (9)
DOCUMENT TYPE: Utility

DOCUMENT TYPE: FILE SEGMENT: Granted PRIMARY EXAMINER: Chu, John S.
ASSISTANT EXAMINER: Clarke, Yvette M

LEGAL REPRESENTATIVE: Corless, Peter F., Frickey, Darryl P., Cairns, S.

Matthew

NUMBER OF CLAIMS: 30 EXEMPLARY CLAIM: 1,20 865 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 52 OF 167 USPATFULL

2000:87893 USPATFULL ACCESSION NUMBER:

TITLE: Positive-working photoresist composition

Hada, Hideo, Hiratsuka, Japan INVENTOR(S): Sato, Kazufumi, Sagamihara, Japan Komano, Hiroshi, Samukawa-machi, Japan PATENT ASSIGNEE(S): Tokyo Ohka Kogyo Co., Ltd., Japan (non-U.S.

corporation)

NUMBER DATE

PRIORITY INFORMATION: JP 1997-171947 19970627

DOCUMENT TYPE: Utility
FILE SEGMENT: Granted
PRIMARY EXAMINER: Chu, John S.

LEGAL REPRESENTATIVE: Wenderoth, Lind & Ponack, L.L.P.

NUMBER OF CLAIMS: 14
EXEMPLARY CLAIM: 1
LINE COUNT: 832

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 53 OF 167 USPATFULL

ACCESSION NUMBER: 2000:77160 USPATFULL

TITLE: Positive-working resist composition

INVENTOR(S): Hada, Hideo, Hiratsuka, Japan

Sato, Kazufumi, Sagamihara, Japan Komano, Hiroshi, Kanagawa-ken, Japan Nakayama, Toshimasa, Chigasaki, Japan

PATENT ASSIGNEE(S): Tokyo Ohka Kogyo Co., Ltd., Japan (non-U.S.

corporation)

RELATED APPLN. INFO.: Division of Ser. No. US 1997-912123, filed on 15 Aug

1997, now patented, Pat. No. US 5929271

PRIORITY INFORMATION: JP 1996-DOCUMENT TYPE: Utility FILE SEGMENT: Granted

PRIMARY EXAMINER: Baxter, Janet
ASSISTANT EXAMINER: Ashton, Rosemary

LEGAL REPRESENTATIVE: Wenderoth, Lind & Ponack, L.L.P.

NUMBER OF CLAIMS: 10 EXEMPLARY CLAIM: 1 LINE COUNT: 760

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 54 OF 167 USPATFULL

ACCESSION NUMBER: 2000:50504 USPATFULL

TITLE: Composition for underlying film and method of forming a

pattern using the film

INVENTOR(S): Sato, Yasuhiko, Yokohama, Japan Onishi, Yasunobu, Yokohama, Japan

PATENT ASSIGNEE(S): Kabushiki Kaisha Toshiba, Kawasaki, Japan (non-U.S.

corporation)

NUMBER DATE

PRIORITY INFORMATION: JP 1997-178671 19970703

DOCUMENT TYPE: Utility FILE SEGMENT: Granted

PRIMARY EXAMINER: Baxter, Janet
ASSISTANT EXAMINER: Clarke, Yvette M

LEGAL REPRESENTATIVE: Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P.

NUMBER OF CLAIMS: 10 EXEMPLARY CLAIM: 1

NUMBER OF DRAWINGS: 39 Drawing Figure(s); 6 Drawing Page(s)

LINE COUNT: 2350

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 55 OF 167 USPATFULL

ACCESSION NUMBER: 2000:37549 USPATFULL

TITLE: Positive working photosensitive composition

INVENTOR(S): Aoai, Toshiaki, Shizuoka, Japan Tan, Shiro, Shizuoka, Japan

Sato, Kenichiro, Shizuoka, Japan

PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Kanagawa, Japan (non-U.S.

corporation)

PATENT INFORMATION: US 6042991 20000328 APPLICATION INFO.: US 1998-25451 19980218 (9)

NUMBER DATE

PRIORITY INFORMATION: JP 1997-33958 19970218 JP 1997-46000 19970228

DOCUMENT TYPE: Utility
FILE SEGMENT: Granted
PRIMARY EXAMINER: Le, Hoa Van
ASSISTANT EXAMINER: Lee, Sin J.

LEGAL REPRESENTATIVE: Sughrue, Mion, Zinn, Macpeak & Seas, PLLC

NUMBER OF CLAIMS: 8
EXEMPLARY CLAIM: 1
LINE COUNT: 2172

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 56 OF 167 USPATFULL

ACCESSION NUMBER: 2000:4579 USPATFULL

TITLE: Chemically amplified resist compositions and process for the formation of resist patterns

INVENTOR(S): Nozaki, Koji, Kawasaki, Japan

Yano, Ei, Kawasaki, Japan

Watanabe, Keiji, Kawasaki, Japan Namiki, Takahisa, Kawasaki, Japan Igarashi, Miwa, Kawasaki, Japan Kuramitsu, Yoko, Kawasaki, Japan Takechi, Satoshi, Kawasaki, Japan Kotachi, Akiko, Kawasaki, Japan Takahashi, Makoto, Kawasaki, Japan

PATENT ASSIGNEE(S): Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation)

NUMBER KIND DATE
-----PATENT INFORMATION: US 6013416 20000111
APPLICATION INFO.: US 1996-673739 19960627 (8)

NUMBER DATE \_\_\_\_\_ PRIORITY INFORMATION:

JP 1995-162287 19950628 JP 1995-178717 19950714 JP 1995-312722 19951130 JP 1996-50264 19960307

DOCUMENT TYPE: Utility

FILE SEGMENT: Granted
PRIMARY EXAMINER: Hamilton, Cynthia

LEGAL REPRESENTATIVE: Armstrong, Westerman Hattori, McLeland & Naughton

NUMBER OF CLAIMS: 15 EXEMPLARY CLAIM: 1 3627 LINE COUNT:

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 57 OF 167 USPATFULL

ACCESSION NUMBER: 2000:1669 USPATFULL Resist composition TITLE:

Abe, Nobunori, Kanagawa, Japan INVENTOR(S):

Matsuno, Shugo, Tokyo, Japan Tanaka, Hideyuki, Tokyo, Japan Sugimoto, Tatsuya, Kanagawa, Japan Wada, Yasumasa, Kanagawa, Japan

Nippon Zeon Co., Ltd., Tokyo, Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_\_ US 6010826 20000104 WO 9612216 19960425 PATENT INFORMATION: US 1997-817358 WO 1995-JP2114 19970411 APPLICATION INFO.: 19951013 19970411 PCT 371 date

19970411 PCT 102(e) date

NUMBER DATE \_\_\_\_\_ JP 1994-27445719941013JP 1995-2125019950113JP 1995-8472919950316 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility Granted

FILE SEGMENT: Granted
PRIMARY EXAMINER: Hamilton, Cynthia
LEGAL REPRESENTATIVE: Dinsmore & Shohl LLP

NUMBER OF CLAIMS: 30
EXEMPLARY CLAIM: 1,3
LINE COUNT: 324 LINE COUNT: 2242

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 58 OF 167 USPATFULL

1999:128329 USPATFULL ACCESSION NUMBER:

Chemically amplified resist compositions and TITLE: process for the formation of resist patterns

Nozaki, Koji, Kawasaki, Japan INVENTOR(S):

Yano, Ei, Kawasaki, Japan

Watanabe, Keiji, Kawasaki, Japan Namiki, Takahisa, Kawasaki, Japan Igarashi, Miwa, Kawasaki, Japan Kuramitsu, Yoko, Kawasaki, Japan Takechi, Satoshi, Kawasaki, Japan Kotachi, Akiko, Kawasaki, Japan Takahashi, Makoto, Kawasaki, Japan

Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation) PATENT ASSIGNEE(S):

NUMBER KIND DATE \_\_\_\_\_\_

PATENT INFORMATION: US 5968713 19991019 APPLICATION INFO.: US 1997-896833 19970718 (8)

RELATED APPLN. INFO.: Division of Ser. No. US 1996-673739, filed on 27 Jun

1996

NUMBER DATE \_\_\_\_\_

PRIORITY INFORMATION:

JP 1995-162287 19950628 JP 1995-178717 19950714 JP 1995-312722 19951130 JP 1996-50264 19960307

Utility DOCUMENT TYPE: FILE SEGMENT: Granted

FILE SEGMENT: Granted
PRIMARY EXAMINER: Hamilton, Cynthia

LEGAL REPRESENTATIVE: Armstrong, Westerman, Hattori, McLeland, and, Naughton

NUMBER OF CLAIMS: EXEMPLARY CLAIM: 1,11 LINE COUNT: 3663

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 59 OF 167 USPATFULL

ACCESSION NUMBER: 1999:85622 USPATFULL

Compounds for use in a positive-working resist TITLE:

composition

Hada, Hideo, Hiratsuka, Japan INVENTOR(S): Sato, Kazufumi, Sagamihara, Japan

Komano, Hiroshi, Kanagawa-ken, Japan Nakayama, Toshimasa, Chigasaki, Japan

Tokyo Ohka Kogyo Co., Ltd., Japan (non-U.S. PATENT ASSIGNEE(S):

corporation)

NUMBER KIND DATE \_\_\_\_\_

PATENT INFORMATION: US 5929271 19990727 APPLICATION INFO.: US 1997-912123 19970815 19970815 (8) APPLICATION INFO.:

NUMBER DATE

JP 1996-218803 19960820 PRIORITY INFORMATION:

DOCUMENT TYPE: Utility Granted FILE SEGMENT:

PRIMARY EXAMINER: Barts, Samuel ASSISTANT EXAMINER: Keys, Rosalynd LEGAL REPRESENTATIVE: Wenderoth, Line

Wenderoth, Lind & Ponack, L.L.P.

NUMBER OF CLAIMS: EXEMPLARY CLAIM: LINE COUNT: 703

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 60 OF 167 USPATFULL

1999:65150 USPATFULL ACCESSION NUMBER:

Resist composition, a process for forming a TITLE: resist pattern and a process for manufacturing

a semiconductor device

Nozaki, Koji, Kawasaki, Japan INVENTOR(S):

Yano, Ei, Kawasaki, Japan

Watanabe, Keiji, Kawasaki, Japan Namiki, Takahisa, Kawasaki, Japan Igarashi, Miwa, Kawasaki, Japan

Fujitsu Limited, Kawasaki, Japan (non-U.S. corporation) PATENT ASSIGNEE(S):

.7 ANS PI	WER 12 ( US 2002	OF 167 US 2004178	PATFULL A1 20020110
L17 A PI	NSWER 13 US 2003	3 OF 167 1051316	USPATFULL A1 20011213
		4 OF 167 1051315	USPATFULL A1 20011213
L17 A	NSWER 19	5 OF 167 1049075	USPATFULL A1 20011206
		6 OF 167 1046641	USPATFULL A1 20011129
		7 OF 167 1044072	USPATFULL A1 20011122
L17 A	NSWER 1	8 OF 167 1044071	USPATFULL A1 20011122
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L17 A	NSWER 2 US 200	1 OF 167 1036593	USPATFULL A1 20011101
L17 A	NSWER 2 US 200	2 OF 167 1035394	USPATFULL A1 20011101
		3 OF 167 1033994	USPATFULL A1 20011025
		4 OF 167 1033990	USPATFULL A1 20011025
L17 P	NSWER 2 US 200	5 OF 167 1033987	USPATFULL A1 20011025
	NSWER 2 US 630		USPATFULL B1 20011023
L17 F PI	NSWER 2 US 200	7 OF 167 1031421	USPATFULL Al 20011018
L17 F PI	NSWER 2 US 630	8 OF 167 3266	USPATFULL B1 20011016
L17 A		9 OF 167 1026901	USPATFULL A1 20011004
		0 OF 167 1024763	USPATFULL Al 20010927
L17 A	ANSWER 3 US 629		USPATFULL B1 20010925
L17 A		2 OF 167 1023050	USPATFULL A1 20010920

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	ANSWER 33 OF 167 US 6291130	
L17	ANSWER 34 OF 167	USPATFULL
PI	US 6284429	B1 20010904
L17	ANSWER 35 OF 167	USPATFULL
PI	US 6280911	B1 20010828
L17	ANSWER 36 OF 167	USPATFULL
PI	US 6280898	B1 20010828
L17	ANSWER 37 OF 167	USPATFULL
PI	US 6280897	B1 20010828
	ANSWER 38 OF 167 US 2001016298	
L17	ANSWER 39 OF 167	USPATFULL
PI	US 2001014428	A1 20010816
L17	ANSWER 40 OF 167	USPATFULL
PI	US 6270941	B1 20010807
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	ANSWER 42 OF 167 US 6248920	
L17	ANSWER 43 OF 167	USPATFULL
PI	US 2001003772	A1 20010614
L17 PI	ANSWER 44 OF 167 US 2001003640 US 6329125	USPATFULL A1 20010614 B2 20011211
	ANSWER 45 OF 167 US 6245485	USPATFULL B1 20010612
	ANSWER 46 OF 167 US 6239231	
L17	ANSWER 47 OF 167	USPATFULL
PI	US 6225476	B1 20010501
L17	ANSWER 48 OF 167	USPATFULL
PI	US 6207342	B1 20010327
	ANSWER 49 OF 167 US 6200725	USPATFULL B1 20010313
L17	ANSWER 50 OF 167	USPATFULL
PI	US 6156481	20001205
L17	ANSWER 51 OF 167	USPATFULL
PI	US 6136501	20001024
L17	ANSWER 52 OF 167	USPATFULL
PI	US 6087063	20000711
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PI	US 6077644	20000620

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L17 ANSWER 54 OF 167 USPATFULL
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      US 6054254
L17 ANSWER 55 OF 167 USPATFULL
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     US 6042991
L17 ANSWER 56 OF 167 USPATFULL
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       US 6010826
       WO 9612216 19960425
L17 ANSWER 58 OF 167 USPATFULL
                         19991019
     US 5968713
PΤ
L17 ANSWER 59 OF 167 USPATFULL
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     US 5929271
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                                  19990608
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L17 ANSWER 61 OF 167 CAPLUS COPYRIGHT 2002 ACS
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                                          JP 2001-211147
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     JP 2002082441 A2 20020322
                                                                   20010711
PΤ
                                               US 2001-901569
                        A1 20020411
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     US 2002042016
L17 ANSWER 62 OF 167 CAPLUS COPYRIGHT 2002 ACS
     PATENT NO. KIND DATE APPLICATION NO. DATE
     WO 2002019033 A2 20020307 WO 2001-US26438 20010824
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RW: GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZW, AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR, BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG
L17 ANSWER 63 OF 167 CAPLUS COPYRIGHT 2002 ACS
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     EP 1182506 A1 20020227 EP 2001-306923 20010814
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         R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,
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     JP 2002062655 A2 20020228
JP 2002062656 A2 20020228
US 2002034704 A1 20020321
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US 2001-928399 20010814
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     ANSWER 65 OF 167 CAPLUS COPYRIGHT 2002 ACS
L17
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                               20020215 JP 2000-233146 20000801
     JP 2002049154 A2
PΙ
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L17	ANSWER 66 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	EP 1179750 R: AT, BE, 0	A1 20020213	EP 2001-117796 GB, GR, IT, LI, LU,	20010802
L17	ANSWER 67 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2002040661	A2 20020206	JP 2000-221889	20000724
=> d	117 68-167 pi			
L17	ANSWER 68 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2002023376	A2 20020123	JP 2000-208514	20000710
L17	ANSWER 69 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 2002023375	A2 20020123	JP 2000-208513	20000710
L17	ANSWER 70 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2002023372	A2 20020123	JP 2000-206901	20000707
L17	PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
ΡΙ	EP 1167349 R: AT, BE,	A1 20020102 CH, DE, DK, ES, FR,	EP 2001-114724 GB, GR, IT, LI, LU US 2001-886386	20010621 , NL, SE, MC, PT,
L17	PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001356478	A2 20011226	JP 2000-175519	20000612
L17	ANSWER 73 OF 167 PATENT NO.	CAPLUS COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	EP 1154321 R: AT, BE,	A1 20011114 CH, DE, DK, ES, FR,	EP 2001-1101/9 GB, GR, IT, LI, LU	, NL, SE, MC, PT,
	JP 2002030067 US 2002006582	LT, LV, FI, RO A2 20020129 A1 20020117	JP 2000-255119 US 2001-849523	20000825 20010507
L17	ANSWER 74 OF 167	CAPLUS COPYRIGHT	2002 ACS	
L17	ANSWER 75 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 2001290276	A2 20011019	JP 2000-383801	20001218
L17	PATENT NO.	CAPLUS COPYRIGHT KIND DATE	APPLICATION NO.	DATE
PI	EP 1143299	A1 20011010	EP 2001-107747	20010402

	דר פד ו	CH, DE, DK, ES, FR, LT, LV, FI, RO		
	CN 1316675 US 2001044070	A 20011010 A1 20011122	CN 2001-110230 US 2001-824227	20010402 20010403
L17	ANSWER 77 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE 20010907	2002 ACS APPLICATION NO.	DATE
PI	JP 2001242627	A2 20010907	JP 2000-51811	20000228
L17	ANSWER 78 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001242626	A2 20010907	JP 2000-51687	20000228
L17	ANSWER 79 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001240625	A2 20010904	JP 2000-49549	20000225
L17	ANSWER 80 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001235867	A2 20010831	JP 2000-47907	20000224
L17	ANSWER 81 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001235866	A2 20010831	JP 2000-47815	20000224
L17	ANSWER 82 OF 167	CAPLUS COPYRIGHT	2002 ACS	
L17	ANSWER 83 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001215709	A2 20010810	JP 2000-29257	20000207
L17	PATENT NO.	CAPLUS COPYRIGHT KIND DATE	APPLICATION NO.	DATE
PI	JP 2001188352	A2 20010710		
L17	ANSWER 85 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001188346	A2 20010710	JP 2000-89903	20000328
L17	ANSWER 86 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001166478	A2 20010622	JP 1999-344910	19991203
L17	ANSWER 87 OF 167 PATENT NO.	CAPLUS COPYRIGHT KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001166474	A2 20010622	JP 1999-344911	19991203
L17	PATENT NO.	CAPLUS COPYRIGHT KIND DATE	APPLICATION NO.	DATE
PI	JP 2001131232	A2 20010515	JP 1999-312329	19991102
L17	ANSWER 89 OF 167	CAPLUS COPYRIGHT	2002 ACS	

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 2001131143	A2	20010515	JP 1999-313470	19991104
L17	ANSWER 90 OF 167 PATENT NO.	CAPL KIND	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001125269	A2	20010511	JP 1999-307366	19991028
L17		CAPL KIND	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001117232	A2	20010427	JP 1999-297145	19991019
L17	ANSWER 92 OF 167 PATENT NO.	CAPL KIND	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001109154	A2	20010420	JP 1999-285762	19991006
L17	ANSWER 93 OF 167 PATENT NO.	CAPL	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001075285	A2	20010323	JP 2000-231006	20000731
L17	ANSWER 94 OF 167 PATENT NO.	CAPLI KIND	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	EP 1085379 R: AT, BE, ( IE, SI, I	A1 CH, DE, LT, LV,	20010321 , DK, ES, FR, , FI, RO	EP 2000-120000 GB, GR, IT, LI, LU	20000914 , NL, SE, MC, P
	JP 2001109157 JP 2001209181	A2 A2	20010420 20010803	JP 1999-291291 JP 2000-277966	19991013 20000913
L17	ANSWER 95 OF 167 PATENT NO.	KIND	DATE	2002 ACS APPLICATION NO.	DATE
ΡI				JP 1999-242053	
L17	ANSWER 96 OF 167 PATENT NO.			2002 ACS APPLICATION NO.	DATE
ΡI				JP 1999-234239	
L17	ANSWER 97 OF 167 PATENT NO.	KIND	DATE	2002 ACS APPLICATION NO.	DATE
PI				JP 1999-211370	
L17	ANSWER 98 OF 167 PATENT NO.	KIND	DATE	2002 ACS APPLICATION NO.	
PI				JP 1999-211369	
L17	ANSWER 99 OF 167 PATENT NO.	KIND		2002 ACS APPLICATION NO.	DATE
PI	JP 2001042533			JP 1999-211368	19990726
L17	ANSWER 100 OF 167 PATENT NO.	KIND	DATE	APPLICATION NO.	DATE

L17	ANSWER 101 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001033969 A2 20010209	JP 1999-203676	19990716
L17	ANSWER 102 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001027807 A2 20010130	JP 1999-199210	19990713
L17	ANSWER 103 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
PI		JP 1999-193603	19990707
L17	ANSWER 104 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 2001022071 A2 20010126	JP 1999-193602	19990707
L17	ANSWER 105 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 2001022070 A2 20010126	JP 1999-193601	19990707
L17	ANSWER 106 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
ΡI		WO 2000-JP4623	20000711
	PT, SE	· ·	
L17	ANSWER 107 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	APPLICATION NO.	DATE
PI	JP 2001013686 A2 20010119	JP 1999-186607	19990630
L17	ANSWER 108 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 2001005184 A2 20010112	JP 1999-175976	19990622
L17	PATENT NO. KIND DATE	APPLICATION NO.	DATE
ΡI	JP 2000321772 A2 20001124	JP 1999-128838	19990510
L17	ANSWER 110 OF 167 CAPLUS COPYRIGHT PATENT NO. KIND DATE	2002 ACS APPLICATION NO.	DATE
PI	70 00001104	JP 1999-127296	19990507
L17	ANSWER 111 OF 167 CAPLUS COPYRIGHT	2002 ACS	
L17	ANSWER 112 OF 167 CAPLUS COPYRIGHT	2002 ACS	
L17	ANSWER 113 OF 167 CAPLUS COPYRIGHT	2002 ACS	
L17	ANSWER 114 OF 167 CAPLUS COPYRIGHT	2002 ACS	
L17	ANSWER 115 OF 167 CAPLUS COPYRIGHT	2002 ACS	

ΡI	JP 2000187327 A2 20000	704 JP	1998-327056	19981117	
L17	ANSWER 130 OF 167 CAPLUS C	OPYRIGHT 200: AP	2 ACS PLICATION NO.	DATE	
PI		704 JP	1998-367619	19981224	
L17	ANSWER 131 OF 167 CAPLUS C PATENT NO. KIND DATE	OPYRIGHT 200 AP	2 ACS PLICATION NO.	DATE	
PI	JP 2000181054 A2 20000	630 JP	1998-327055	19981117	
L17	ANSWER 132 OF 167 CAPLUS C PATENT NO. KIND DATE	OPYRIGHT 200 AP	2 ACS PLICATION NO.	DATE	
PI	ANSWER 132 OF 167 CAPLUS COPATENT NO. KIND DATE  JP 2000159758 A2 20000 KR 2000023368 A 20000 TW 442706 B 20010	613 JP 425 KR 623 TW	1999-255167 1999-40854 1999-88116425	19990909 19990922 19990923	
	ANSWER 133 OF 167 CAPLUS CPATENT NO. KIND DATE	OPYRIGHT 200	2 ACS		
PI	JP 2000147776 A2 20000	526 JP	1998-327054	19981117	
L17	ANSWER 134 OF 167 CAPLUS C PATENT NO. KIND DATE	OPYRIGHT 200	2 ACS PLICATION NO.	DATE	
ΡI	JP 2000147775 A2 20000	526 JP	1998-327052	19981117	
	ANSWER 135 OF 167 CAPLUS C PATENT NO. KIND DATE	AP	PLICATION NO.	DATE	
PI	JP 2000122294 A2 20000 JP 2001188351 A2 20010	1428 JP 1710 JP	1999-70591 2000-351365	19990316 19990316	
L17		OPYRIGHT 200	2 ACS		
PI	EP 982628 A2 20000	)301 EP )503	1999-116705	19990825	
	R: AT, BE, CH, DE, DK,	ES, FR, GB,			MC, PT,
	CN 1245910 A 20000 JP 2000137327 A2 20000 US 6239231 B1 20010	0301 CN	1999-111698	19990824 19990825	
	US 6239231 B1 20010	529 US	1999-384032	19990826	
L17	ANSWER 137 OF 167 CAPLUS OF PATENT NO. KIND DATE DATE DE 2000029219 A2 20000	COPYRIGHT 200	2 ACS PLICATION NO.	DATE	
PI	JP 2000029219 A2 20000	)128 JP	1998-197730	19980713	
L17	ANSWER 138 OF 167 CAPLUS C	COPYRIGHT 200	2 ACS PLICATION NO.	DATE	
ΡI	JP 2000029218 A2 20000	)128 JP	1998-197729	19980713	
L17	ANSWER 139 OF 167 CAPLUS C	COPYRIGHT 200 AP	2 ACS PLICATION NO.	DATE	
ΡI	JP 2000029216 A2 20000	)128 JP	1998-194566	19980709	
L17	ANSWER 140 OF 167 CAPLUS OF PATENT NO. KIND DATE	COPYRIGHT 200 AF	2 ACS PLICATION NO.	DATE .	

L17	ANSWER 116 OF 167 CAP	LUS COPYRIGHT	2002 ACS	
L17	ANSWER 117 OF 167 CAPPATENT NO. KIND	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
ΡI				
L17		LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	PATENT NO. KIND JP 2000275840 A2	20001006	JP 1999-83403	19990326
L17	ANSWER 119 OF 167 CAPPERSON OF THE CAPPERSON OF T			DATE
PI		20001006	JP 1999-82404	19990325
L17	ANSWER 120 OF 167 CAPI PATENT NO. KIND	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	EP 1041442 A1	20001004	EP 2000-105938	20000323
	R: AT, BE, CH, DE, IE, SI, LT, LV,	.¤T .₽Λ		
	JP 2001192569 A2 CN 1268680 A	20010717 20001004	JP 2000-60057 CN 2000-103514	20000306 20000324
	US 6348297 B1	20020219	US 2000-533986	20000324
L17	ANSWER 121 OF 167 CAPI PATENT NO. KIND	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	EP 1035441 A1 R: AT, BE, CH, DE,	20000913	EP 2000-104965	20000308
	JP 2000321774 A2 JP 2002072487 A2 US 2001049075 A1	FI, RO 20001124	JP 2000-40647	20000218
L17	ANSWER 122 OF 167 CAPI	US COPYRIGHT	2002 ACS	
L17	ANSWER 123 OF 167 CAPI	US COPYRIGHT	2002 ACS	
L17	ANSWER 124 OF 167 CAPI	LUS COPYRIGHT	2002 ACS	
L17	ANSWER 125 OF 167 CAPI	US COPYRIGHT	2002 ACS	
L17	ANSWER 126 OF 167 CAPI PATENT NO. KIND			DATE
PI	JP 2000227659 A2			
L17	ANSWER 127 OF 167 CAPL PATENT NO. KIND			DATE
PI	JP 2000214588 A2			
L17	ANSWER 128 OF 167 CAPL PATENT NO. KIND			DATE
PI	JP 2000194135 A2			
L17	ANSWER 129 OF 167 CAPL PATENT NO. KIND	US COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE

ΡI	JP 11352693	A2 19	9991224	JP 1998-159267	19980608
L17	ANSWER 141 OF 16 PATENT NO.	67 CAPLUS KIND DA	COPYRIGHT	2002 ACS APPLICATION NO.	DATE
ΡI	JP 11295894	A2 19	9991029	APPLICATION NO.  JP 1998-96205	19980408
L17	ANSWER 142 OF 10 PATENT NO.	67 CAPLUS KIND DA	COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	JP 11271974	A2 19	9991008	JP 1998-74295	19980323
L17	ANSWER 143 OF 10 PATENT NO.	67 CAPLUS	COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	JP 11258801	A2 19	9990924	JP 1998-65598	19980316
L17	ANSWER 144 OF 1	67 CAPLUS	S COPYRIGHT	2002 ACS	
L17	ANSWER 145 OF 1 PATENT NO.	67 CAPLUS	S COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	JP 11231539	A2 19	9990827	JP 1998-34900	19980217
L17	ANSWER 146 OF 1 PATENT NO.	67 CAPLUS	S COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	JP 11218927	A2 19	9990810	JP 1998-23499	19980204
L17	ANSWER 147 OF 1 PATENT NO.	67 CAPLUS	S COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	JP 11212265	A2 19	9990806	JP 1998-12407	19980126
L17	ANSWER 148 OF 1 PATENT NO.	67 CAPLUS	S COPYRIGHT	2002 ACS APPLICATION NO.  JP 1997-332814	DATE
PI	JP 11158118	A2 1	9990615	JP 1997-332814	19971203
L17	ANSWER 149 OF 1	KIND D	S COPYRIGHT ATE	APPLICATION NO.	DATE
ΡI	JP 11109628	A2 1	9990423	JP 1997-267024	19970930
L17	ANSWER 150 OF 1 PATENT NO.	67 CAPLU	S COPYRIGHT	2002 ACS APPLICATION NO.	DATE
PI	JP 11102065	A2 1	9990413	JP 1997-263278	19970929
L17	ANSWER 151 OF 1 PATENT NO.	67 CAPLU	S COPYRIGHT ATE	2002 ACS APPLICATION NO.	DATE
PI	JP 11084663 US 6280897	A2 1 B1 2	9990326 0010828	JP 1997-366051 US 1997-997623	19971224 19971223
L17	ANSWER 152 OF 1 PATENT NO.	67 CAPLU KIND D	S COPYRIGHT ATE	2002 ACS APPLICATION NO.	DATE
PI	JP 11012326	A2 1	9990119	APPLICATION NO	19970623
L17	ANSWER 153 OF 1 PATENT NO.	.67 CAPLU KIND D	S COPYRIGHT ATE	2002 ACS APPLICATION NO.	DATE

ΡΙ				JP 1997-130131	19970520
L17	ANSWER 154 OF 1	67 CAP	LUS COPYRIGHT	2002 ACS	
L17	ANSWER 155 OF 10 PATENT NO.	67 CAPI KIND	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 10301285	A2	19981113	JP 1997-112698	19970430
L17	ANSWER 156 OF 1	67 CAP	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 10301284	A2	19981113	JP 1997-112604	19970430
	ANSWER 157 OF 1	KIND	ኮለጥሮ	APPLICATION NO	DATE
PI	JP 10239847 US 6042991	A2 A	19980911 20000328	JP 1997-46000 US 1998-25451	19970228 19980218
L17	ANSWER 158 OF 1 PATENT NO.	67 CAP	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	TD 10232495	A2	19980902	JP 1997-33958 US 1998-25451	199/0218
L17	ANSWER 159 OF 1 PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
ΡI	JP 10221852	A2	19980821	JP 1997-24011	19970206
L17	ANSWER 160 OF 1 PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
ΡI	JP 10182552 US 6248920	A2 B1	19980707 20010619	JP 1996-350765 US 1997-996158	19961227 19971222
L17	ANSWER 161 OF 1 PATENT NO.	67 CAP KIND	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
PI	JP 10161313 US 2001003640	A2	19980619 20010614	JP 1996-320105 US 2000-739259	19961129
L17	ANSWER 162 OF 1 PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 10133377 US 5910392 TW 434452	A2 A B	19980522 19990608 20010516	JP 1996-288524 US 1997-882734 TW 1997-86110419	19961030 19970626 19970722
L17	ANSWER 163 OF 1 PATENT NO.	KIND	DATE	2002 ACS APPLICATION NO.	DATE
ΡĪ	JP 10078658	A2	19980324	JP 1996-235247	19960905
L17	ANSWER 164 OF 1	67 CAP	LUS COPYRIGHT	2002 ACS	
L17	ANSWER 165 OF 1 PATENT NO.	67 CAP KIND	LUS COPYRIGHT DATE	2002 ACS APPLICATION NO.	DATE
ΡI	JP 09050126	A2	19970218	JP 1995-202343	19950808

L17 ANSWER 166 OF 167 CAPLUS COPYRIGHT 2002 ACS

L17 ANSWER 167 OF 167 CAPLUS COPYRIGHT 2002 ACS

NUMBER KIND DATE \_\_\_\_\_

PATENT INFORMATION:

US 5910392 US 1997-882734

19990608 19970626 (8)

APPLICATION INFO.:

NUMBER DATE .\_\_\_\_\_ -----

PRIORITY INFORMATION:

JP 1996-288524 19961030

DOCUMENT TYPE: FILE SEGMENT:

Utility Granted

PRIMARY EXAMINER:

Baxter, Janet

ASSISTANT EXAMINER:

Clarke, Yvette

LEGAL REPRESENTATIVE:

Armstrong, Westerman, Hattori, McLeland & Naughton

NUMBER OF CLAIMS:

17

EXEMPLARY CLAIM:

1,13,15

NUMBER OF DRAWINGS:

10 Drawing Figure(s); 2 Drawing Page(s)

LINE COUNT:

1484

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L17 ANSWER 61 OF 167 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: DOCUMENT NUMBER:

2002:219917 CAPLUS 136:254554

TITLE:

Chemically amplified positive photoresist compositions having lactone-containing

polymers with good dry etching resistance

INVENTOR(S):

Yoon, Kwang Sup; Jung, Dong Won; Lee, Si Hyeung; Kim, Hyun Woo; Lee, Sook; Woo, Sang Gyun; Choi, Sang Joon

Samsung Electronics Co., Ltd., S. Korea

SOURCE:

Jpn. Kokai Tokkyo Koho, 22 pp.

CODEN: JKXXAF

DOCUMENT TYPE:

Patent Japanese

LANGUAGE:

1

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT ASSIGNEE(S):

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2002082441	A2	20020322	JP 2001-211147	20010711
US 2002042016	A1	20020411	US 2001-901569	20010711
PRIORITY APPLN. INFO.	:		KR 2000-39562 A	20000711
			KR 2000-75485 A	20001212

L17 ANSWER 62 OF 167 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER:

2002:172248 CAPLUS

DOCUMENT NUMBER:

136:224211

TITLE:

Photoacid generators and photoresists comprising same

INVENTOR(S):

Cameron, James F.; Pohlers, Gerhard

PATENT ASSIGNEE(S):

Shipley Company, L.L.C., USA PCT Int. Appl., 41 pp.

SOURCE:

DOCUMENT TYPE:

CODEN: PIXXD2 Patent

LANGUAGE:

English

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO.		ΚI	ND	DATE			Α	PPLI	CATI	ON NO	Ο.	DATE			
							_								
WO 2002019	033	Α	2	2002	0307		W	O 20	01-U	S264	38	2001	0824		
W: AE	, AG,	AL,	AM,	AT,	ΑU,	ΑZ,	BA,	BB,	BG,	BR,	BY,	ΒZ,	CA,	CH,	CN,
CR	, CU,	CZ,	DE,	DK,	DM,	DZ,	EE,	ĒS,	FI,	GB,	GD,	GE,	GH,	GM,	HR,
HU	, ID,	IL,	IN,	IS,	JP,	KE,	KG,	ΚP,	KR,	ΚZ,	LC,	LK,	LR,	LS,	LT,

LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NO, NZ, PH, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, TZ, UA, UG, UZ, VN,

YU, ZA, ZW, AM, AZ, BY, KG, KZ, MD, RU, TJ, TM

RW: GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZW, AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR, BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG

US 2000-648022 A 20000825

PRIORITY APPLN. INFO.: MARPAT 136:224211 OTHER SOURCE(S):

L17 ANSWER 63 OF 167 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002:157200 CAPLUS

DOCUMENT NUMBER: 136:207692

TITLE: Crosslinked positive-working photoresist

composition

INVENTOR(S): Oomori, Katsumi; Kinoshita, Yohei; Yamada, Tomotaka;

Takayama, Toshikazu

Tokyo Ohka Kogyo Co., Ltd., Japan PATENT ASSIGNEE(S):

Eur. Pat. Appl., 17 pp. SOURCE:

CODEN: EPXXDW

Patent DOCUMENT TYPE: LANGUAGE: English

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE EP 1182506 A1 20020227 EP 2001-306923 20010814

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2002062655 A2 20020228 JP 2002062656 A2 20020228 JP 2000-250174 20000821 JP 2000-250175 20000821 US 2001-928399 20010814 US 2002034704 A1 20020321 JP 2000-250174 A 20000821 PRIORITY APPLN. INFO.: JP 2000-250175 A 20000821

THERE ARE 6 CITED REFERENCES AVAILABLE FOR THIS REFERENCE COUNT: 6 RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L17 ANSWER 64 OF 167 CAPLUS COPYRIGHT 2002 ACS

2002:131264 CAPLUS ACCESSION NUMBER:

DOCUMENT NUMBER: 136:191693

Chemically amplified resist material and TITLE: manufacture of resist pattern with improved

dry etching resistance using it Murakami, Kenichi; Takechi, Satoshi

PATENT ASSIGNEE(S):

Fujitsu Ltd., Japan Jpn. Kokai Tokkyo Koho, 15 pp. SOURCE:

CODEN: JKXXAF

Patent DOCUMENT TYPE: Japanese LANGUAGE:

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

INVENTOR(S):

PATENT NO. KIND DATE APPLICATION NO. DATE JP 2002055455 A2 20020220 JP 2000-245051 20000811

L17 ANSWER 65 OF 167 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002:119603 CAPLUS

DOCUMENT NUMBER: 136:191685

TITLE: Positively working photoresist composition

for far-ultraviolet exposure

Nakao, Hajime; Sato, Kenichiro INVENTOR(S): PATENT ASSIGNEE(S): Fuji Photo Film Co., Ltd., Japan

Jpn. Kokai Tokkyo Koho, 55 pp. SOURCE:

CODEN: JKXXAF

DOCUMENT TYPE:

Patent

LANGUAGE:

Japanese

FAMILY ACC. NUM. COUNT:

PATENT INFORMATION:

PATENT NO. KIND DATE APPLICATION NO. DATE \_\_\_\_\_\_ \_\_\_\_\_ \_\_\_\_\_ JP 2002049154 A2 20020215 JP 2000-233146 20000801

MARPAT 136:191685 OTHER SOURCE(S):

L17 ANSWER 66 OF 167 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002:119352 CAPLUS

136:175472 DOCUMENT NUMBER:

Positive photosensitive composition for TITLE:

photofabrication using deep UV ray Kodama, Kunihiko; Aoai, Toshiaki

Fuji Photo Film Co., Ltd., Japan PATENT ASSIGNEE(S):

Eur. Pat. Appl., 120 pp. SOURCE:

CODEN: EPXXDW Patent

DOCUMENT TYPE: English LANGUAGE:

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

INVENTOR(S):

APPLICATION NO. DATE KIND DATE PATENT NO. EP 1179750 A1 20020213 EP 2001-117796 20010802 R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT,

IE, SI, LT, LV, FI, RO

JP 2000-240059 A 20000808 PRIORITY APPLN. INFO.:

THERE ARE 13 CITED REFERENCES AVAILABLE FOR THIS 13 REFERENCE COUNT:

RECORD. ALL CITATIONS AVAILABLE IN THE RE FORMAT

L17 ANSWER 67 OF 167 CAPLUS COPYRIGHT 2002 ACS

ACCESSION NUMBER: 2002:99076 CAPLUS

DOCUMENT NUMBER: 136:175461

Positive-working radiation-sensitive resist TITLE:

composition suitable for subquartermicron patterning

Tamura, Kazutaka; Nio, Hiroyuki; Senoo, Masahide INVENTOR(S):

Toray Industries, Inc., Japan PATENT ASSIGNEE(S):

Jpn. Kokai Tokkyo Koho, 10 pp. SOURCE:

CODEN: JKXXAF

Patent DOCUMENT TYPE:

Japanese LANGUAGE:

FAMILY ACC. NUM. COUNT: 1

PATENT INFORMATION:

APPLICATION NO. DATE PATENT NO. KIND DATE \_\_\_\_\_ -----\_\_\_\_\_ 20020206 JP 2000-221889 20000724 JP 2002040661 A2